

# Compal Confidential

## QML70 Schematics Document

AMD Comal

APU Trinity / Hudson M3 / Thames XT M2  
UMA Only / PX Muxless with BACO

2011-10-17

LA-8371P REV: 0.2

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Model Name : QML70

Comal



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64M x 16 x 8  
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ADM1032  
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+3VSG, +VGA\_CORE, +VDDCI  
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+1.5V, +1.2VS, +2.5VS  
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GENI

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USB 2.0 + 3.0  
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USB2.0 Port 10

USB3.0 Port 1  
USB2.0 Port 11

USB2.0 Port 0

USB2.0 Port 1

USB2.0 Port 2

USB2.0 Port 3

HD Audio 3.3V 24.576MHz/48MHz

USB2.0 Port 4

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SPI ROM  
128KB (Reserve)  
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Touch Pad  
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LED  
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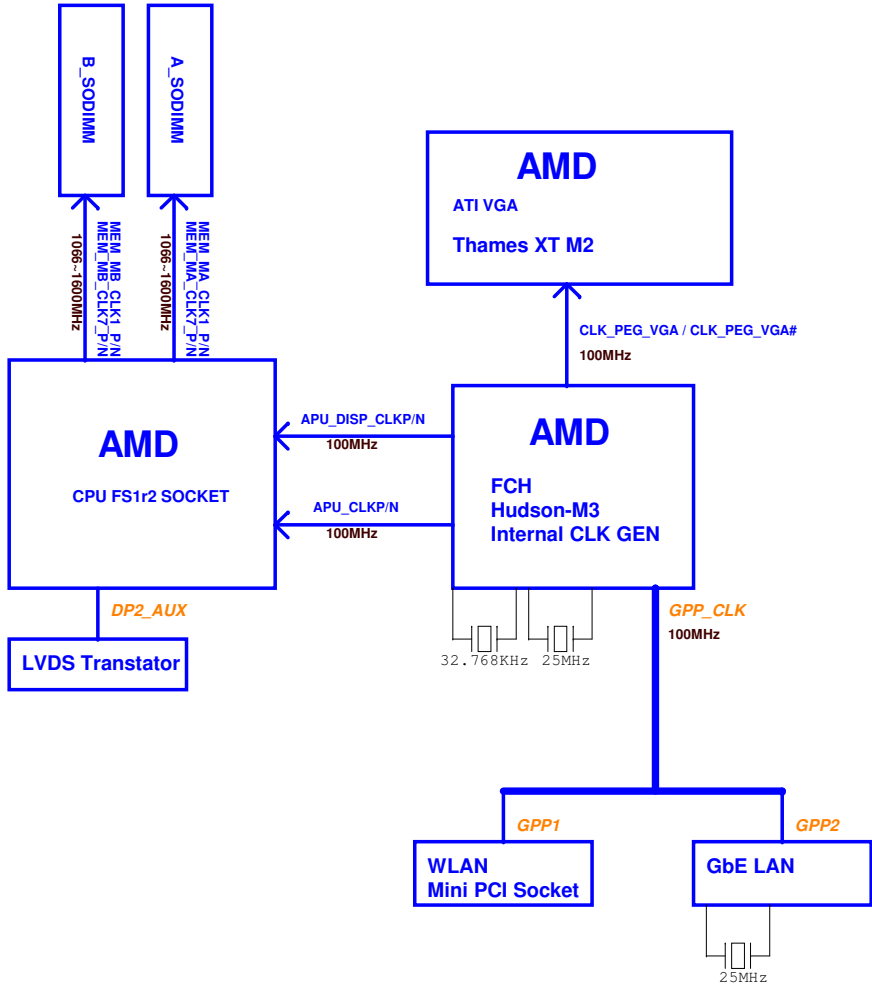
DC/DC Interface CKT.  
page 39

VGA DC/DC Interface CKT.  
page 26

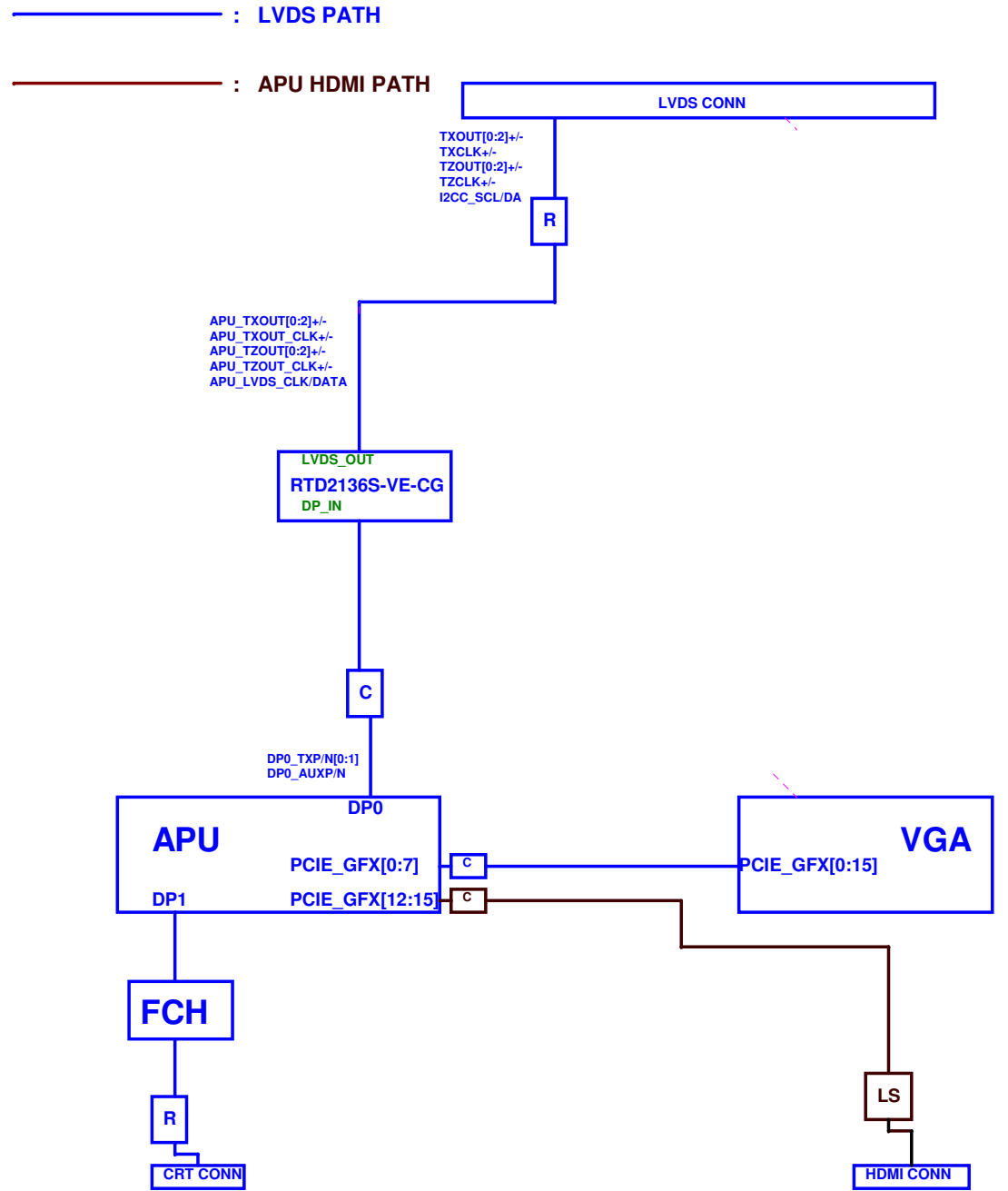
Power Circuit  
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# CLOCK DISTRIBUTION



# DISPLAY DISTRIBUTION



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# Voltage Rails

Power Plane	Description	S1	S3	S4/S5	Deep S3
VIN	Adapter power supply (19V)	N/A	N/A	N/A	N/A
B+	AC or battery power rail for power circuit.	N/A	N/A	N/A	N/A
+APU_CORE	Core voltage for CPU	ON	OFF	OFF	OFF
+APU_CORE_NB	Voltage for On-die VGA of APU	ON	OFF	OFF	OFF
+VGA_CORE	0.95-1.2V switched power rail	ON	OFF	OFF	OFF
+0.75VS	0.75V switched power rail for DDR terminator	ON	ON	OFF	ON
+1.0VSG	1.0V switched power rail for VGA	ON	OFF	OFF	OFF
+1.1VALW	1.1V switched power rail for FCH	ON	ON	ON*	OFF
+3V_PCH	3.3V switched power rail for FCH	ON	ON	ON*	OFF
+1.1VS	1.1V switched power rail for FCH	ON	OFF	OFF	OFF
+1.2VS	1.2V switched power rail for APU	ON	OFF	OFF	OFF
+3VSG	1.8V switched power rail	ON	OFF	OFF	OFF
+1.5V	1.5V power rail for CPU VDDIO and DDR	ON	ON	OFF	ON
+1.5VS	1.5V switched power rail	ON	OFF	OFF	OFF
+1.8VSG	1.8V switched power rail	ON	OFF	OFF	OFF
+2.5VS	2.5V for CPU_VDDA	ON	OFF	OFF	OFF
+3VALW	3.3V always on power rail	ON	ON	ON*	ON
+LAN_IO	3.3V power rail for LAN	ON	ON	ON	ON
+3VS	3.3V switched power rail	ON	OFF	OFF	OFF
+5VALW	5V always on power rail	ON	ON	ON*	ON
+5VS	5V switched power rail	ON	OFF	OFF	OFF
+VSB	VSB always on power rail	ON	ON	ON*	ON
+RTCVCC	RTC power	ON	ON	ON	ON

Note : ON\* means that this power plane is ON only with AC power available, otherwise it is OFF.

x = 1 is read cmd, x= 0 is write cmd.

## External PCI Devices

Device	IDSEL#	REQ#/GNT#	Interrupts

## EC SM Bus1 address

Device	Address	HEX
Smart Battery	0001 011X b	16H

## EC SM Bus2 address

Device	Address	HEX
ADI ADM1032	1001 101X b	9AH
AMD Thames XT M2	1000 001X b	82H
AMD FS12 (APU)	1001 1000 b	98H
RTD2132S (TL)	1010 1000 b	A8H

## FCH SM Bus 0 address

Device	Address	HEX
DDR DIMM1	1101 000X b	D0
DDR DIMM2	1101 001X b	D2

## FCH SM Bus 1 address

Device	Address	HEX

STATE	SIGNAL	SLP_S3#	SLP_S4#	SLP_S5#	+VALW	+V	+VS	Clock
Full ON		HIGH	HIGH	HIGH	ON	ON	ON	ON
S1 (Power On Suspend)		HIGH	HIGH	HIGH	ON	ON	ON	LOW
S3 (Suspend to RAM)		LOW	HIGH	HIGH	ON	ON	OFF	OFF
S4 (Suspend to Disk)		LOW	LOW	HIGH	ON	OFF	OFF	OFF
S5 (Soft OFF)		LOW	LOW	LOW	ON	OFF	OFF	OFF

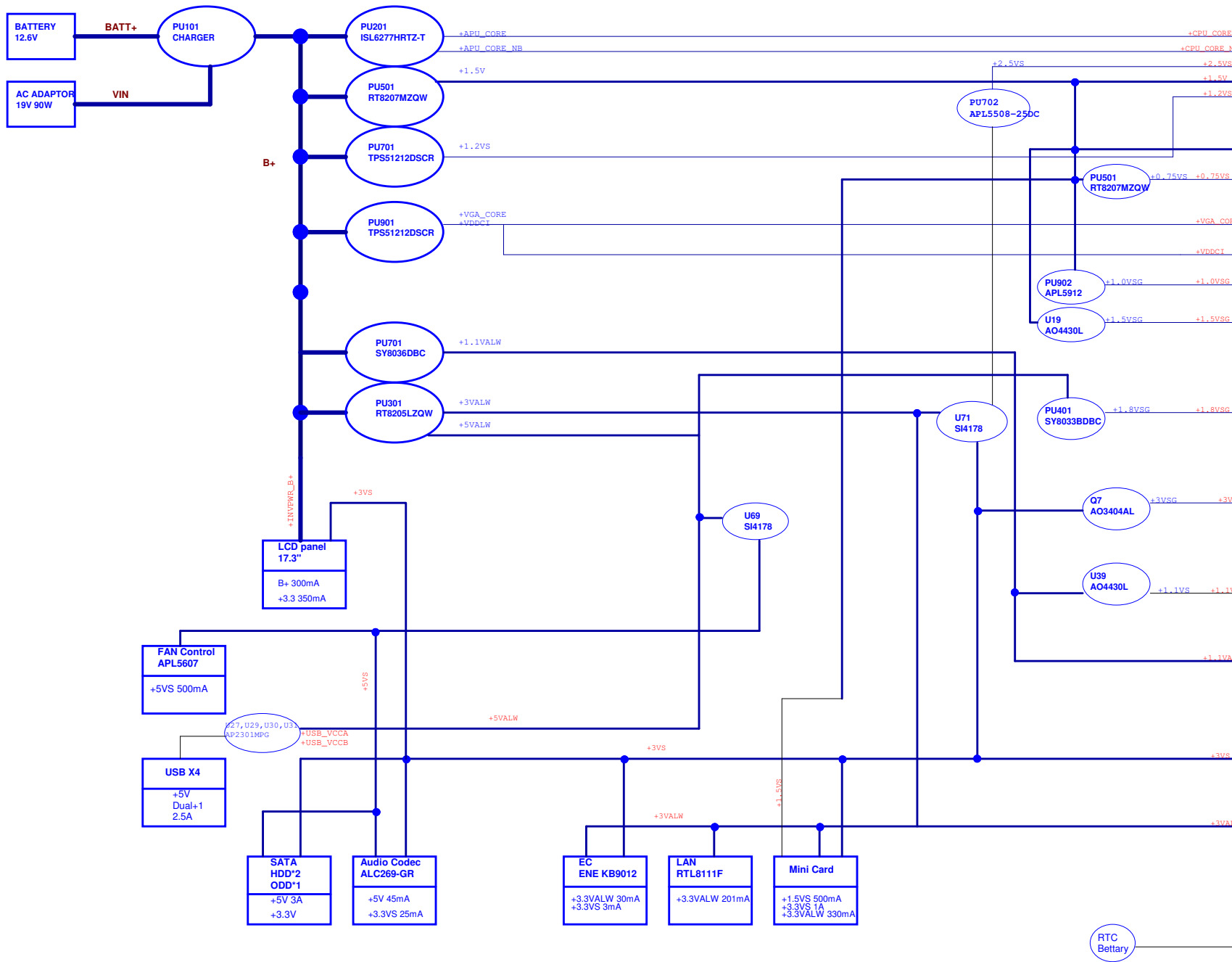
## BTO Option Table

BOM Structure	BTO Item
PX@	Use VGA (Mux)
X76@	VRAM ID Table
AI	Use AI Charger
nonAI@	Do not use AI Charger
CARD@	Use Card Reader IC
nonCARD@	do not use Card Reader IC
X76L01@	Use Hynix GDDR3 1GB VRAM
X76L02@	Use Hynix GDDR3 2GB VRAM
X76L03@	Use Samsung GDDR3 1GB VRAM
X76L04@	Use Samsung GDDR3 2GB VRAM
930@	Use EC KB930
9012@	Use EC KB9012

## Board ID Table for AD channel

Vcc	3.3V +/- 5%			
Ra / Rc	100K +/- 5%			
Board ID	Rb / Rd	VAD_BID min	VAD_BID typ	VAD_BID max
0	0 +/- 5%	0 V	0 V	0.155 V
1	8.2K +/- 5%	0.168 V	0.250 V	0.362 V

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AMD APU FS1	
1.025~1.475V	VDD CORE 54A
0.7~1.475V	VDDNB 27.5A
+2.5VS	VDDA 500mA
+1.5V	VDDIO 4.6A
+1.2VS	VDDR 6.7A

RAM DDRIII SODIMMX2	
+1.5V	VDD_MEM 4A
+0.75VS	VTT_MEM 0.5A

VGA ATI Whistler/Seymour/Granville	
0.85~1.1V	VDDC 47A
0.9~1.0V	VDDCI 4.6A
+1.0VSG	DPLL_VDDC: 125 mA SPV10: 120 mA PCIE_VDDC: 2000 mA DP[A E]_VDD10: 680 mA
+1.5VSG	VDDR1: 3400 mA
+1.8VSG	PLL_PVDD: 75 mA TSVDD: 20 mA AVDD: 70 mA VDD1D1: 100 mA VDD2D1: 50 mA AZVDDC: 1.5 mA VDD_CT: 110 mA VDDR4: 170 mA PCIE_PVDD: 40 mA MPV18: 150 mA SPV18: 75 mA PCIE_VDDR: 400 mA DP[A F]_VDD18: 920 mA DP[A F]_PVDD: 120 mA
+3VSG	AZVDD: 130 mA VDDR3: 60 mA

VRAM 1GB/2GB 64M / 128Mx16 * 4 / 8	
+1.5VSG	2.4 A

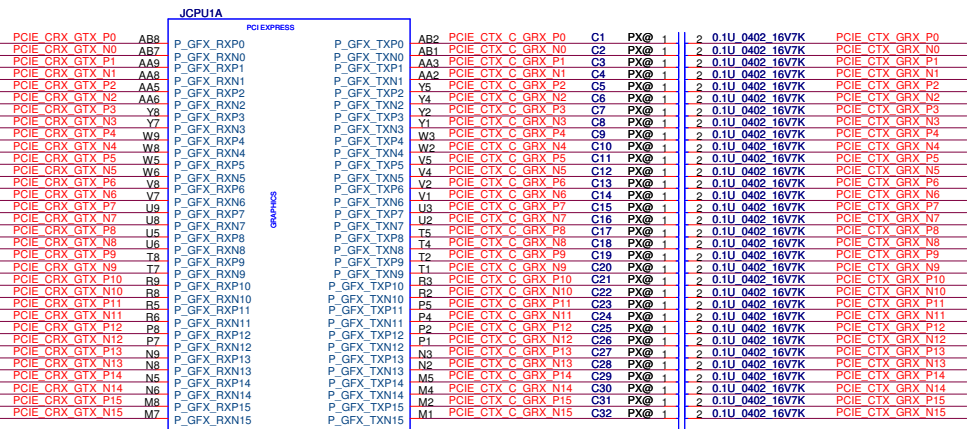
FCH AMD Hudson M2/M3	
+1.1VS	VDDPL_11_DAC: 7 mA VDDAN_11_ML: 226 mA VDDCR_11: 1007 mA VDDAN_11_CLK: 340 mA VDDAN_11_PCIE: 1088 mA VDDAN_11_SATA: 1337 mA
+1.1VALW	VDDAN_11_USB_S: 140 mA VDDCR_11_USB_S: 197 mA VDDAN_11_SSUSB_S: 282 mA VDDCR_11_SSUSB_S: 424 mA VDDCR_11_S: 187 mA VDDPL_11_SYS: 70 mA
+3VS	VDDIO_33_PCIE: 131 mA VDDPL_33_SYS: 47 mA VDDPL_33_DAC: 20 mA VDDPL_33_ML: 20 mA VDDAN_33_DAC: 200 mA VDDPL_33_PCIE: 43 mA VDDPL_33_SATA: 93 mA VDDIO_AZ_S: 26 mA
+3VALW	VDDPL_33_SSUSB_S: 20 mA VDDAN_33_USB_S: 17 mA VDDAN_33_USB_S: 658 mA VDDIO_33_S: 59 mA VDDXL_33_S: 5 mA VDDAN_33_HWM_S: 12 mA
GND	VDDIO_33_GBE_S VDDCR_11_GBE_S VDDIO_GBE_S
RTC BAT	VDDBT_RTC_G

18 PCIE\_CRX\_GTX\_P[0..15]

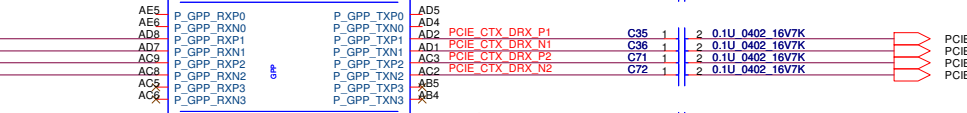
18 PCIE\_CRX\_GTX\_N[0..15]

PCIE\_CTX\_GRX\_P[0..15] 18

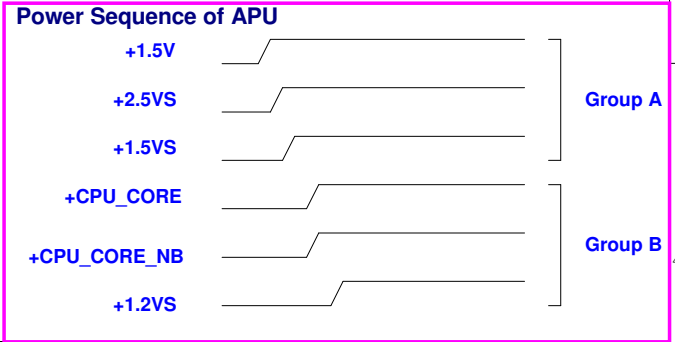
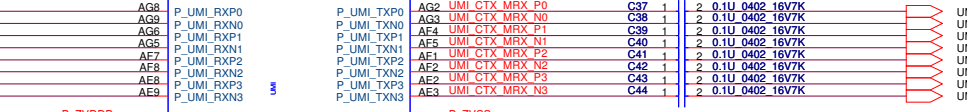
PCIE\_CTX\_GRX\_N[0..15] 18



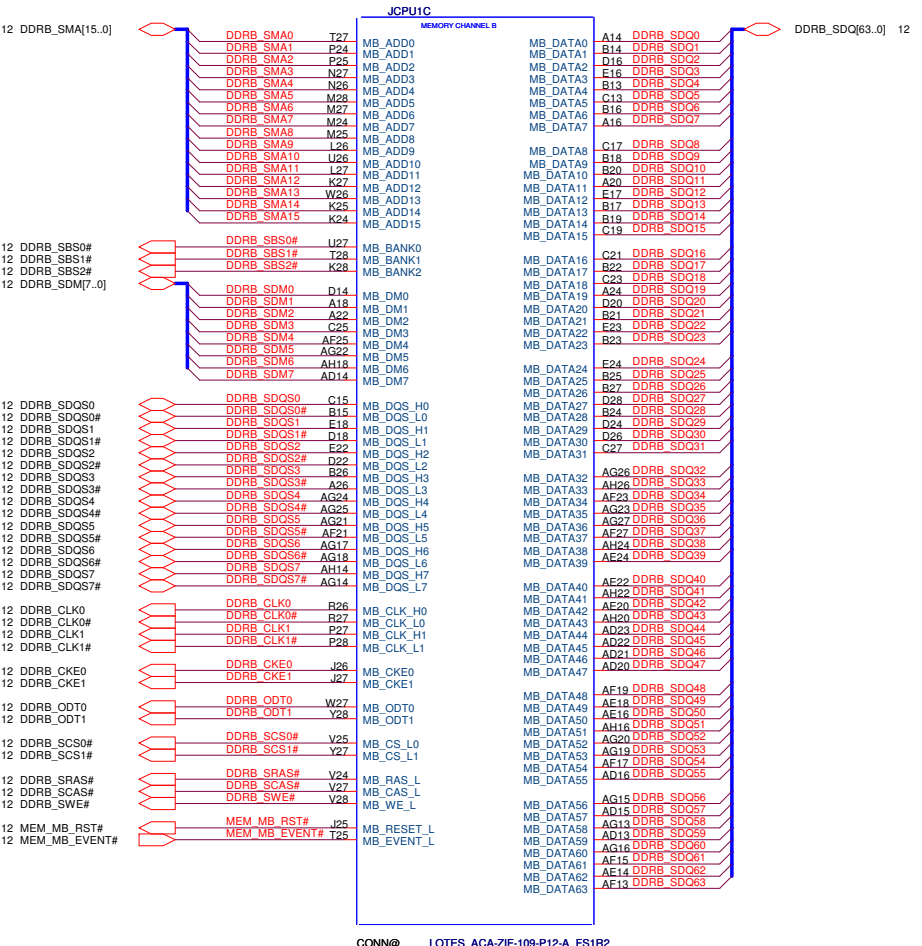
LAN  
WLAN



LAN  
WLAN

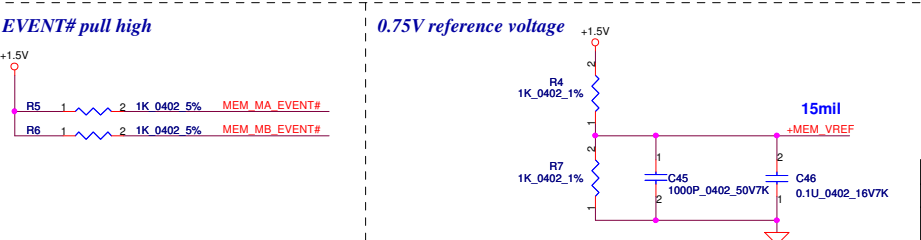


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				FS1r2 PCIE/UMI
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CONN@ LOTES\_ACA-ZIF-109-P12-A\_FS1R2

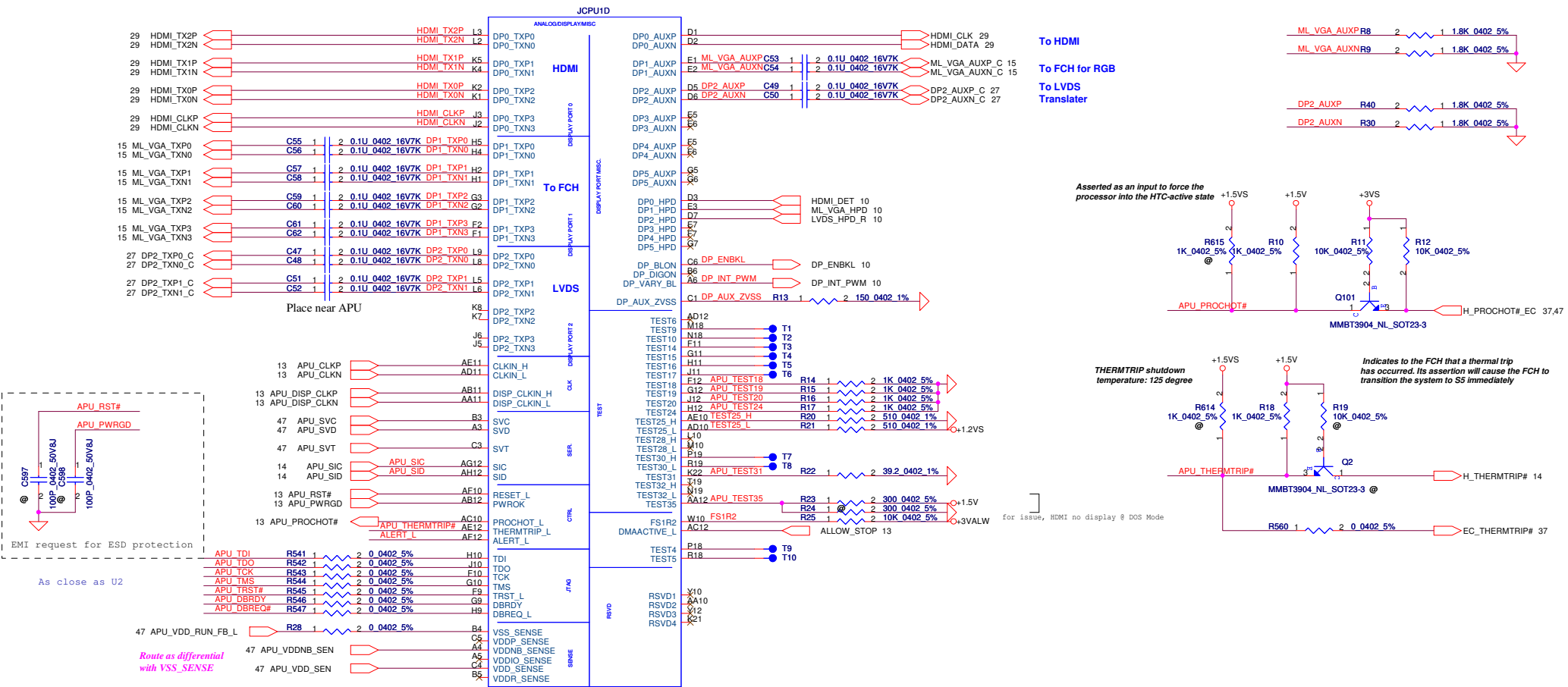
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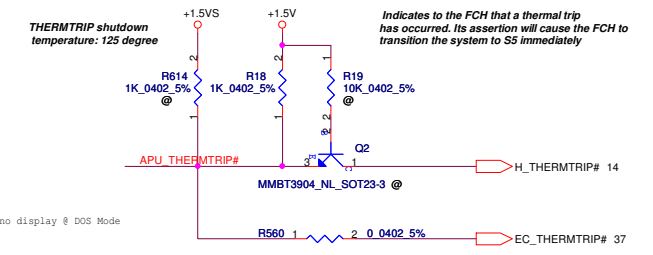
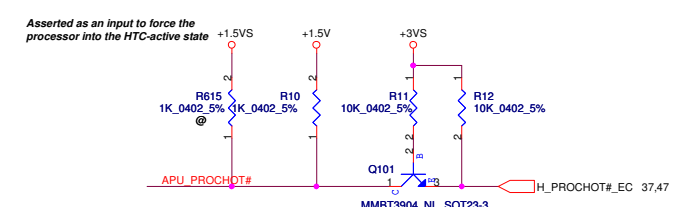
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<b>FS1r2 DDRIII Memory I/F</b>		
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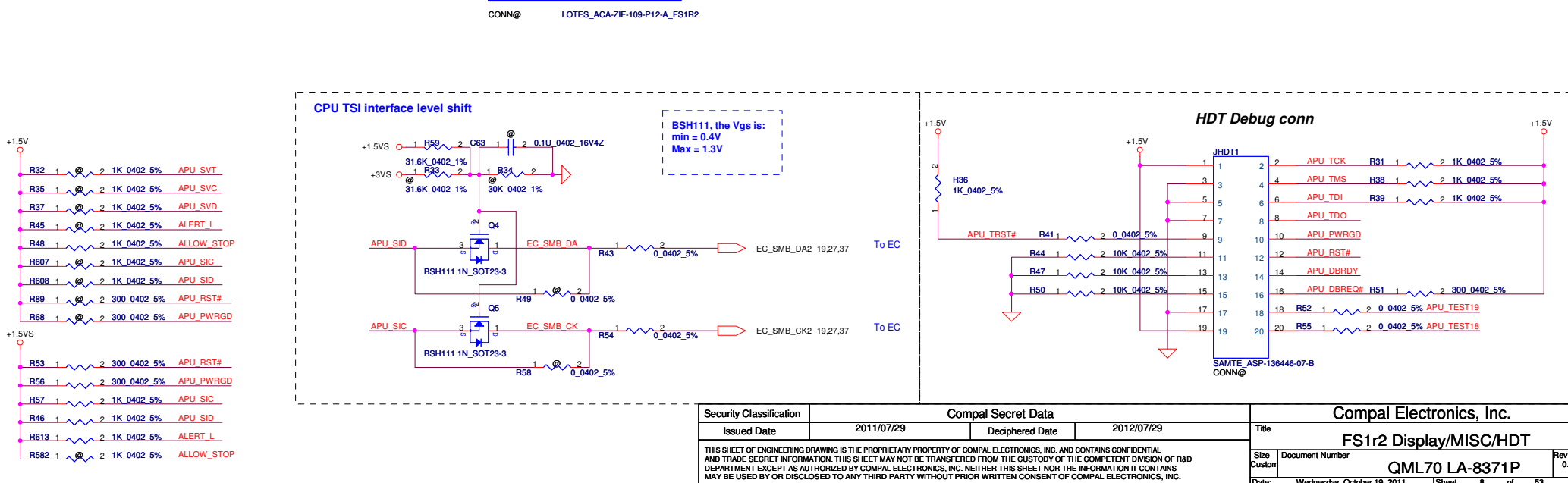
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To HDMI  
To FCH for RGB  
To LVDS  
Translator



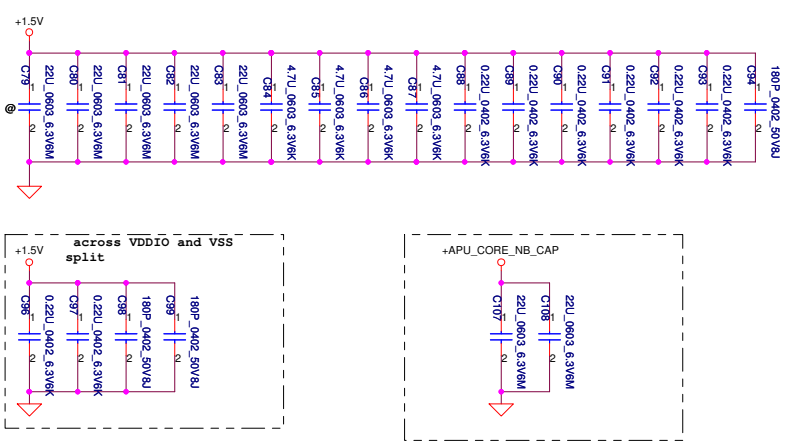
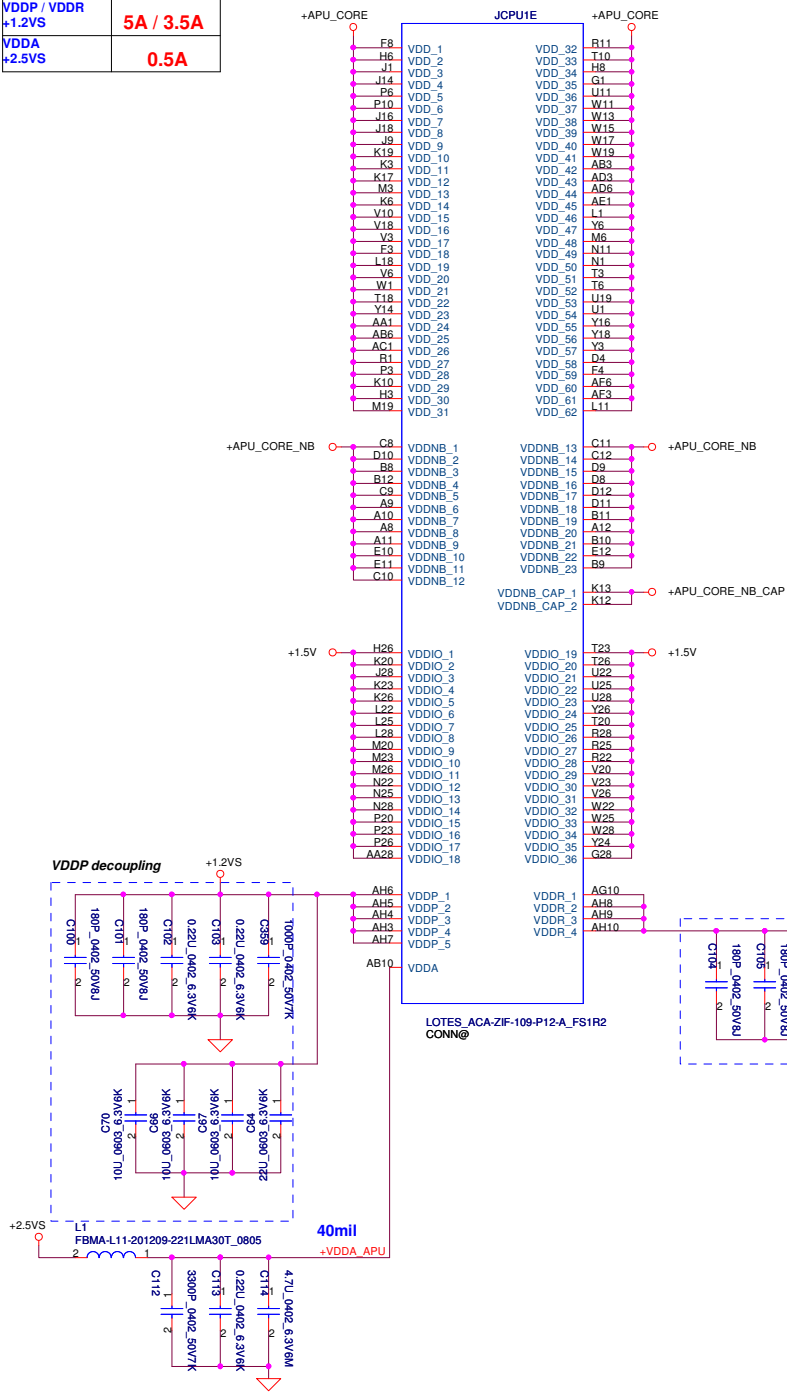
for issue, HDMI no display @ DOS Mode



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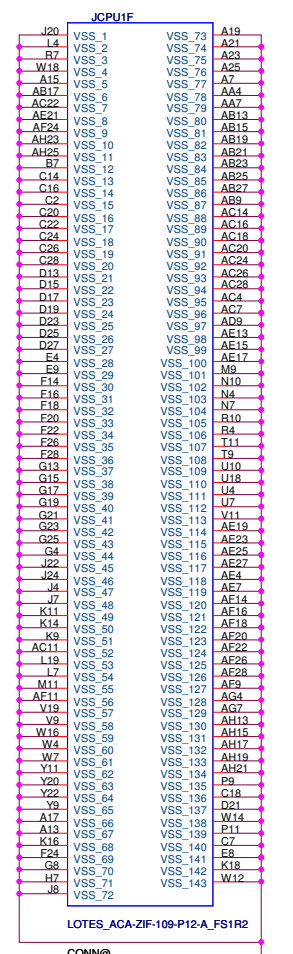


Power Name	Consumption
VDD +CPU_CORE	60A
VDDNB +CPU_CORE_NB	29A
VDDP / VDDR +1.5V	3.2A
VDDP / VDDR +1.2VS	5A / 3.5A
VDDA +2.5VS	0.5A



### Demo Board Capacitor

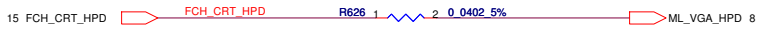
APU_CORE	CORE_NB	CORE_NB_CAP
22uF x 7	22uF x 2	22uF x 2
0.22uF x 2	10uF x 1	
0.01uF x 3	0.22uF x 2	
180pF x 2	180pF x 3	
VDDP	VDDR	VDDA
22uF x 1	10uF x 3	4.7uF x 1
10uF x 3	0.22uF x 2	0.22uF x 1
0.22uF x 2	1nF x 1	3.3nF x 1
180pF x 2	180pF x 2	
1nF x 1		



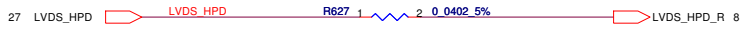
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# HPD

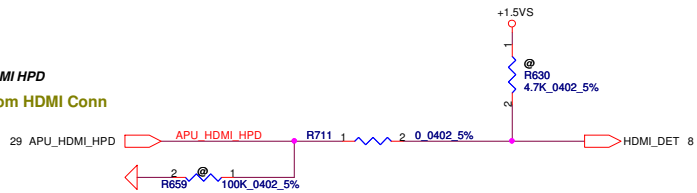
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From FCH



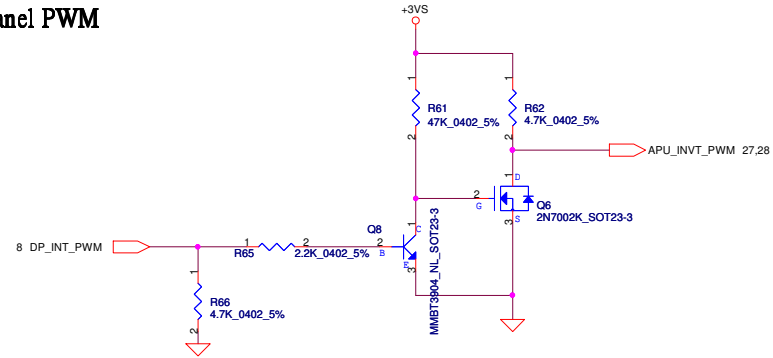
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From Translator



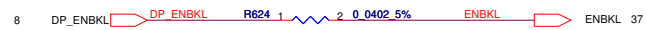
**HDMI HPD**  
From HDMI Conn



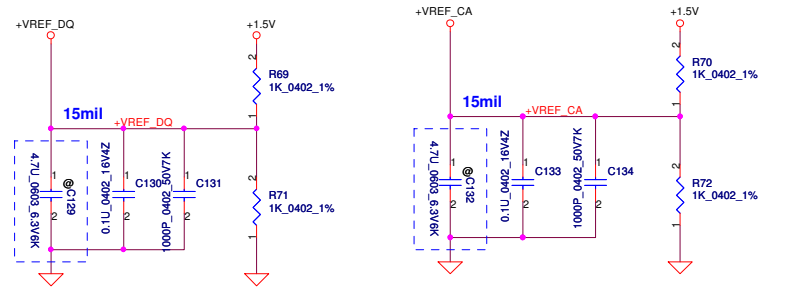
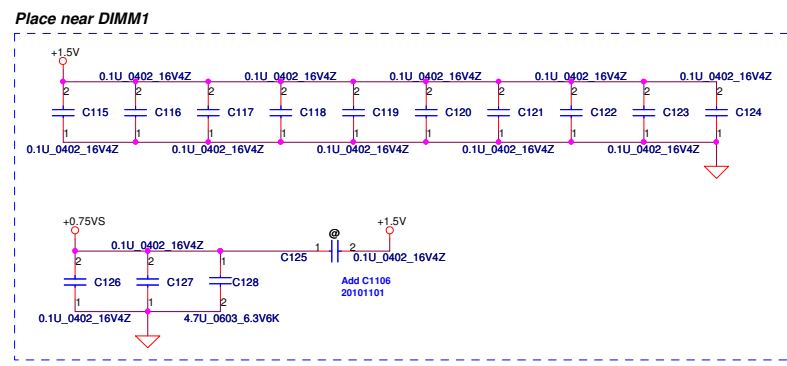
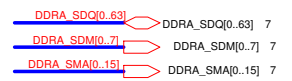
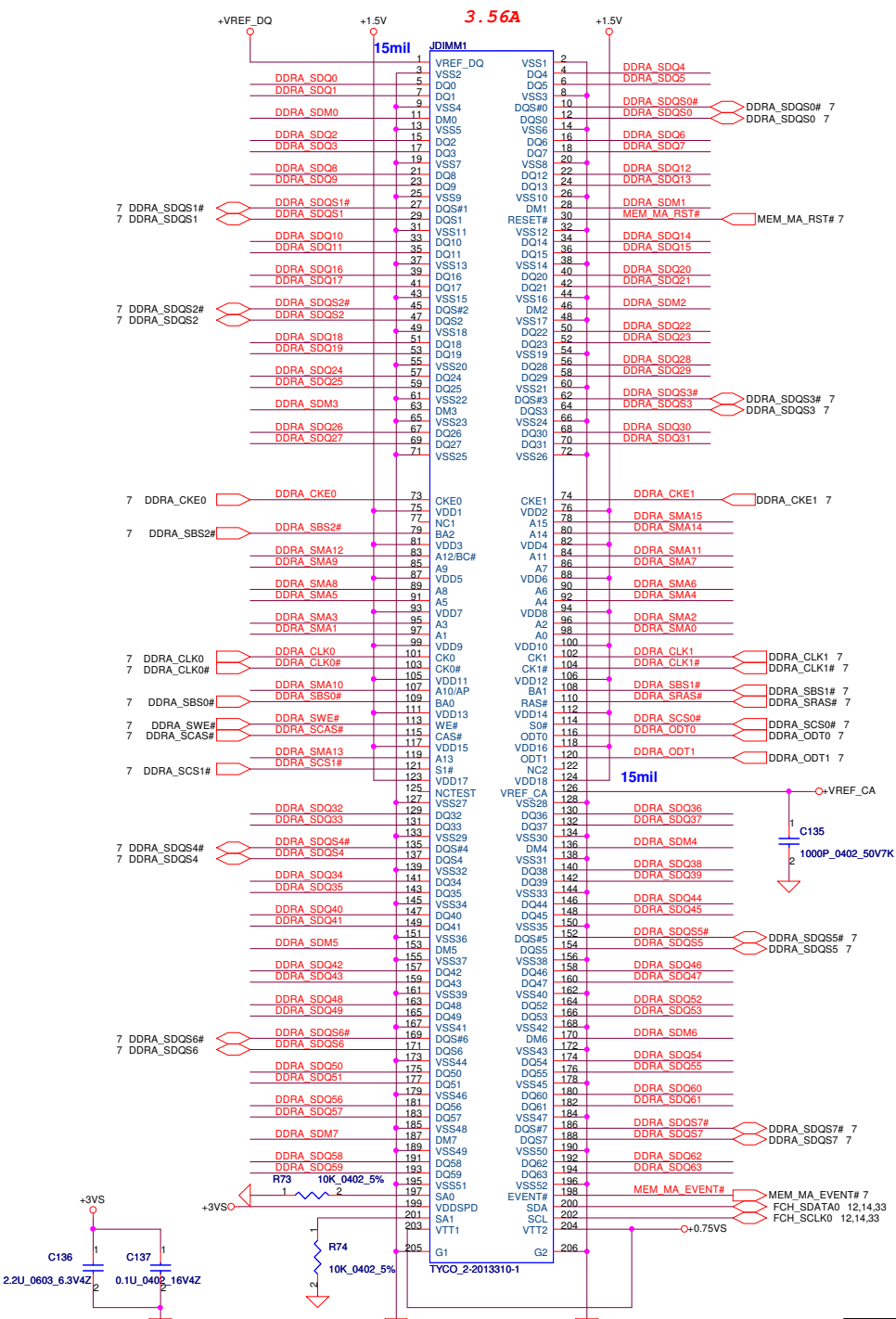
# Panel PWM



# Panel ENBKL

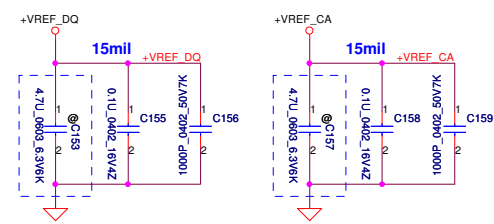
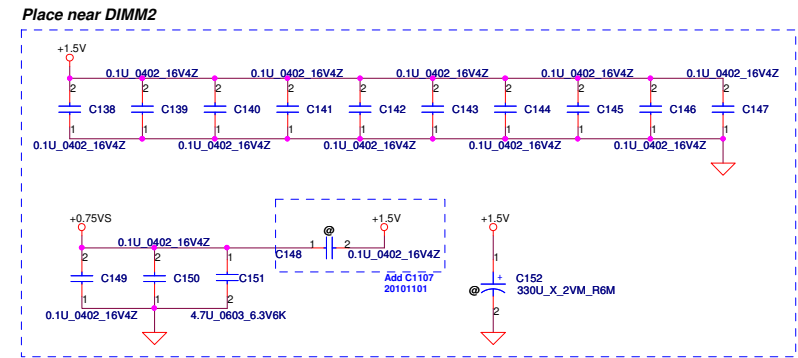
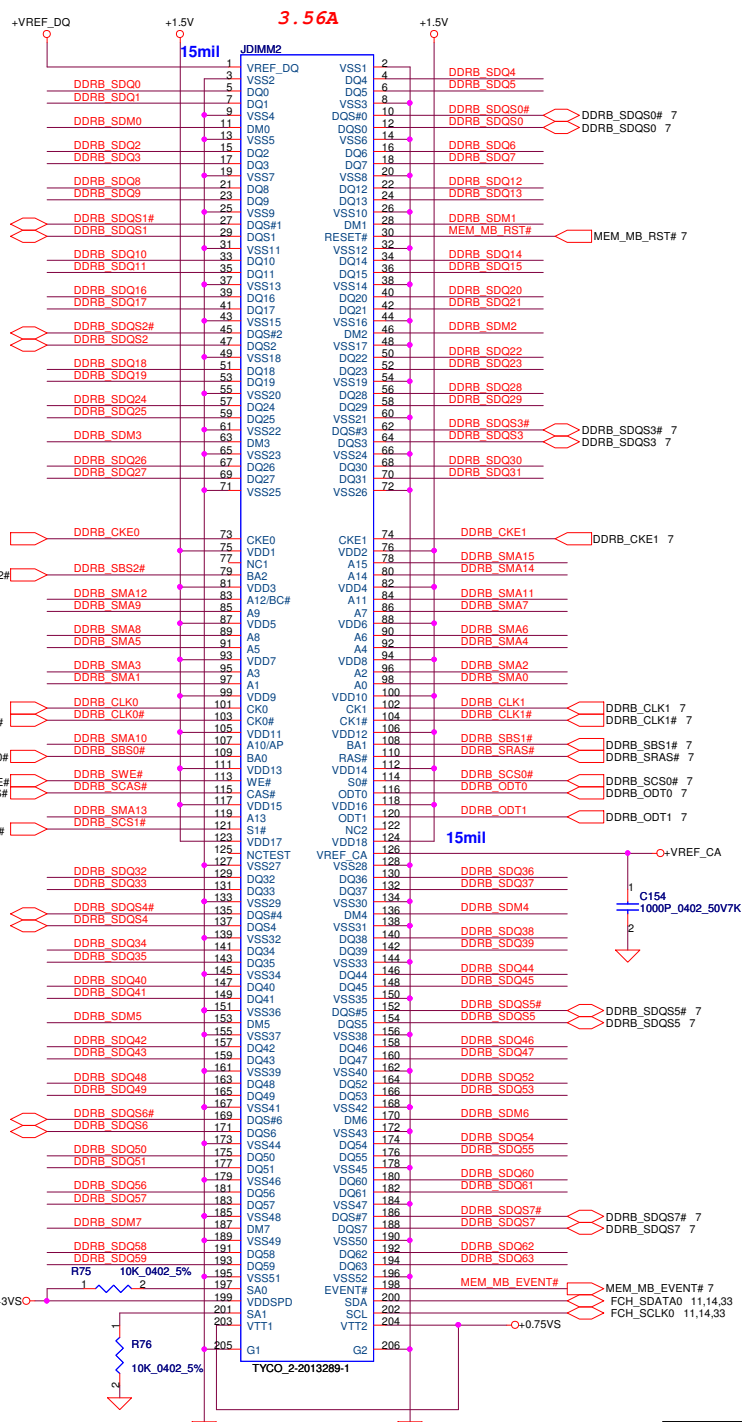


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Date:	Wednesday, October 19, 2011	Sheet	10	of	53	



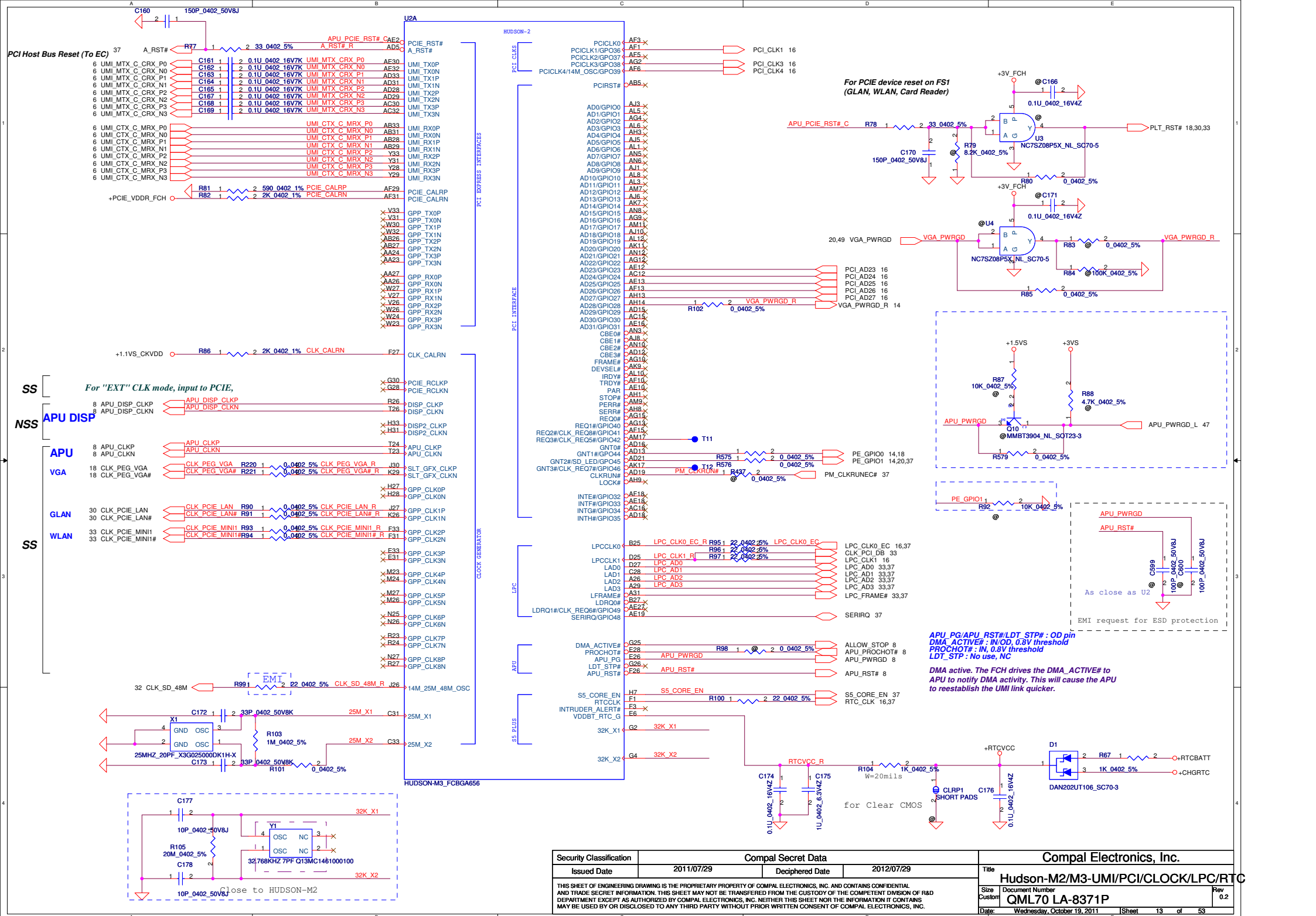
**DIMM\_A STD H:9.2mm**  
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				Date:	Wednesday, October 19, 2011	Sheet	11 of 53



**DIMM\_B STD H:5.2mm**  
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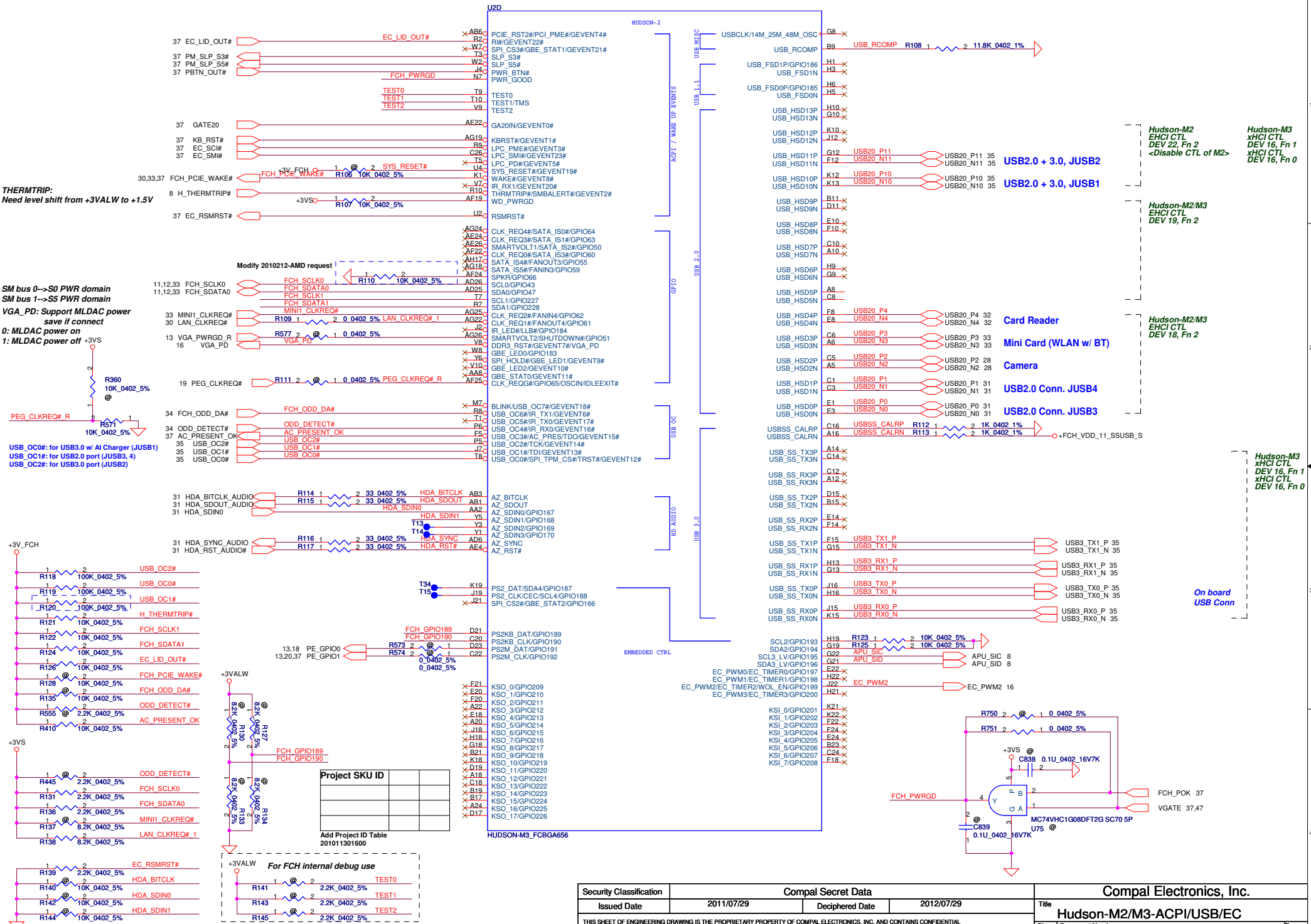
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				DDRIII SO-DIMM 2	
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Hudson-M2/M3-UMI/PCI/CLOCK/LPC/RTC			
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PCIE\_RST2 : Reset PCIE device on Hudson2



**THERMTRIP:**  
Need level shift from +3VALW to +1.5V

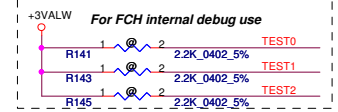
**SM bus 0-->S0 PWR domain**  
**SM bus 1-->S5 PWR domain**  
**VGA\_PD: Support MLDAC power**  
save if connect

0: MLDAC power on  
1: MLDAC power off

USB\_OC0#: for USB3.0 w/ AI Charger (JUSB1)  
USB\_OC1#: for USB2.0 port (JUSB3, 4)  
USB\_OC2#: for USB3.0 port (JUSB2)

Project SKU ID	

Add Project ID Table  
201011301600



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Title	Hudson-M2/M3-ACPI/USB/EC
Size	Document Number
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Hudson-M2  
EHCI CTL  
DEV 22, Fn 2  
<Disable CTL of M2>

Hudson-M2/M3  
EHCI CTL  
DEV 19, Fn 2

Hudson-M2/M3  
EHCI CTL  
DEV 18, Fn 2

Hudson-M3  
xHCI CTL  
DEV 16, Fn 1  
xHCI CTL  
DEV 16, Fn 0

On board  
USB Conn

USB2.0 + 3.0, JUSB2  
USB2.0 + 3.0, JUSB1

Card Reader

Mini Card (WLAN w/ BT)

Camera

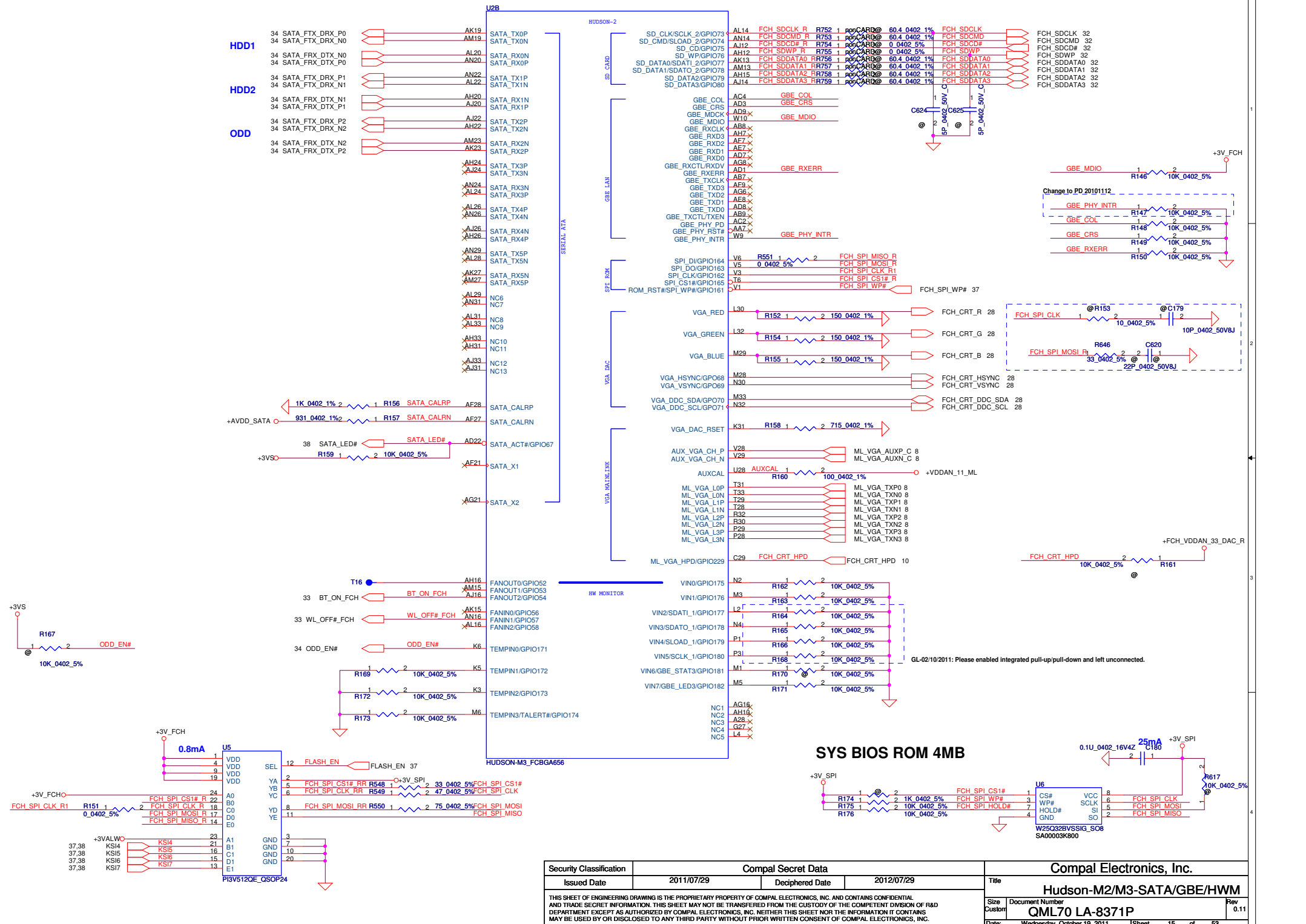
USB2.0 Conn. JUSB4

USB2.0 Conn. JUSB3

APU\_SIC 8  
APU\_SID

EC\_PWM2

FCH\_POK 37  
VGATE 37.47

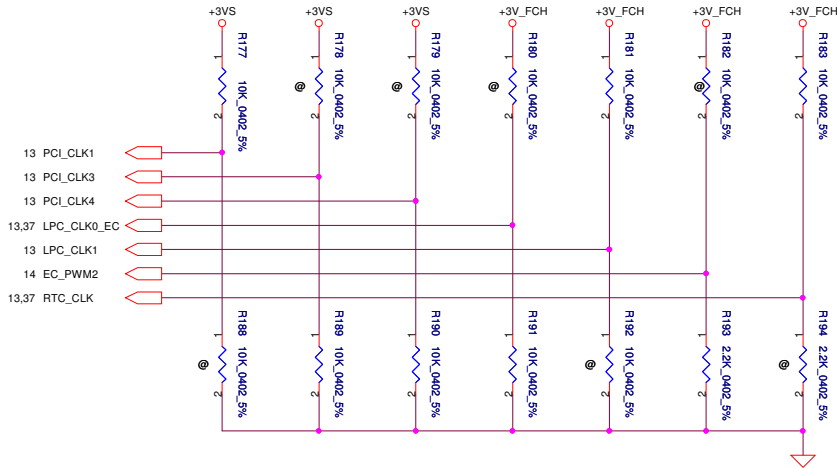


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Title: Hudson-m2/M3-SATA/GBE/HWM			
Size	Document Number	Rev	
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# STRAP PINS

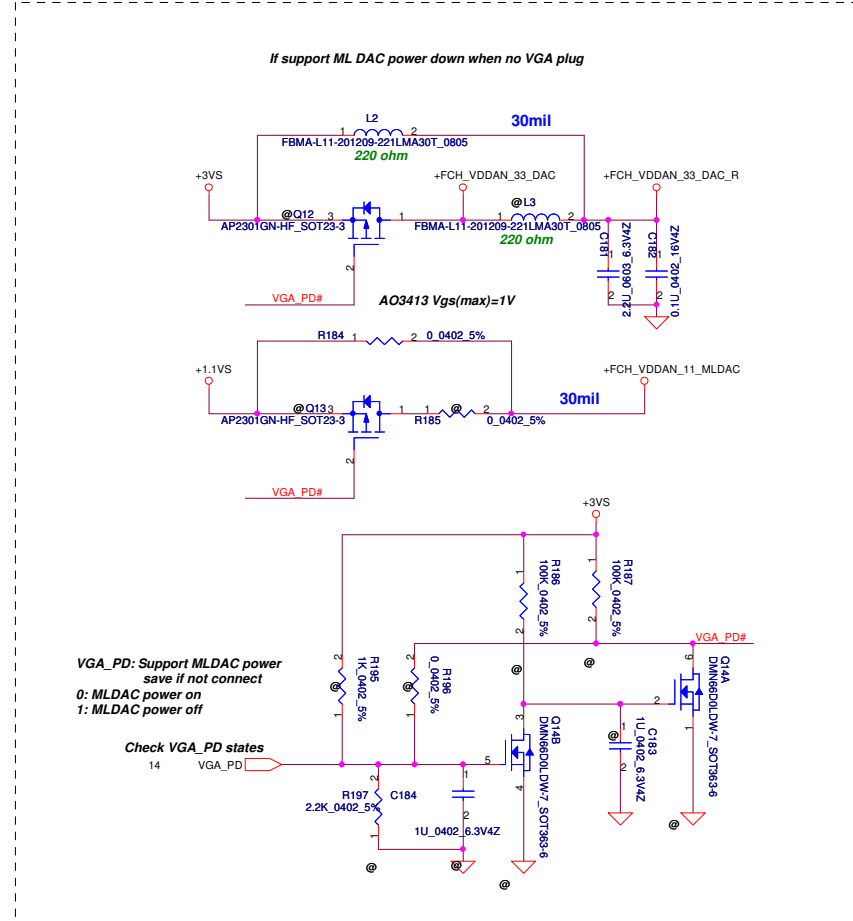
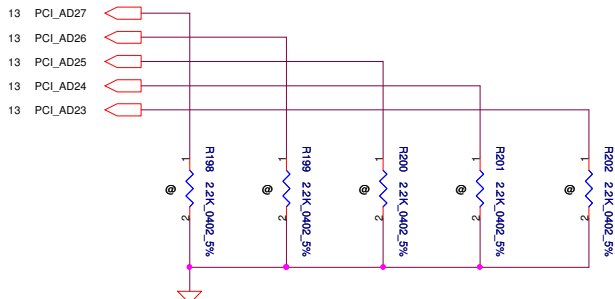
	PCI_CLK1	PCI_CLK3	PCI_CLK4	LPC_CLK0	LPC_CLK1	EC_PWM2	RTC_CLK
<b>PULL HIGH</b>	ALLOW PCI GEN2 <b>DEFAULT</b>	USE DEBUG STRAPS	NON_FUSION CLOCK MODE	EC ENABLED	CLKGEN ENABLED <b>DEFAULT</b>	LPC ROM <b>DEFAULT</b>	S5 PLUS MODE DISABLED <b>DEFAULT</b>
<b>PULL LOW</b>	FORCE PCI GEN1	IGNORE DEBUG STRAP <b>DEFAULT</b>	FUSION CLOCK MODE <b>DEFAULT</b>	EC DISABLED	CLKGEN DISABLE	SPI ROM	S5 PLUS MODE ENABLED



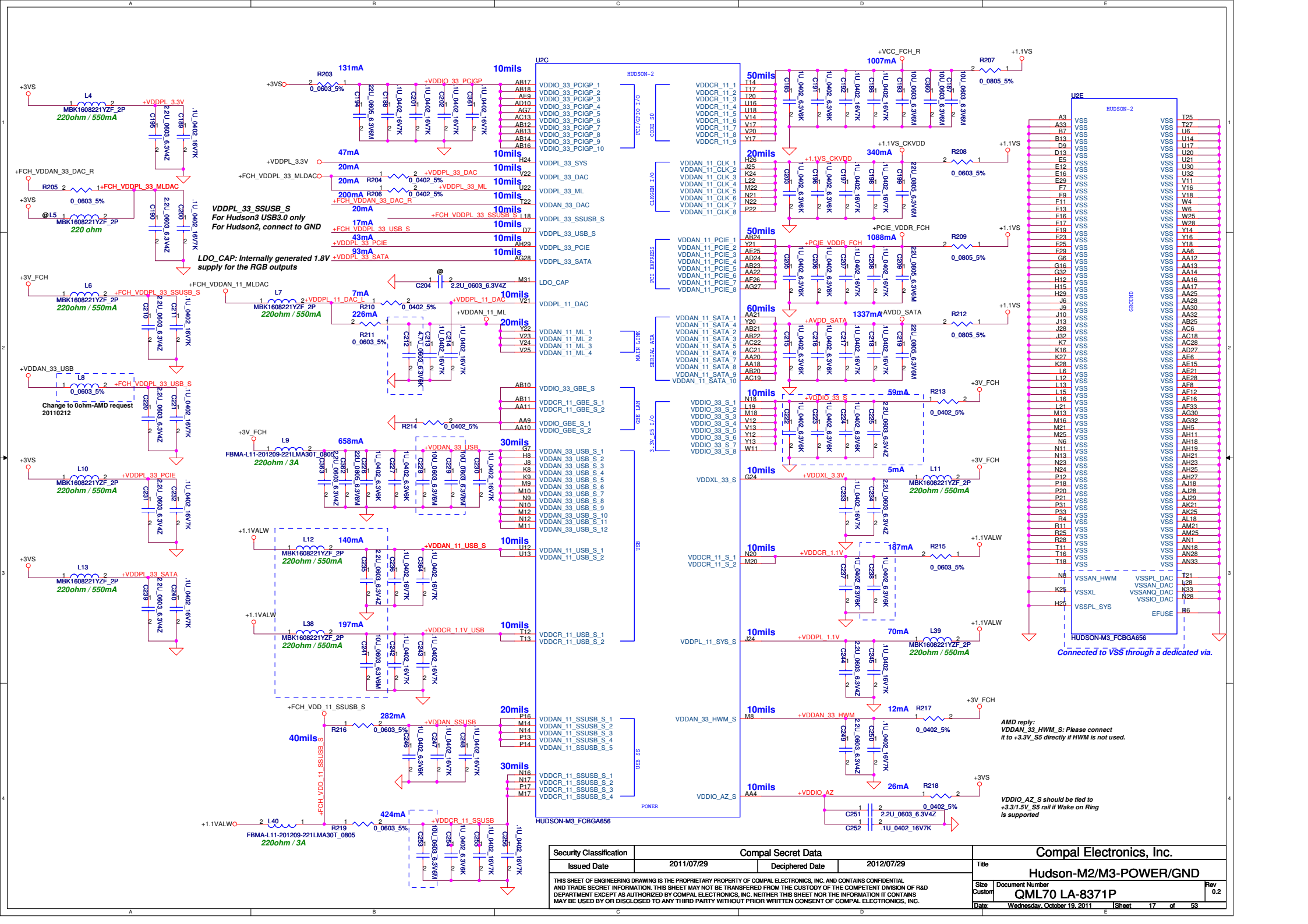
# DEBUG STRAPS

FCH HAS 15K INTERNAL PU FOR PCI\_AD[27:23]

	PCI_AD27	PCI_AD26	PCI_AD25	PCI_AD24	PCI_AD23
<b>PULL HIGH</b>	USE PCI PLL <b>DEFAULT</b>	DISABLE ILA AUTORUN <b>DEFAULT</b>	USE FC PLL <b>DEFAULT</b>	USE DEFAULT PCI STRAPS <b>DEFAULT</b>	DISABLE PCI MEM BOOT <b>DEFAULT</b>
<b>PULL LOW</b>	BYPASS PCI PLL	ENABLE ILA AUTORUN	BYPASS FC PLL	USE EEPROM PCI STRAPS	ENABLE PCI MEM BOOT







**VDDPL\_33\_SSUSB\_S**  
 For Hudson3 USB3.0 only  
 For Hudson2, connect to GND

**LDO\_CAP:** Internally generated 1.8V supply for the RGB outputs

AMD reply:  
 VDDAN\_33\_HWM\_S: Please connect it to +3.3V\_S5 directly if HWM is not used.

VDDIO\_AZ\_S should be tied to +3.3/1.5V\_S5 rail if Wake on Ring is supported

Connected to VSS through a dedicated via.

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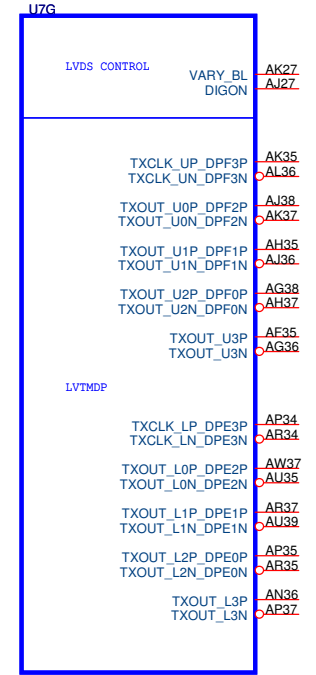
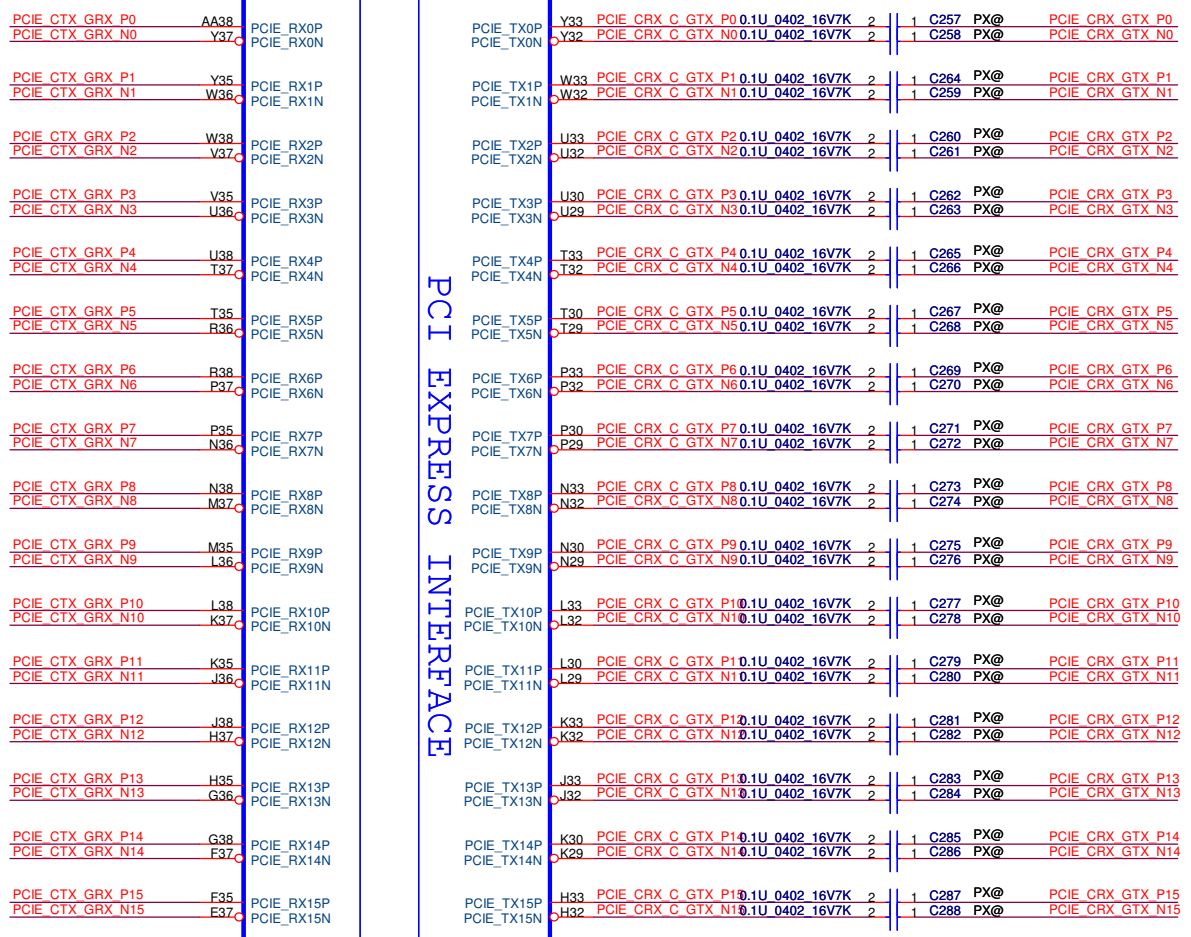
**Compal Electronics, Inc.**

**Hudson-M2/M3-POWER/GND**

6 PCIE\_CTX\_GRX\_P[15..0] PCIE\_CTX\_GRX\_P[15..0]  
 6 PCIE\_CTX\_GRX\_N[15..0] PCIE\_CTX\_GRX\_N[15..0]

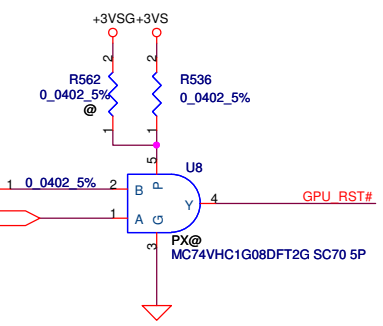
PCIE\_CRX\_GTX\_P[15..0] PCIE\_CRX\_GTX\_P[15..0] 6  
 PCIE\_CRX\_GTX\_N[15..0] PCIE\_CRX\_GTX\_N[15..0] 6

# LVDS Interface



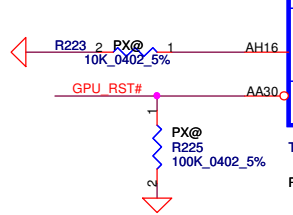
THAMES XT M2 FCBGA 962P

PX@



13 CLK\_PEG\_VGA CLK\_PEG\_VGA AB35  
 13 CLK\_PEG\_VGA# CLK\_PEG\_VGA# AA36

13,14 PE\_GPI00 R556 2 PX@ 1 0.0402 5% 2  
 13,30,33 PLT\_RST# 1



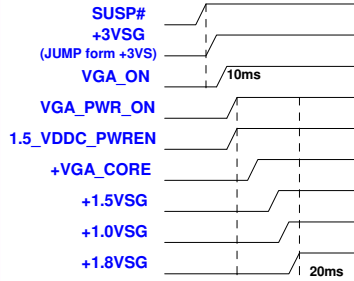
CALIBRATION  
 PCIE\_CALRP Y30 1.27K 0.402 1% 1 PX@ 2 R222  
 PCIE\_CALRN Y29 2K 0.402 1% 1 PX@ 2 R224 +1.0VSG

THAMES XT M2 FCBGA 962P

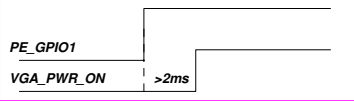
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Size B	Document Number			Rev	0.2
				QML70 LA-8371P	
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**Power Sequence of Whistler and Seymour**



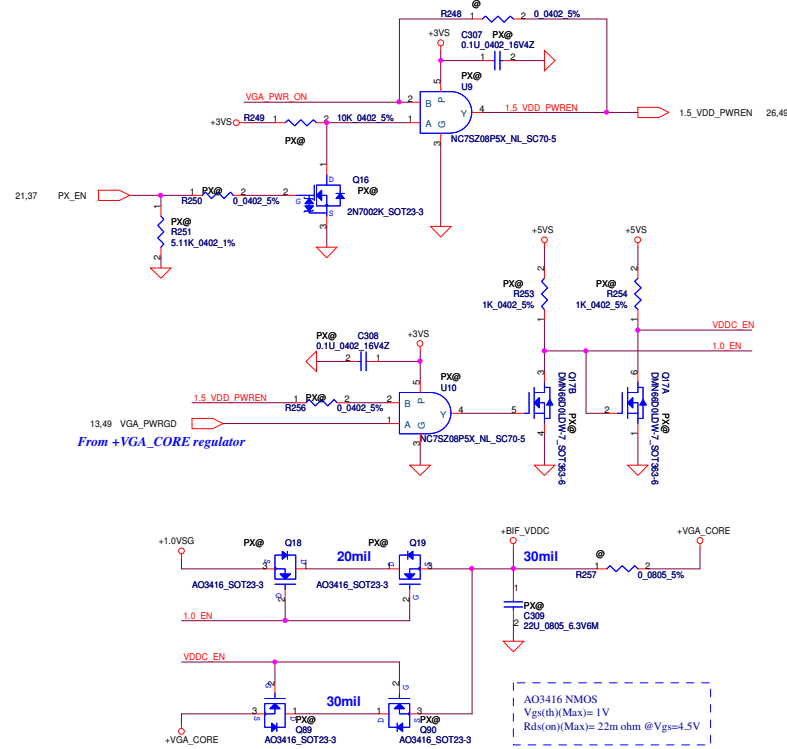
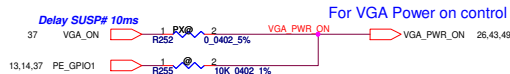
For PX sequence, >2mS delay is required between PE\_GPIO1 and VGA\_PWR\_ON



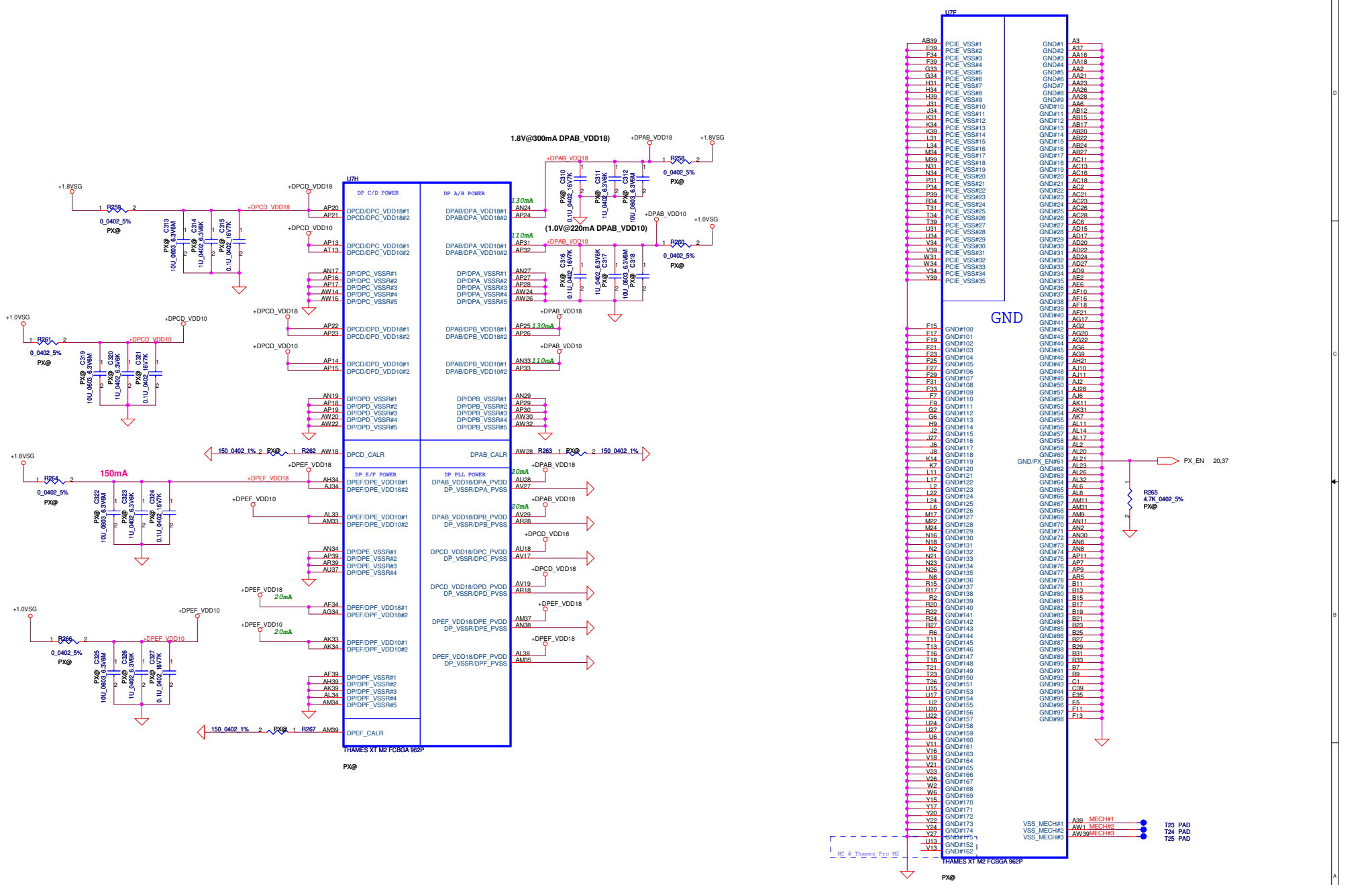
**VGA Muxless with BACO Status Mapping table**

	Normal mode	BACO mode
PX_EN	0	1
1.5_VDDC_PWREN	1	0
VDDC_EN	1	0
1.0_EN	0	1
+3.3VSG	ON	ON
+1.8VSG	ON	ON
+1.0VSG	ON	ON
+VGA_CORE	ON	OFF
+1.5VSG	ON	OFF
+BIF_VDDC	+VGA_CORE	+1.0VSG

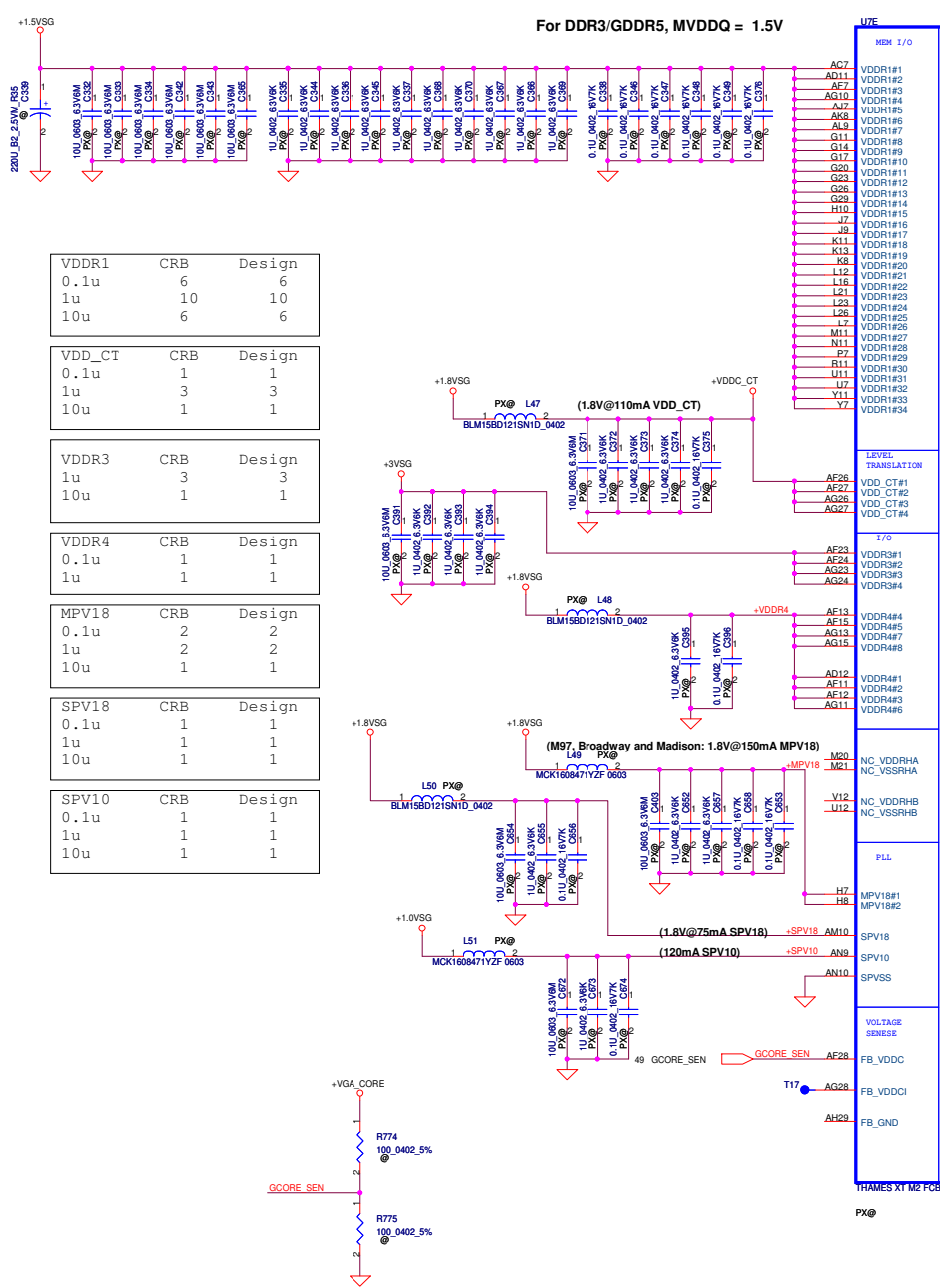
VGA Power Enable Signal Mapping table	
VGA_PWR_ON source signal	Whistler
+3.3VSG	VGA_ON
+1.8VSG	SUSP#
+1.0VSG	VGA_PWR_ON
+VDDCI	Combine with +VGA_CORE
+VGA_CORE	1.5_VDDC_PWREN
+1.5VSG	1.5_VDDC_PWREN



AO3416 NMOS  
 $V_{gs(th)(Max)} = 1V$   
 $R_{ds(on)(Max)} = 22m\ \Omega @ V_{gs} = 4.5V$



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Title			ATI Thames XT M2_PWR_GND	
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For DDR3/GDDR5, MVDDQ = 1.5V

VDDR1	CRB	Design
0.1u	6	6
1u	10	10
10u	6	6

VDD_CT	CRB	Design
0.1u	1	1
1u	3	3
10u	1	1

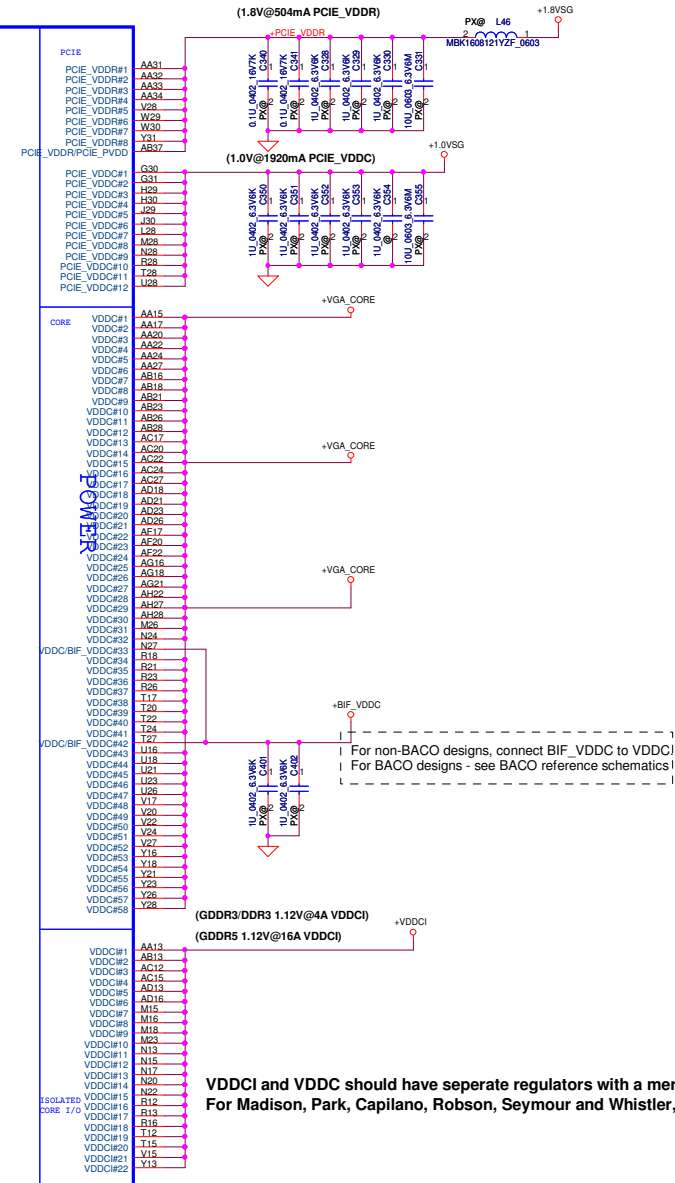
VDDR3	CRB	Design
1u	3	3
10u	1	1

VDDR4	CRB	Design
0.1u	1	1
1u	1	1

MPV18	CRB	Design
0.1u	2	2
1u	2	2
10u	1	1

SPV18	CRB	Design
0.1u	1	1
1u	1	1
10u	1	1

SPV10	CRB	Design
0.1u	1	1
1u	1	1
10u	1	1



VDDCI and VDDC should have separate regulators with a merge option on PCB  
 For Madison, Park, Capilano, Robson, Seymour and Whistler, VDDCI and VDDC can share one common regulator

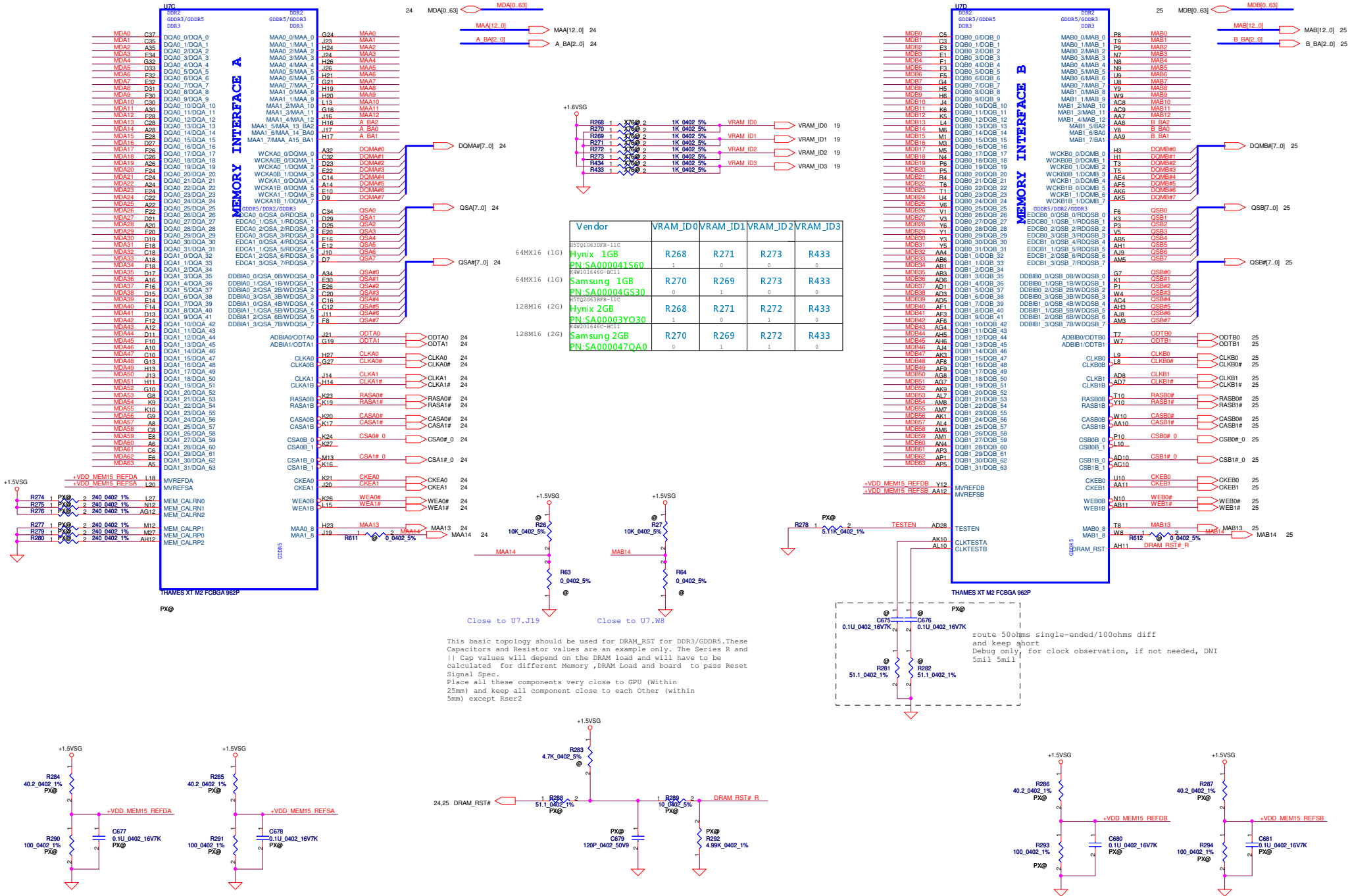
PCIE_VDDR	CRB	Design
0.1u	2	2
1u	3	3
10u	1	1

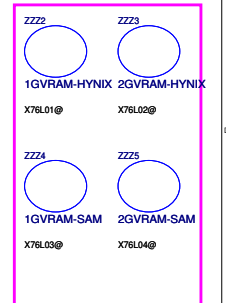
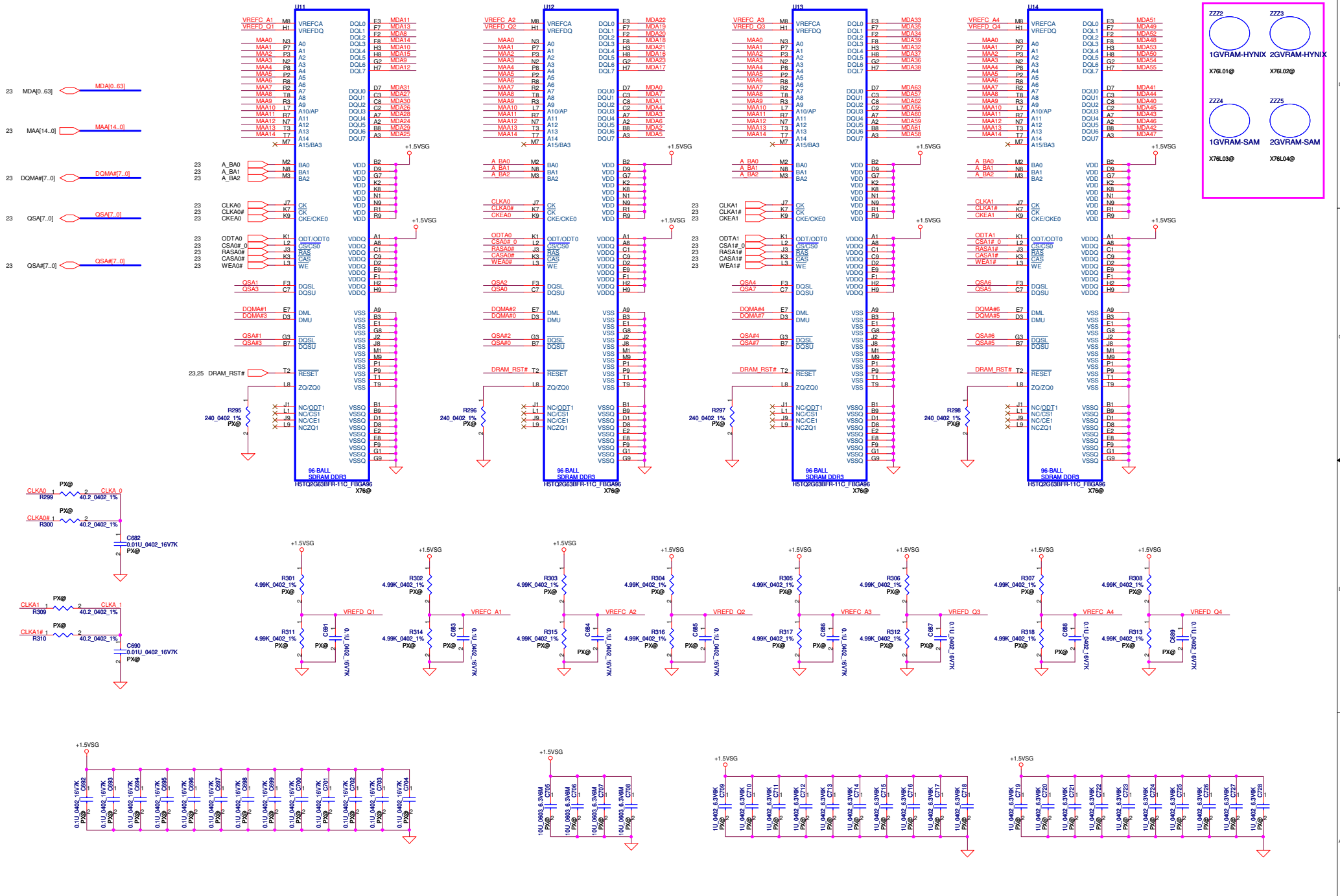
PCIE_VDDC	CRB	Design
1u	7	5 (1@)
10u	1	1

VDDC	CRB	Design
1u	30	30
10u	10	3
22u	0	1

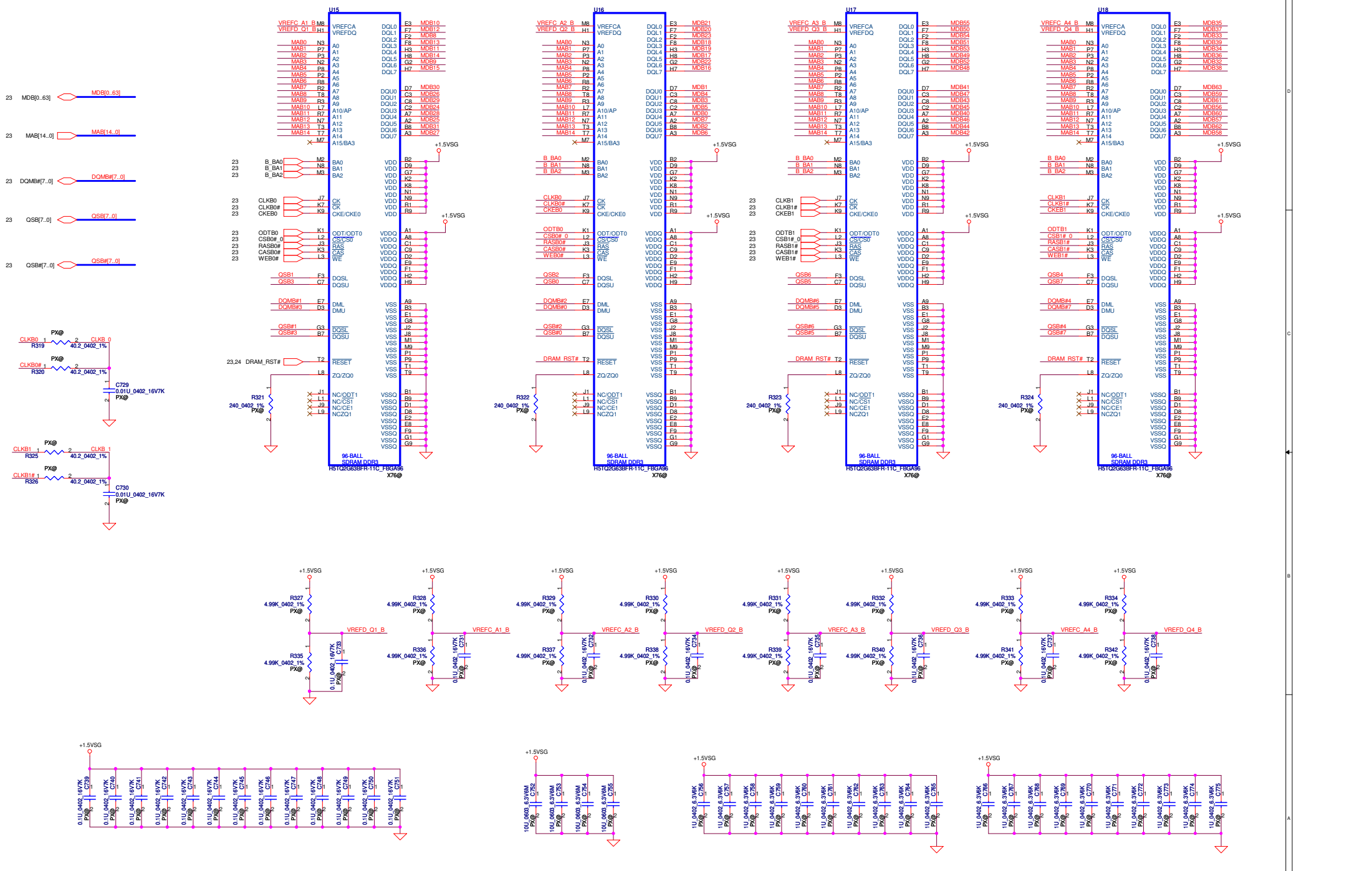
VDDCI	CRB	Design
1u	10	10
10u	3	4 (3@)
22u	0	1

For non-BACO designs, connect BIF\_VDDC to VDDCI  
 For BACO designs - see BACO reference schematics!







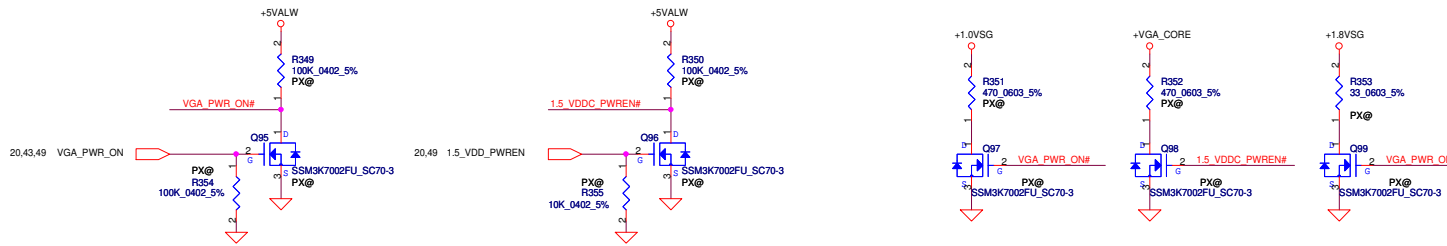
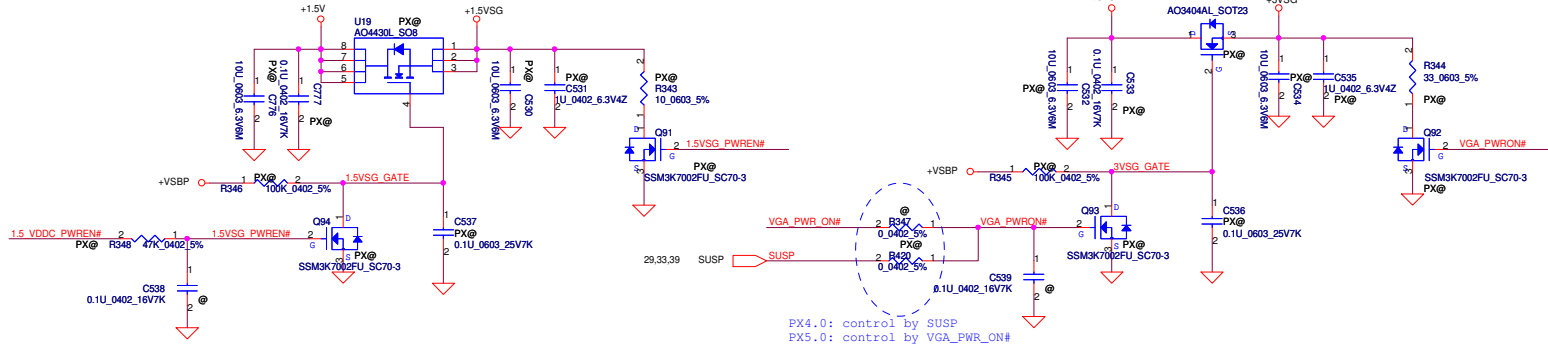


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# VGA Power

## +1.5V to +1.5VSG (5.2A)

## +3VS to +3VSG (60mA)

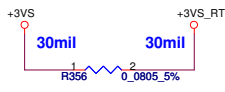


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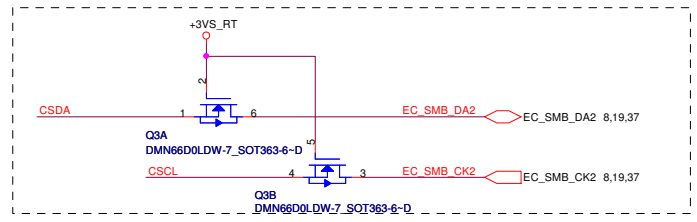
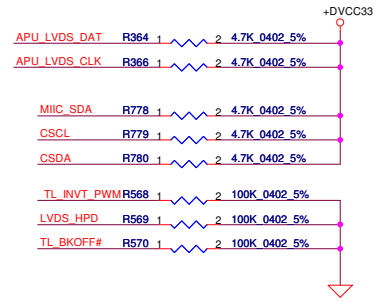
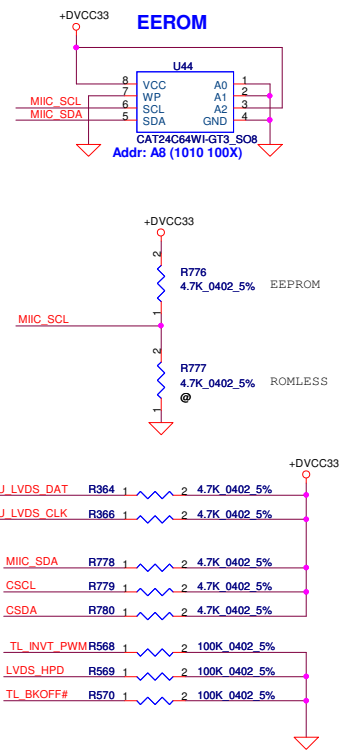
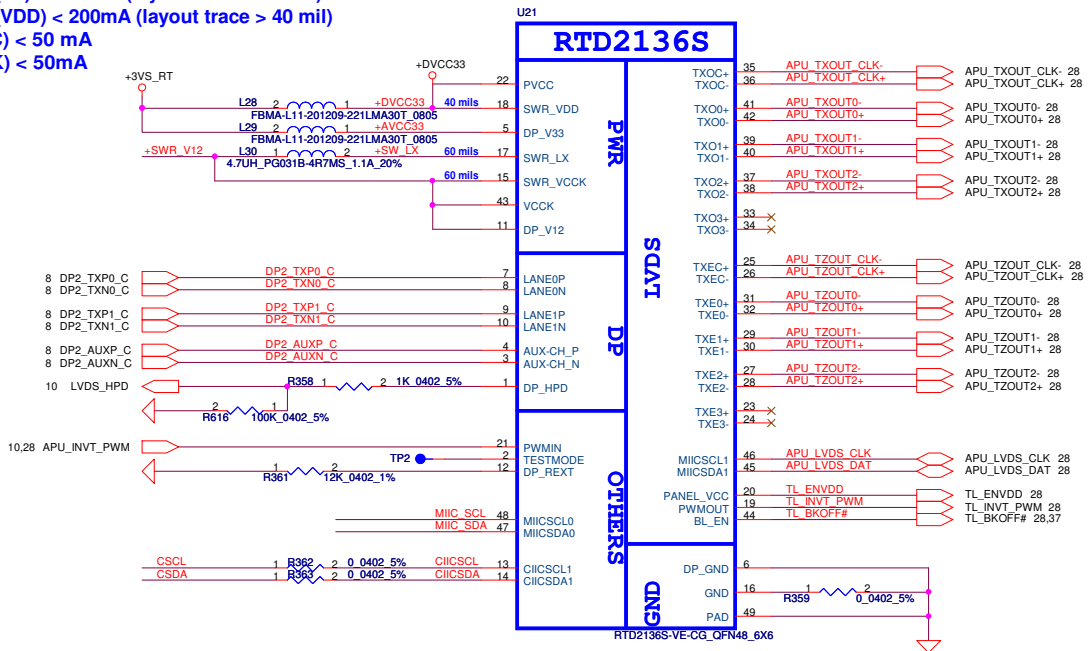
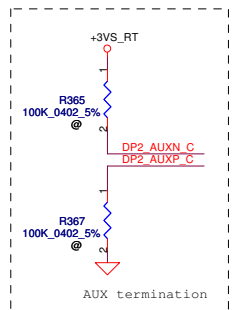
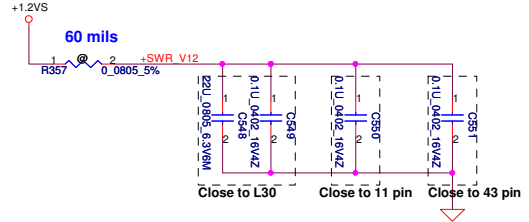
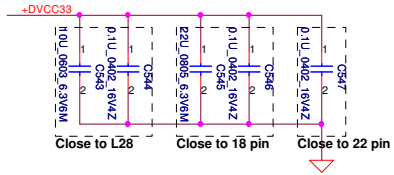
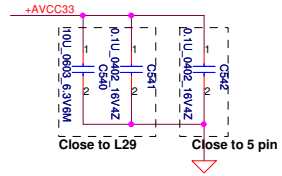
PCH (2/8) PCIE, SMBUS, CLK

Size: Custom  
 Document Number: QML70 LA-8371P  
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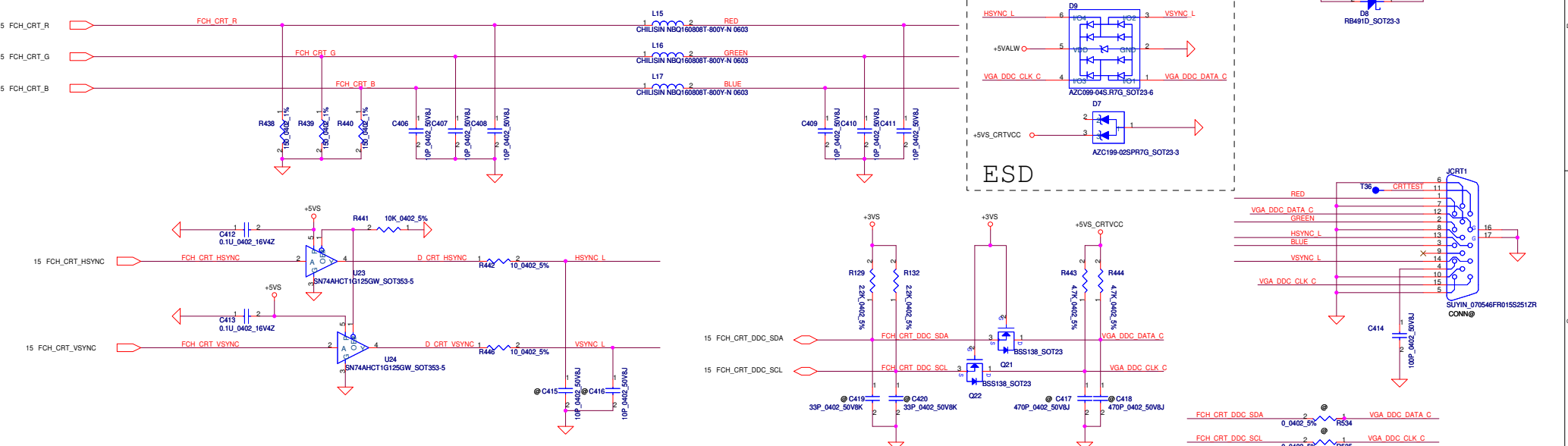
**Power Consumption:**

- Pin5 (DPV33) < 20mA
- Pin 11 (DPV12) < 100mA
- Pin 15 (SWR\_VCKK) < 100mA (layout trace > 60 mil)
- Pin 17 (SWR\_LX) < 600mA (layout trace > 60 mil)
- Pin 18 (SWR\_VDD) < 200mA (layout trace > 40 mil)
- Pin 22 (PVCC) < 50 mA
- Pin 43 (VCKK) < 50mA

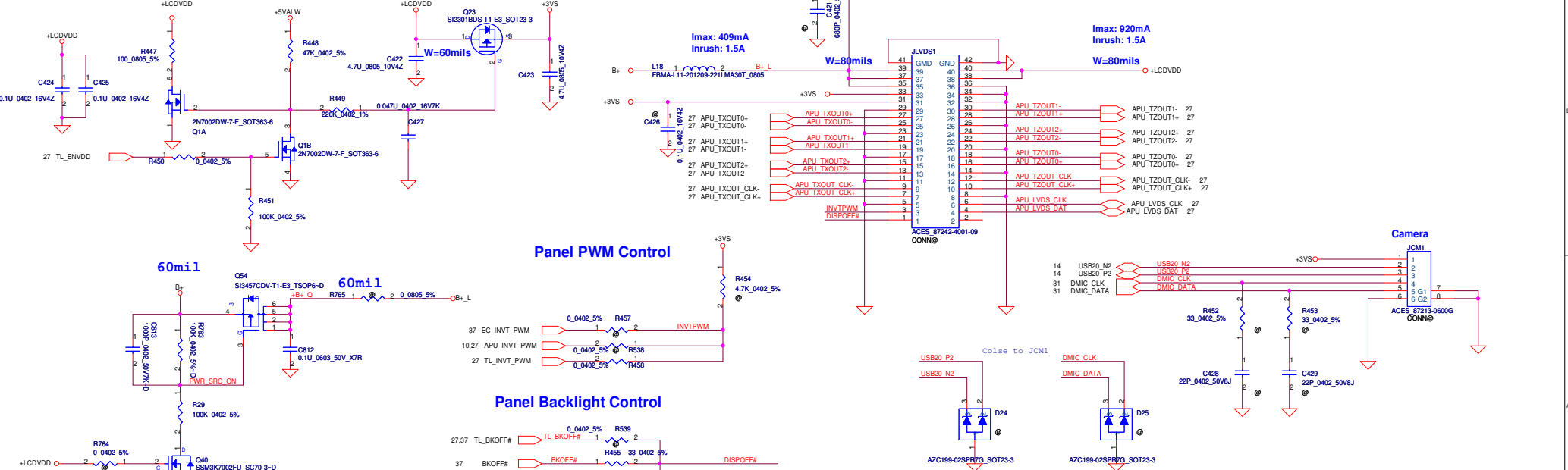


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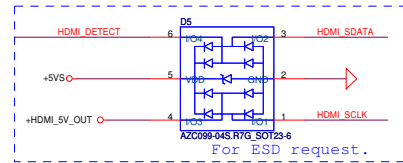
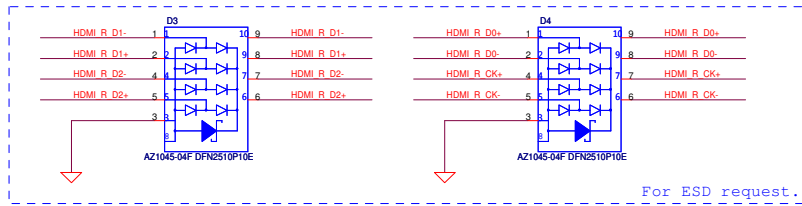
# CRT



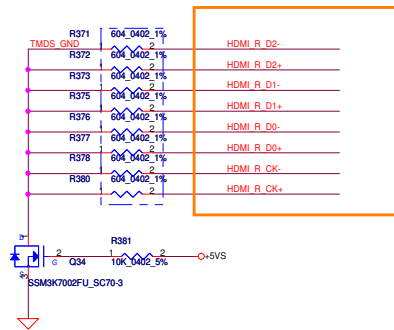
# LCD POWER CIRCUIT



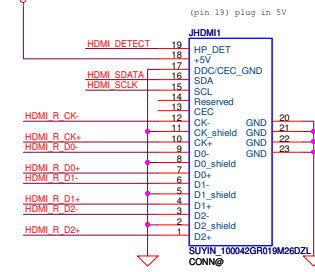
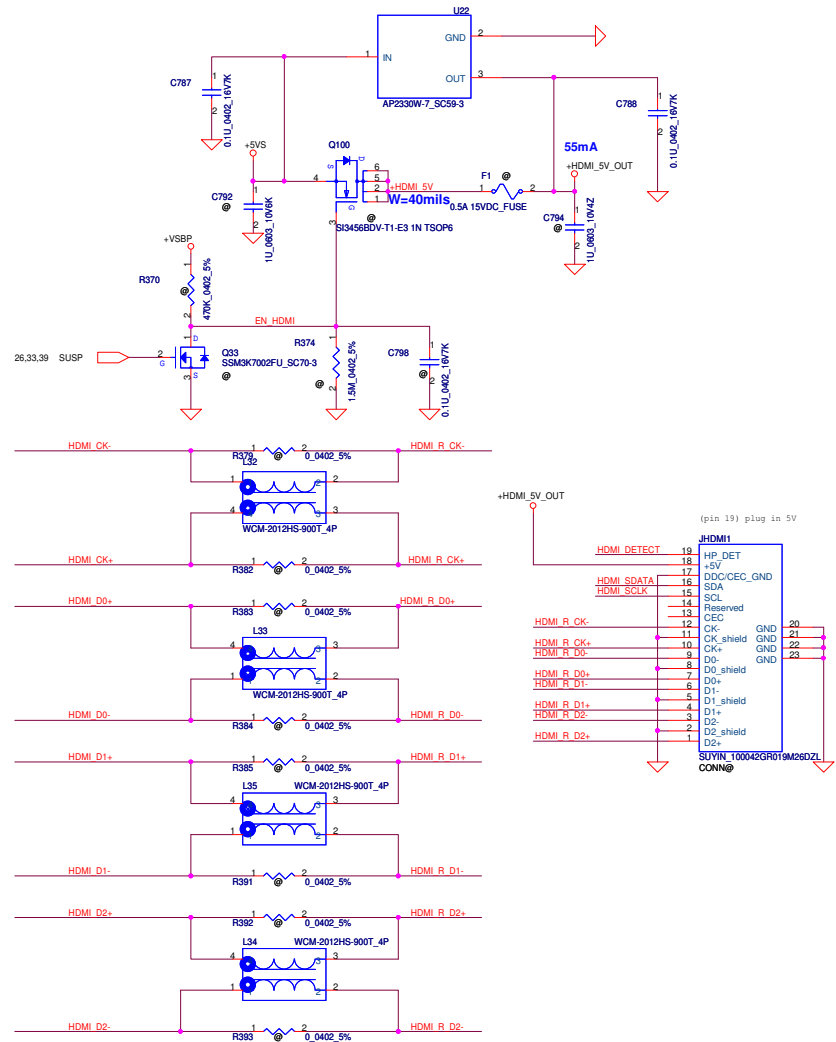
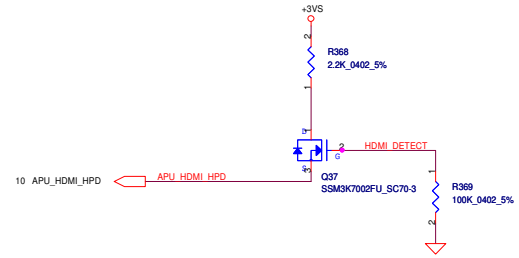
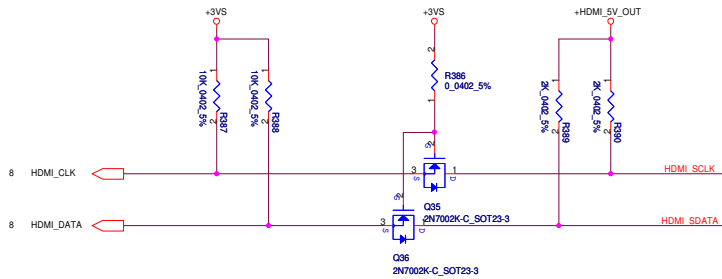
Security Classification	Compal Secret Data		Title	
Issued Date	2011/07/29	Deciphered Date	2012/07/29	P10-LVDS/CRT CONN
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8	HDMI_CLKP	HDMI_CLKP	0.1U_0402_16V7K	2	1	HDMI_CK-
8	HDMI_CLKN	HDMI_CLKN	0.1U_0402_16V7K	2	1	HDMI_CK+
8	HDMI_TX0P	HDMI_TX0P	0.1U_0402_16V7K	2	1	HDMI_D0+
8	HDMI_TX0N	HDMI_TX0N	0.1U_0402_16V7K	2	1	HDMI_D0-
8	HDMI_TX1P	HDMI_TX1P	0.1U_0402_16V7K	2	1	HDMI_D1+
8	HDMI_TX1N	HDMI_TX1N	0.1U_0402_16V7K	2	1	HDMI_D1-
8	HDMI_TX2P	HDMI_TX2P	0.1U_0402_16V7K	2	1	HDMI_D2+
8	HDMI_TX2N	HDMI_TX2N	0.1U_0402_16V7K	2	1	HDMI_D2-



HDMI



W=60mils

W=60mils

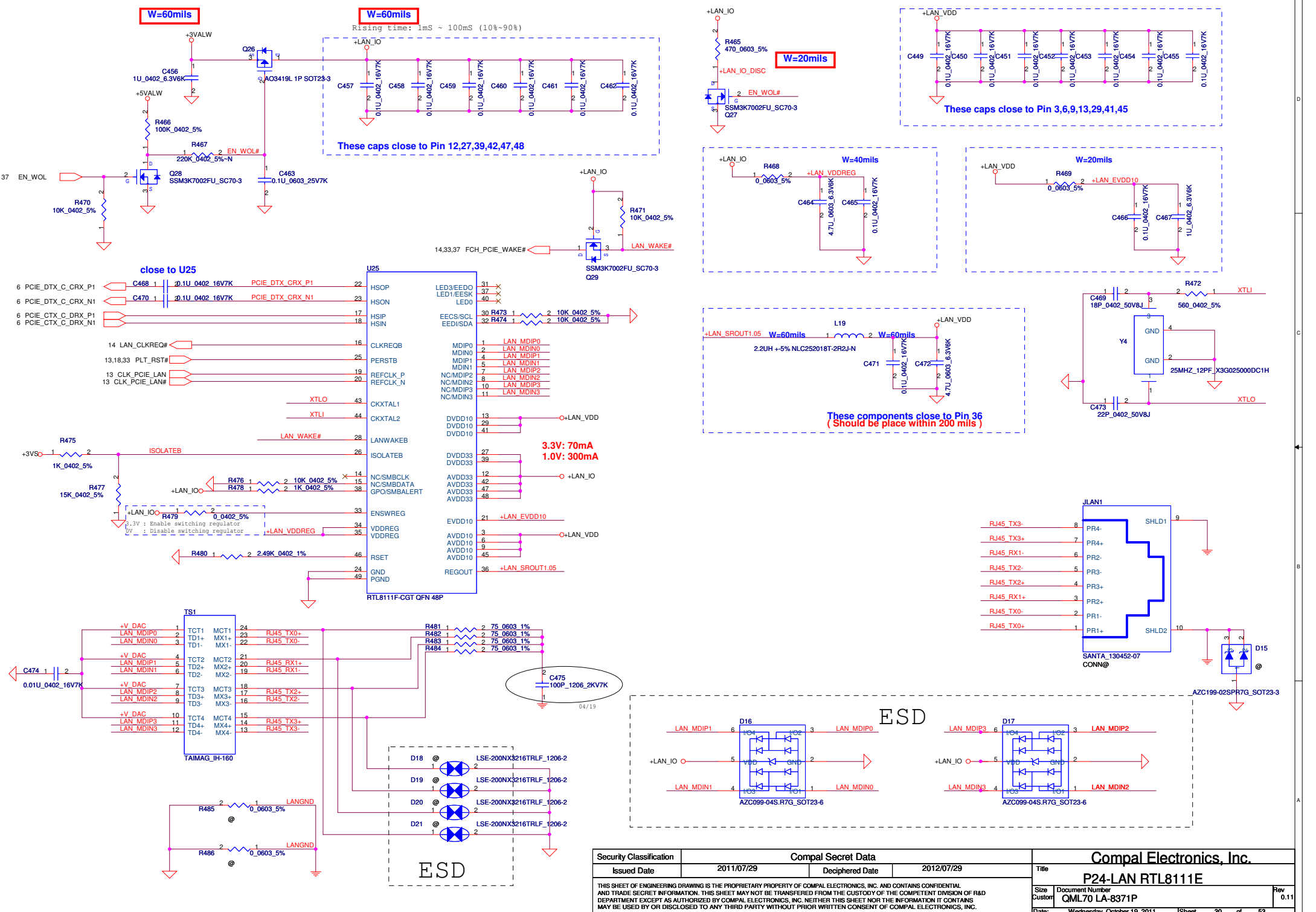
Rising time: 1ms ~ 100ms (10%~90%)

W=20mils

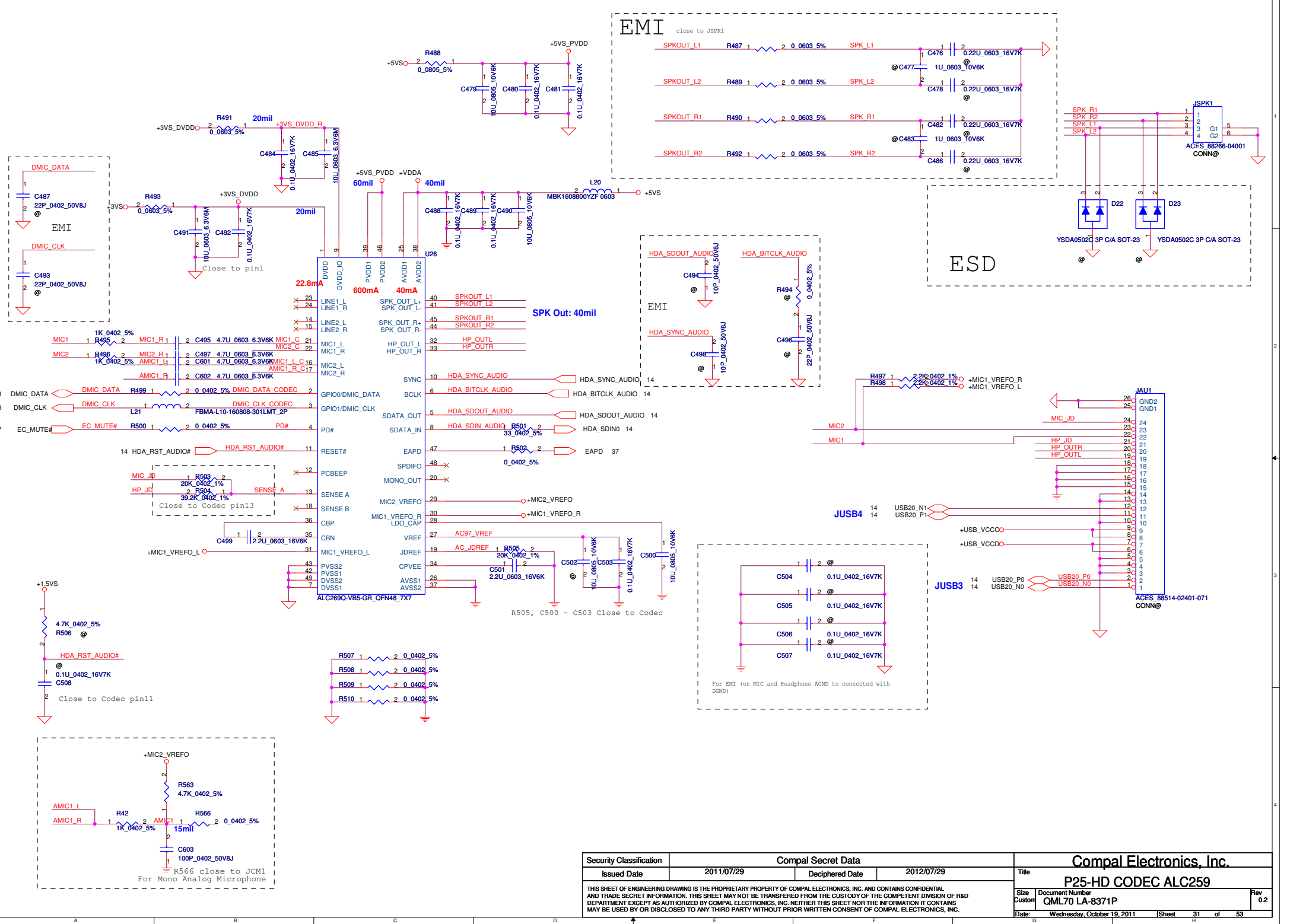
These caps close to Pin 3,6,9,13,29,41,45

These caps close to Pin 12,27,39,42,47,48

These components close to Pin 36 (Should be place within 200 mils)



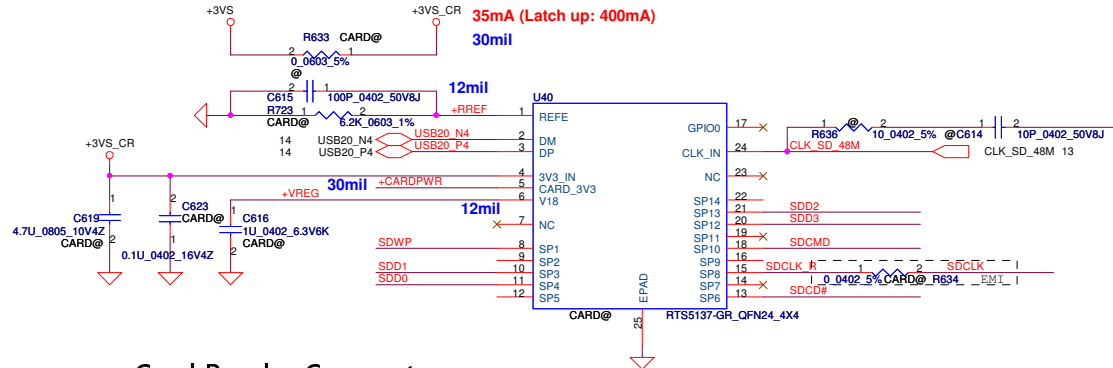
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Issued Date	2011/07/29	Deciphered Date	2012/07/29	P21-LAN RTL8111E	
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Customer	QML70 LA-8371P	Document Number	QML70 LA-8371P	30	9.11
Date	Wednesday, October 19, 2011	Sheet	30	of 53	



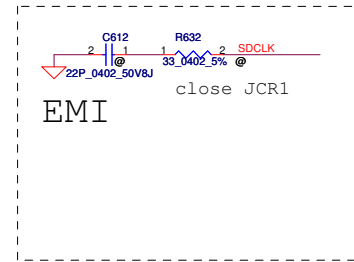
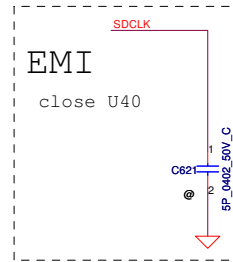
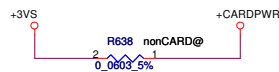
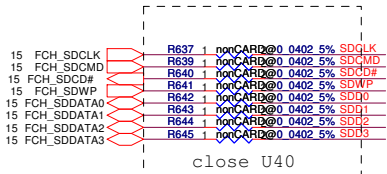
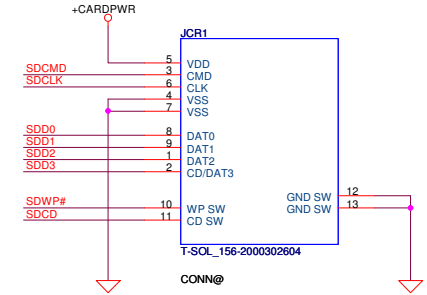
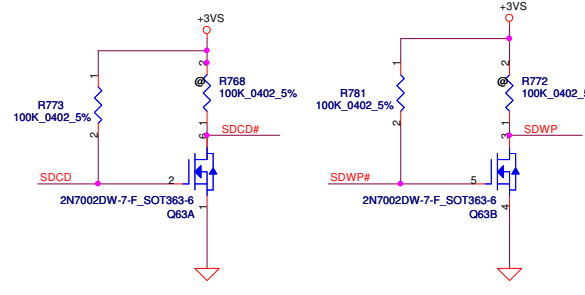
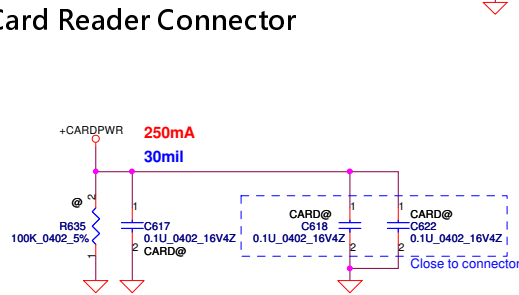
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Issued Date	2011/07/29	Deciphered Date	2012/07/29	Compal Electronics, Inc.	
				P25-HD CODEC ALC259	
Size	Document Number	Rev			
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# Card Reader RTS5137 (only SD/MMC/MS function)

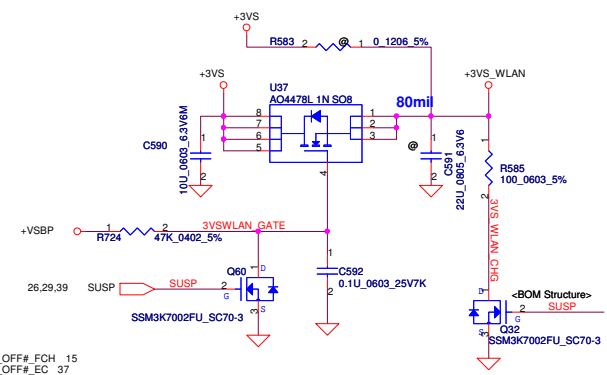
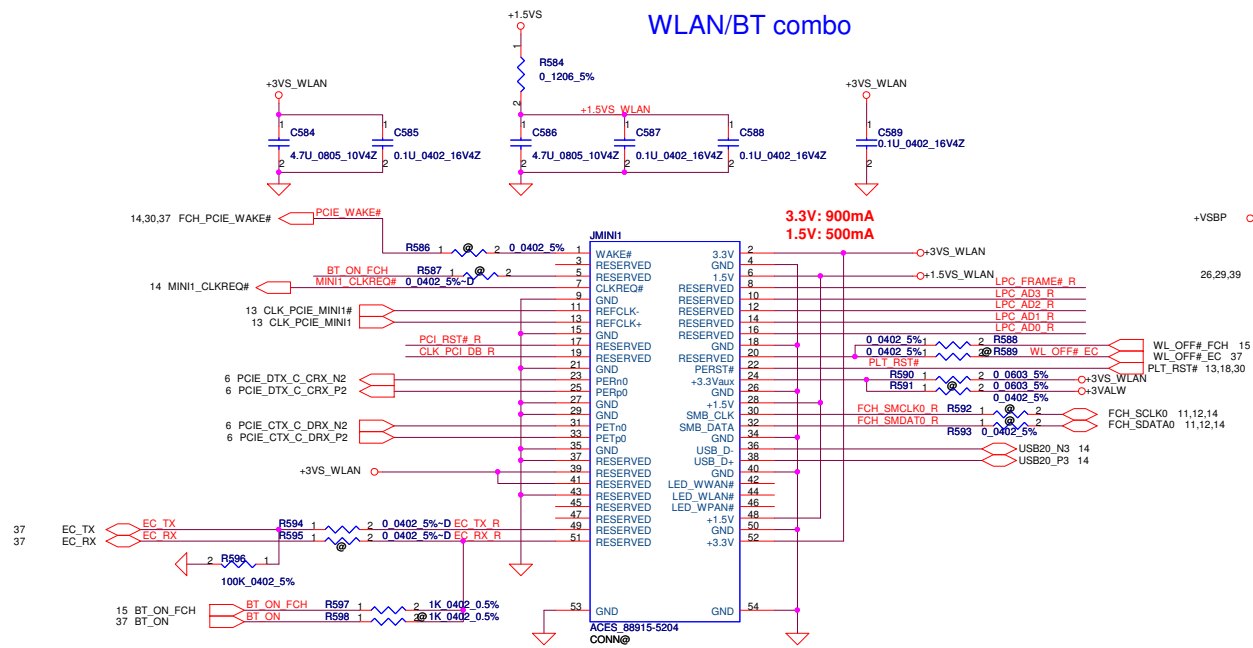


## Card Reader Connector



Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2011/07/29	Deciphered Date	2012/07/29	Title <b>P26-RTS5137 Media Card Controller</b>	
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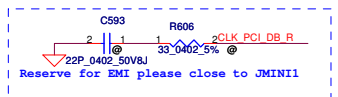




5.2 mm High

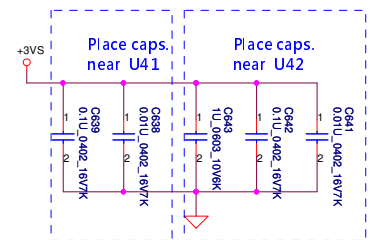
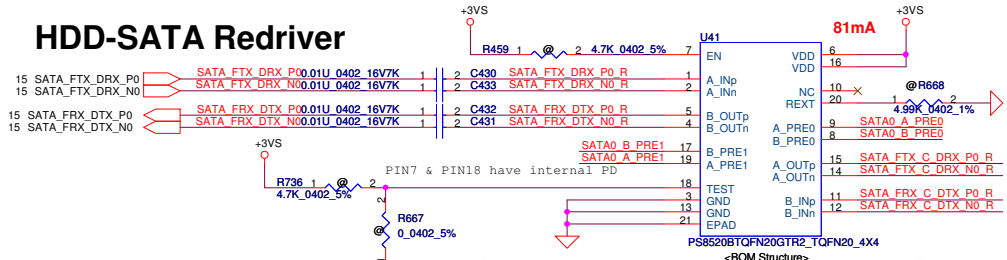
**Reserve for SW mini-pcie debug card.  
Series resistors closed to KBC side.**

LPC_FRAME#_R	R599	1	2	0.0402 5%	LPC_FRAME#	LPC_FRAME#	13.37
LPC_AD3#_R	R600	1	2	0.0402 5%	LPC_AD3	LPC_AD3	13.37
LPC_AD2#_R	R601	1	2	0.0402 5%	LPC_AD2	LPC_AD2	13.37
LPC_AD1#_R	R602	1	2	0.0402 5%	LPC_AD1	LPC_AD1	13.37
LPC_AD0#_R	R603	1	2	0.0402 5%	LPC_AD0	LPC_AD0	13.37
PLT_RST#_R	R604	1	2	0.0402 5%	PLT_RST#	LPC_AD0	13.37
CLK_PCI_DB#_R	R605	1	2	0.0402 5%	CLK_PCI_DB	CLK_PCI_DB	13

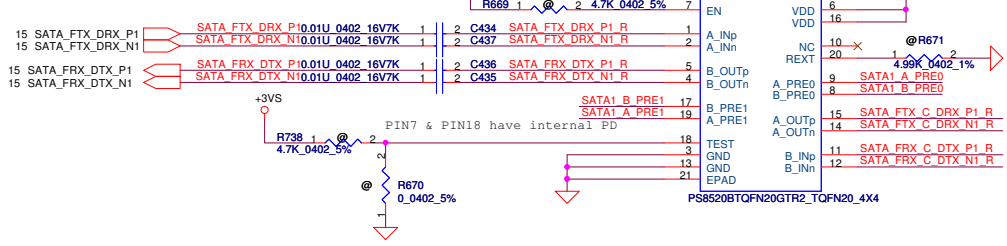


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Size Custom	Document Number	QML70 LA-8371P		Rev 0.2
Date:	Wednesday, October 19, 2011	Sheet	33	of 53

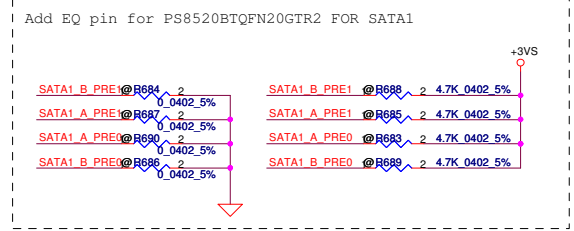
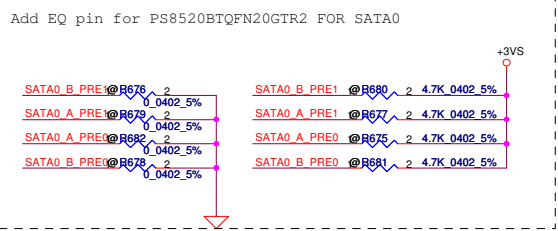
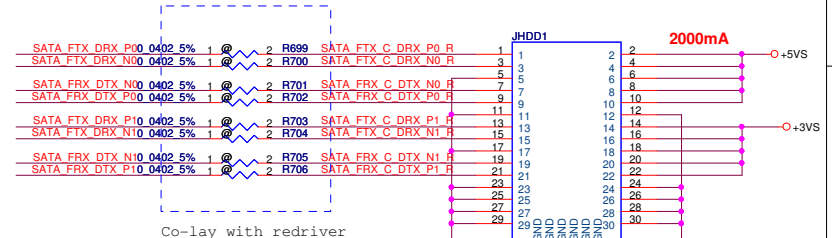
# HDD-SATA Redriver



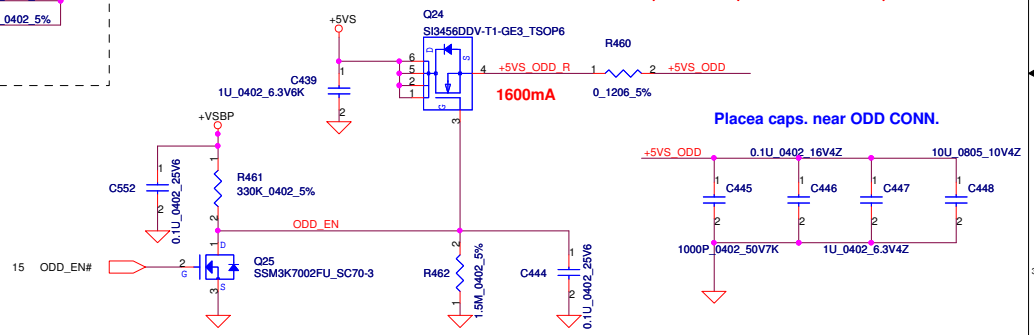
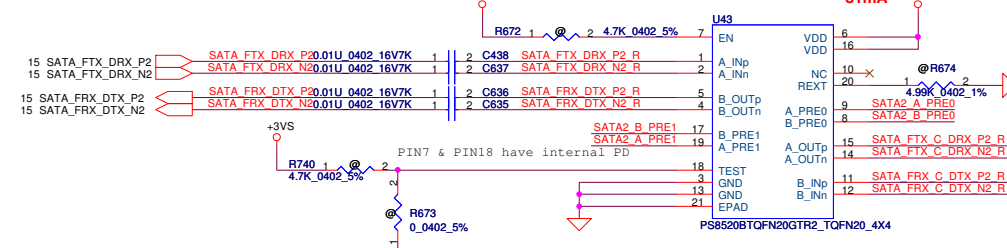
# HDD-SATA Redriver



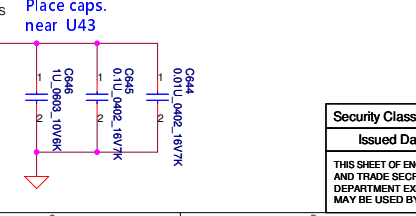
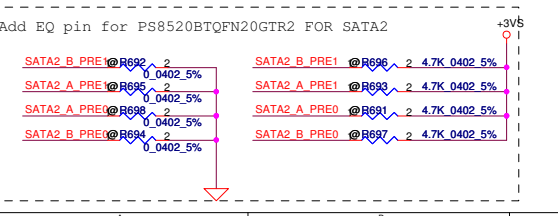
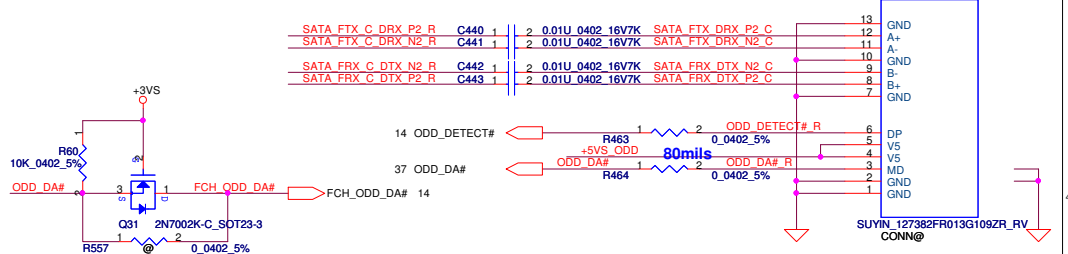
# SATA HDD BTB Conn.



# ODD-SATA Redriver

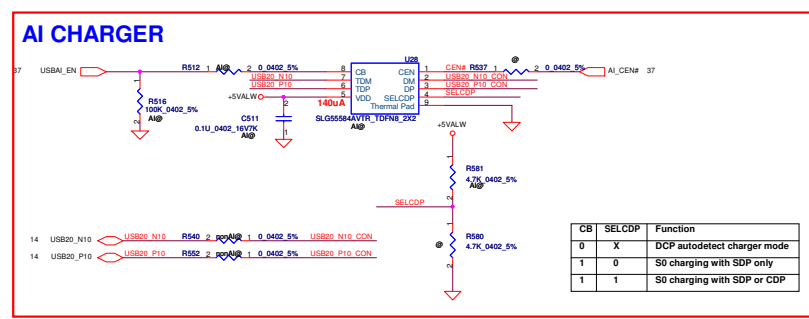
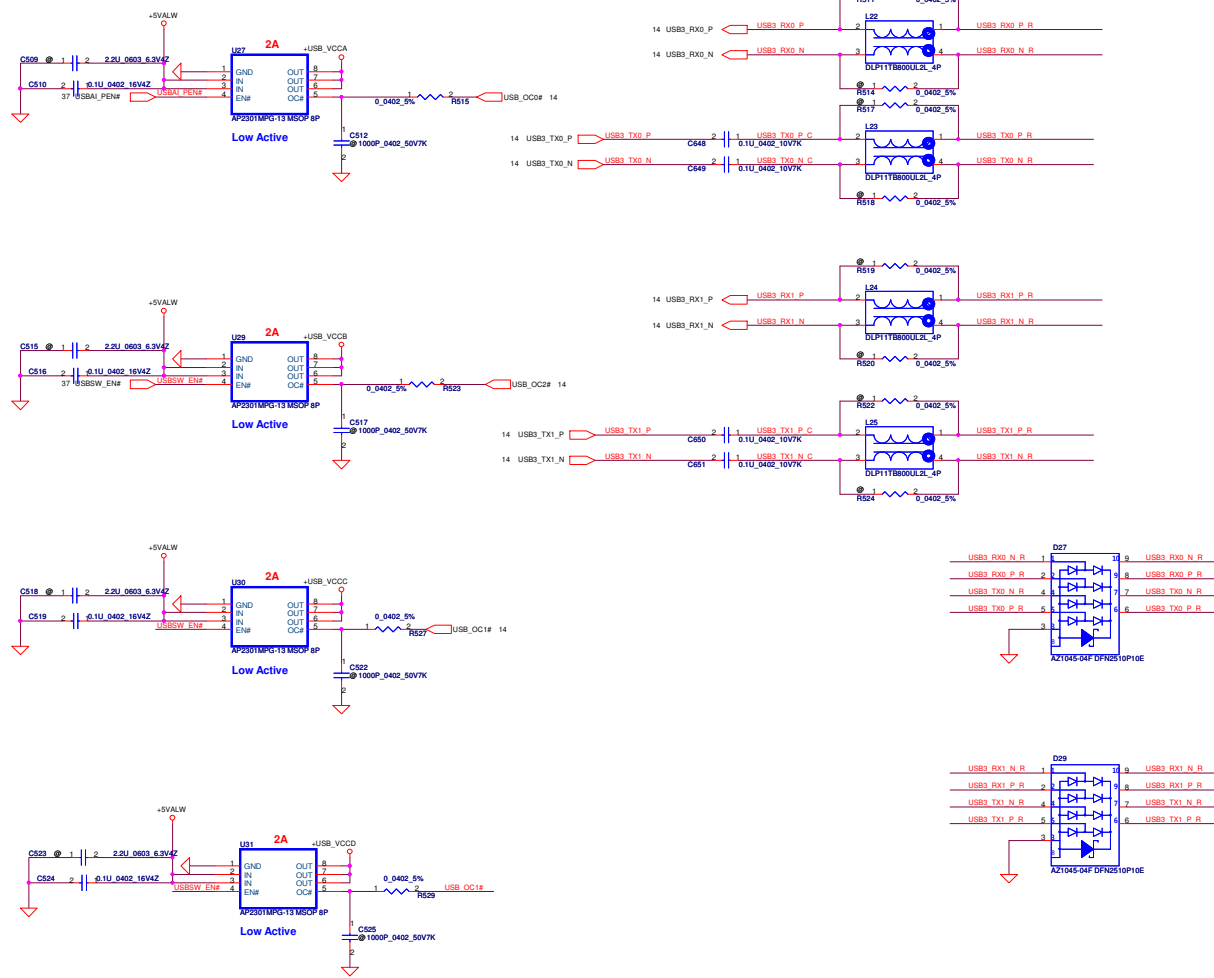


# SATA ODD Conn.

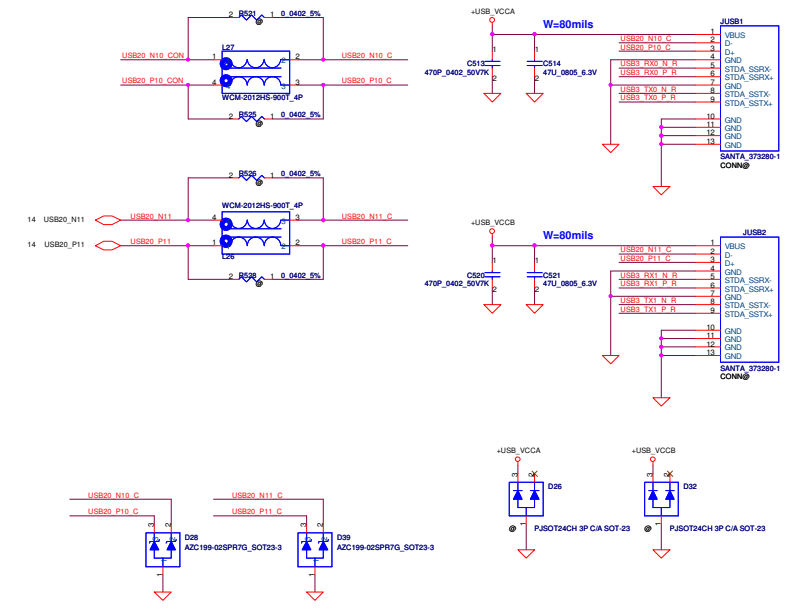


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Issued Date	2011/07/29	Deciphered Date	2012/07/29	Compal Electronics, Inc.	
				P28-HDD & ODD CONN	
				QML70 LA-8371P	
				Date: Wednesday, October 19, 2011   Sheet 34 of 53	

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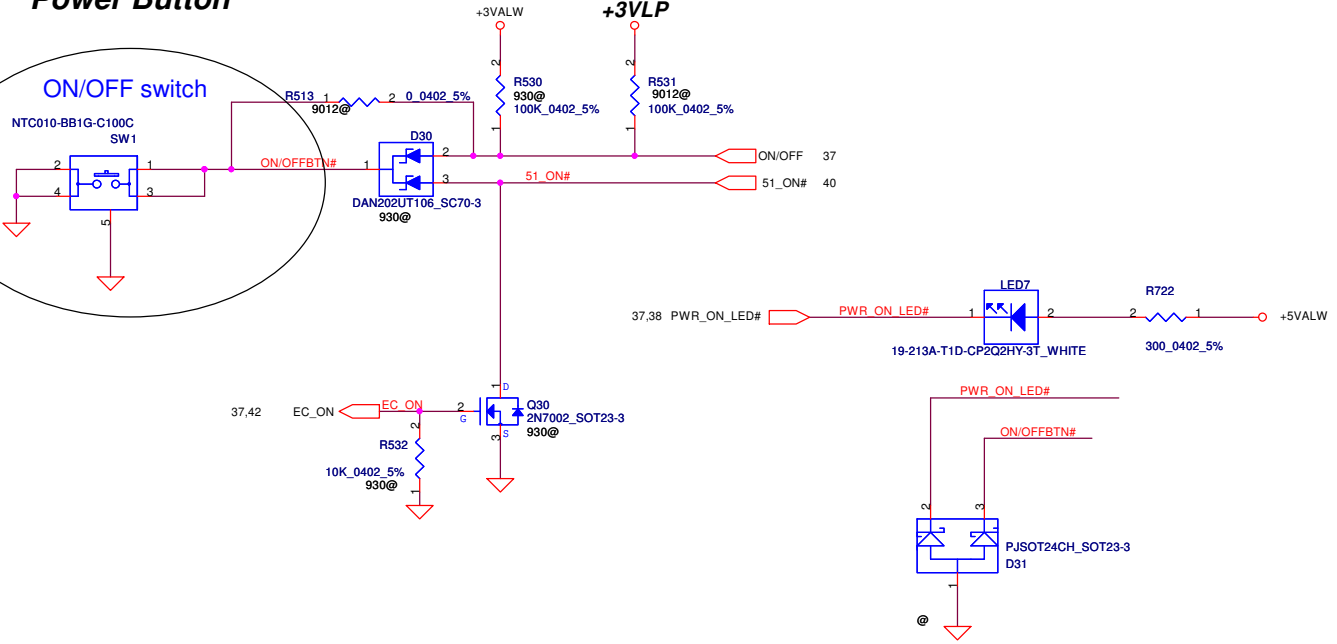


charger port: left side & near user

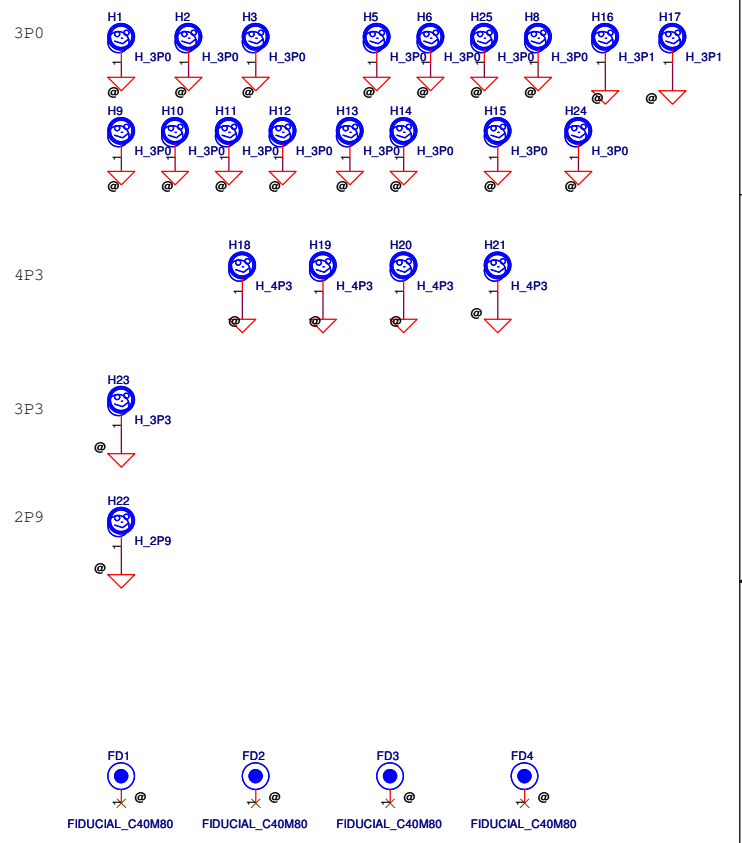


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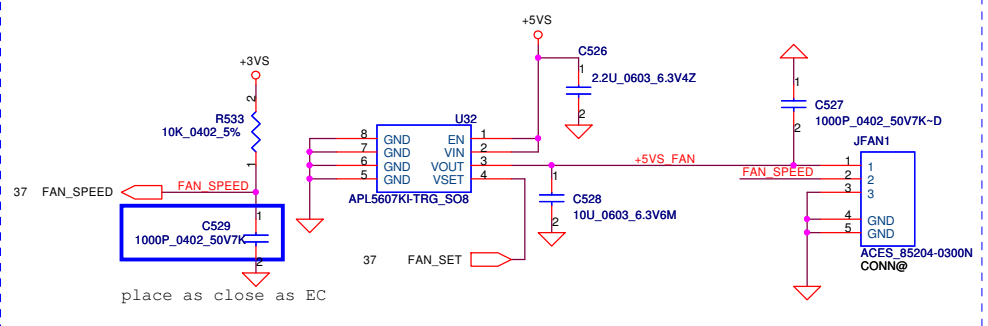
# Power Button



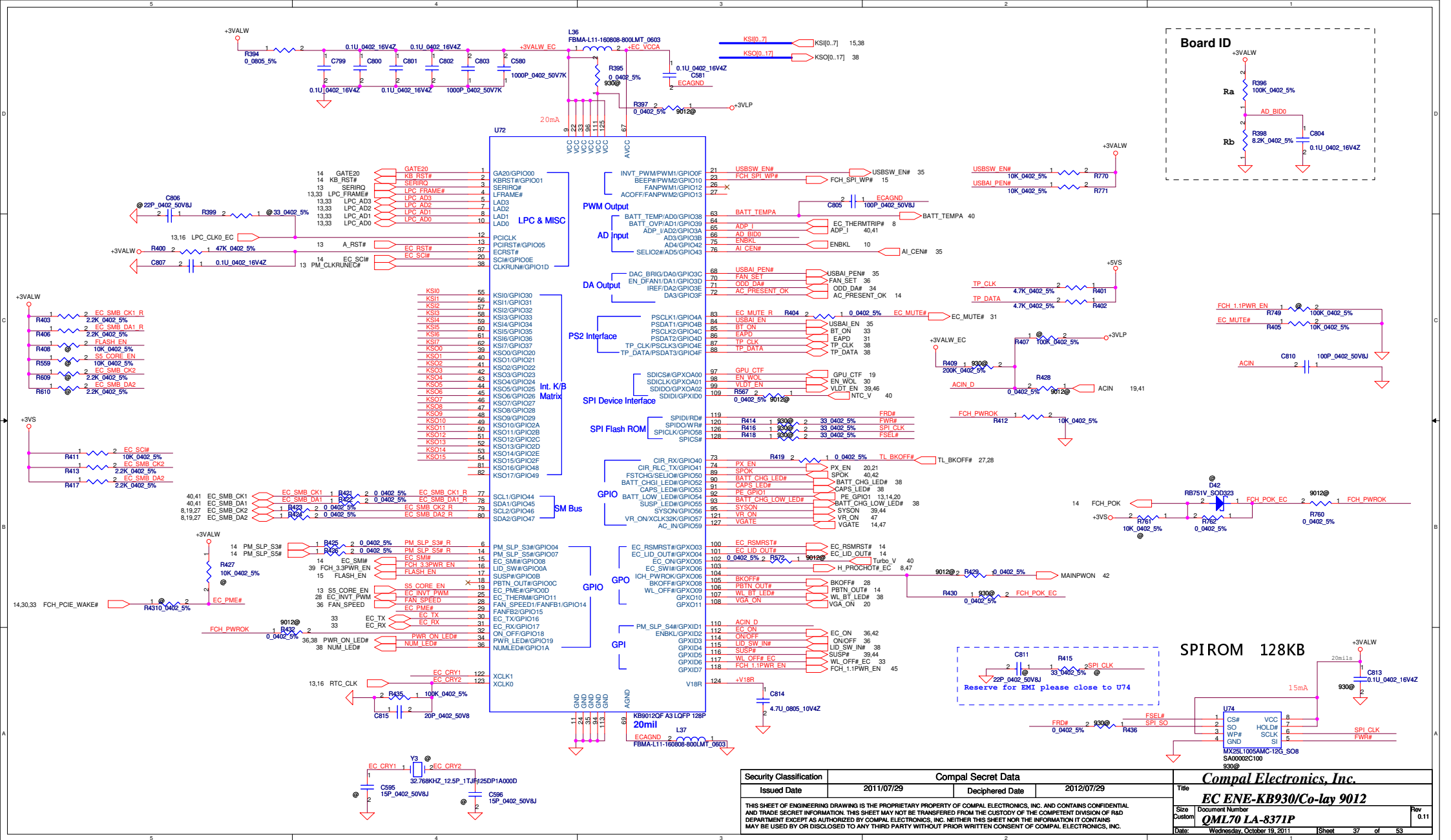
# Screw Hole



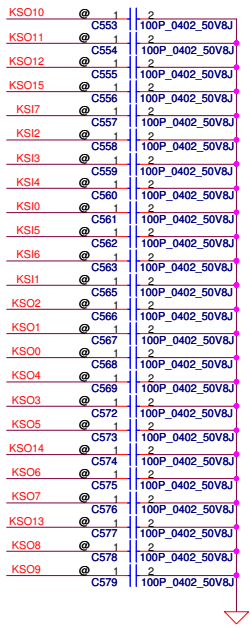
# Fan Control Circuit



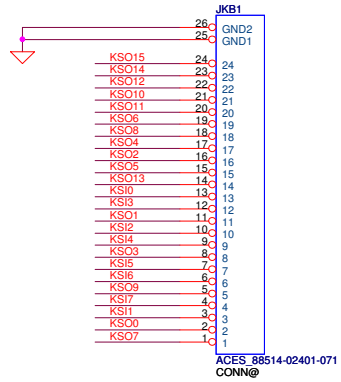
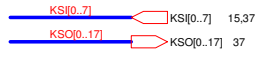
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Size Custom	Document Number	Date		Sheet	Rev
	<b>QML70 LA-8371P</b>	Wednesday, October 19, 2011		36	0.11
				of	53



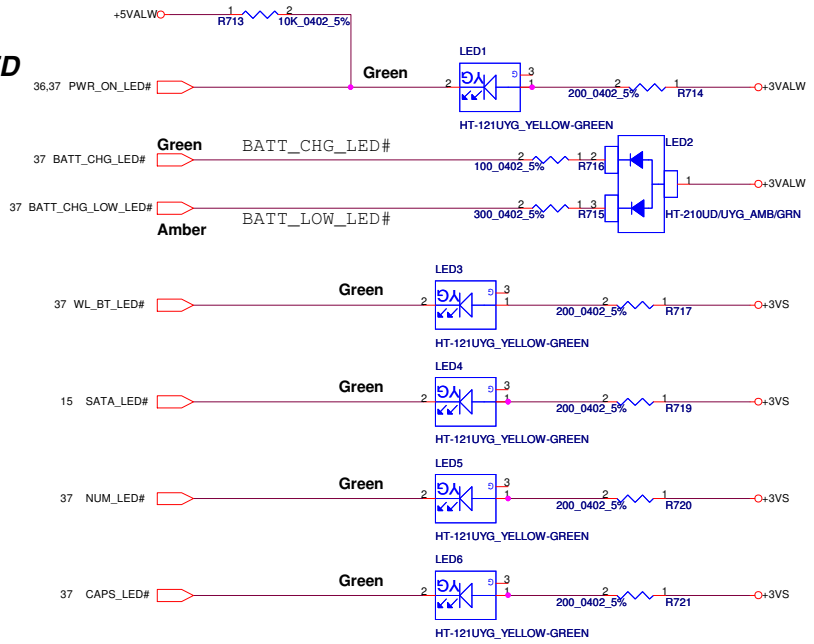
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<b>Compal Electronics, Inc.</b> <b>EC ENE-KB930/Co-lay 9012</b>		<b>QML70 LA-8371P</b>	
Size	Document Number	Rev	
Custom	QML70 LA-8371P	0.11	
Date:	Wednesday, October 19, 2011	Sheet	37 of 53



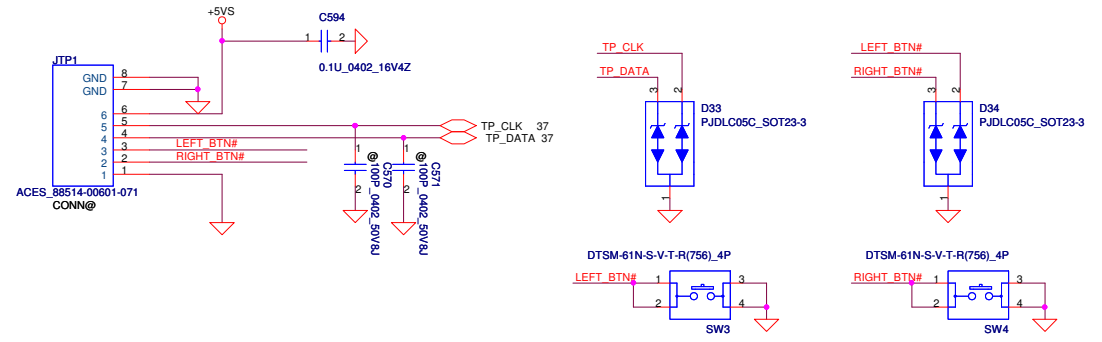
### INT\_KBD Conn.



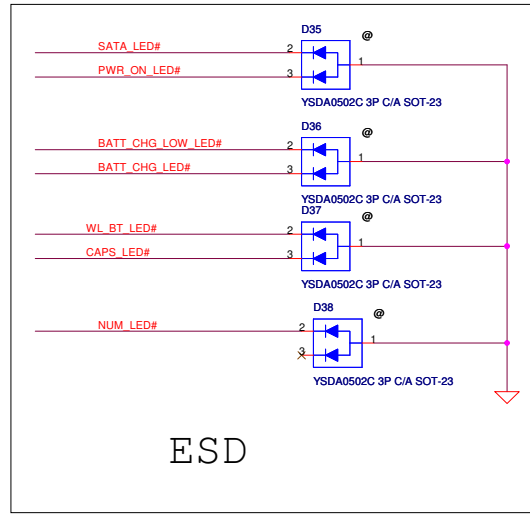
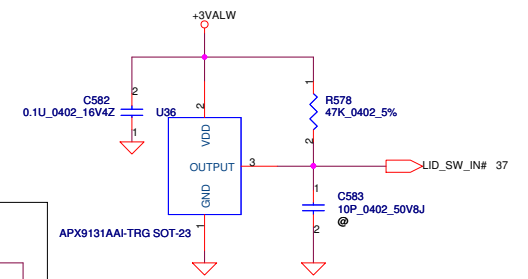
### LED



### Touch/B Connector

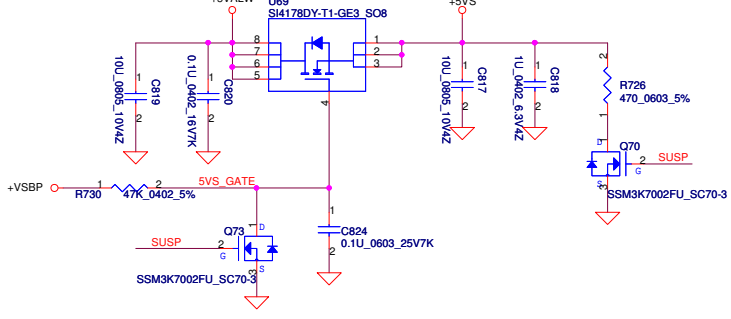


### Lid Switch (Hall Effect Switch)

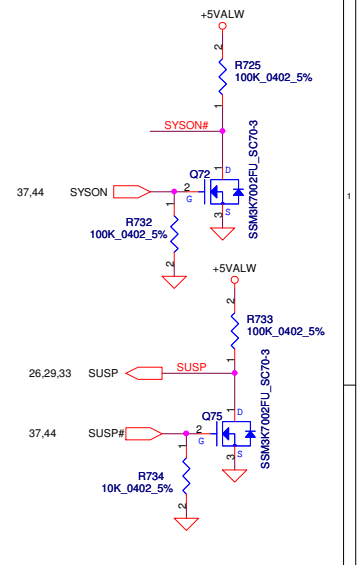
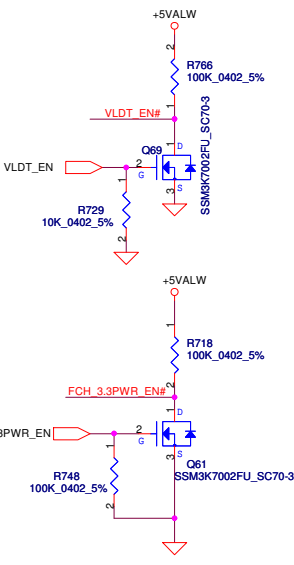
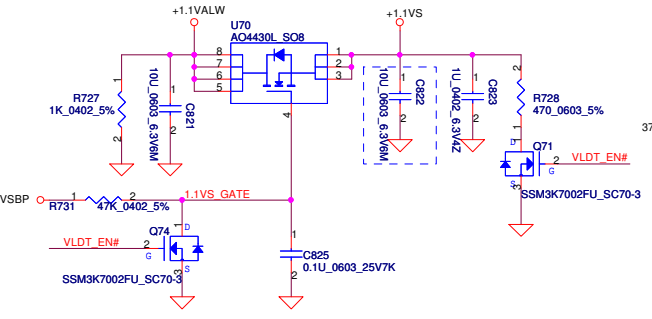


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Date	Wednesday, October 19, 2011	Sheet	38	of 53

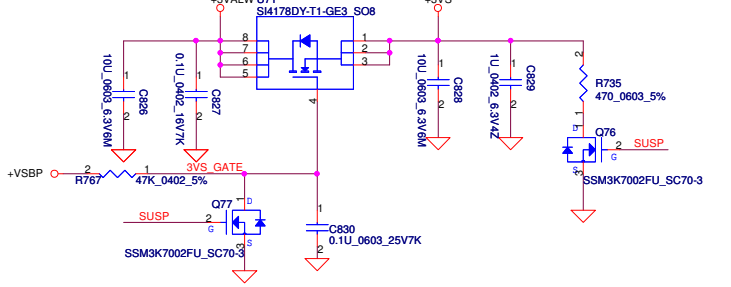
**+5VALW TO +5VS (5.35A)**



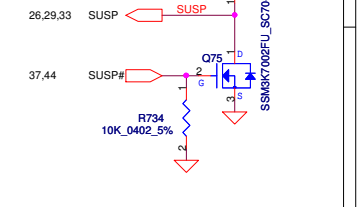
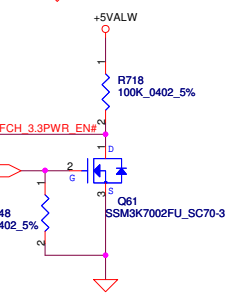
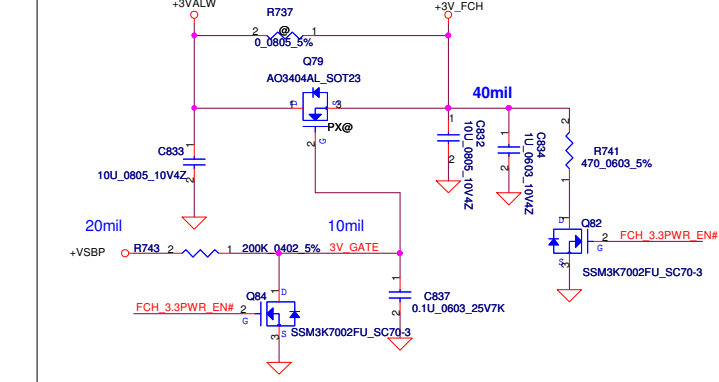
**+1.1VALW TO +1.1VS (4A)**



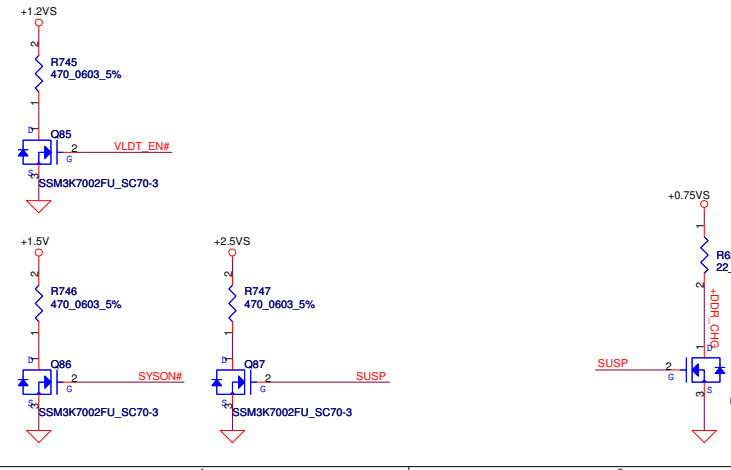
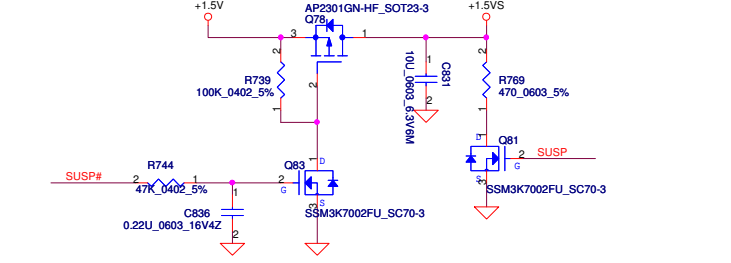
**+3VALW TO +3VS (3A)**



**Instant On +3VALW TO +3V\_FCH (1A)**



**+1.5V TO +1.5VS (0.5A)**

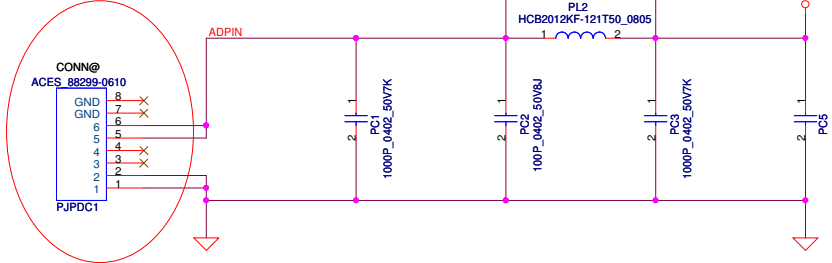


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		2012/07/29

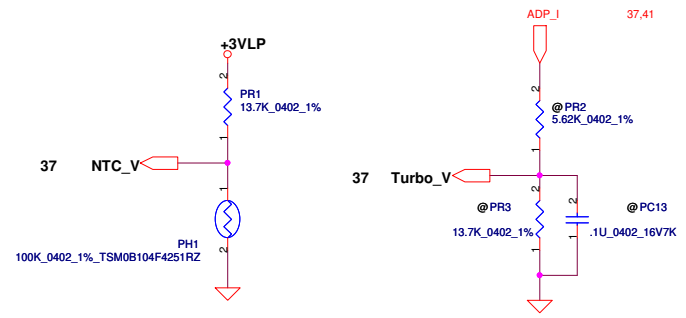
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Compal Electronics, Inc.		
DC Interface		
Size B	Document Number	Rev
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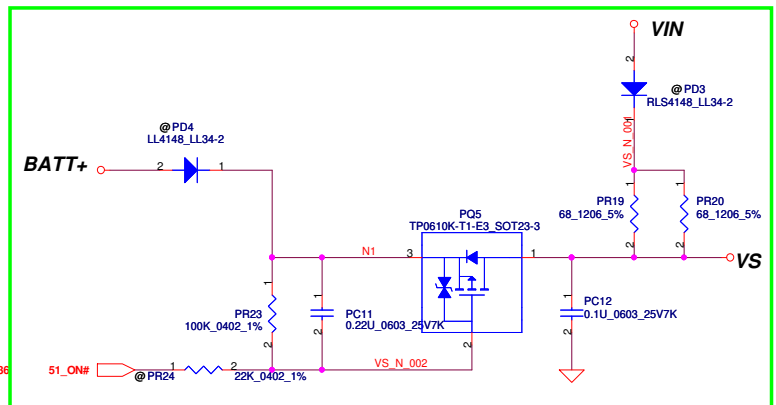
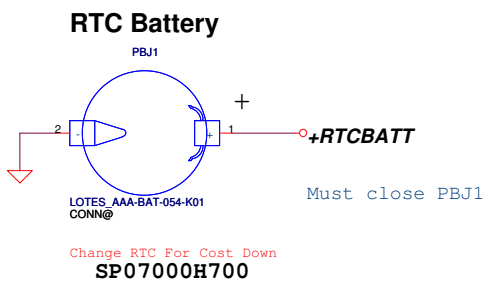
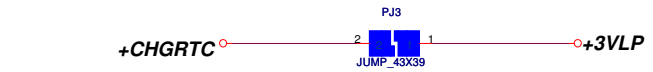
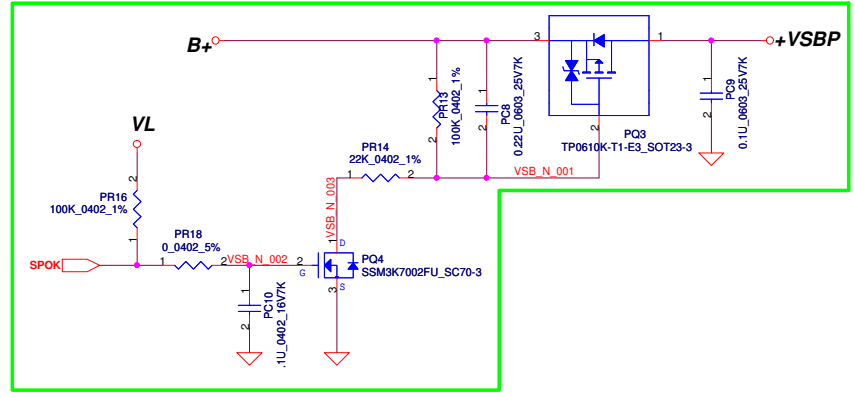
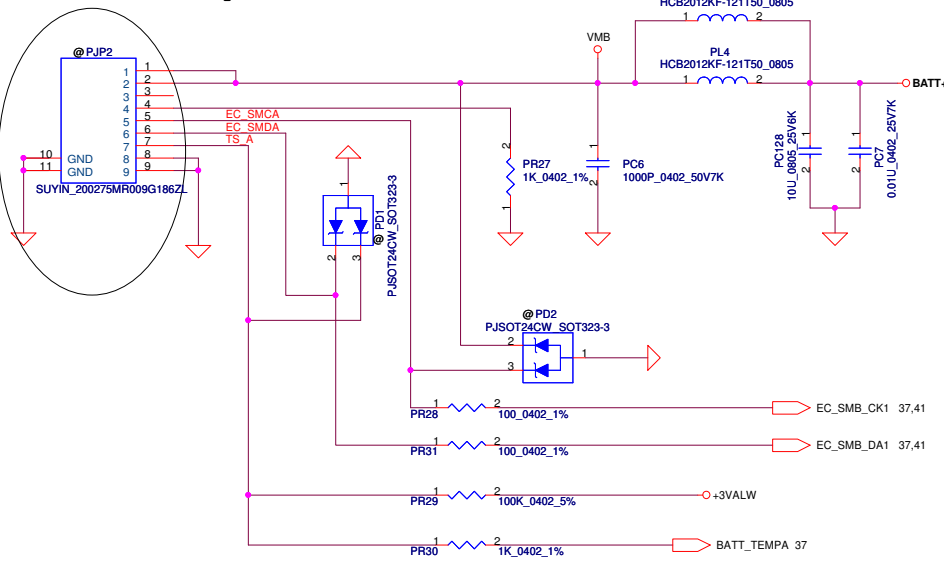
DCIN jack P/N:SP02000N00,  
need doble confirm P/N with ME



PH901 under CPU botten side :  
CPU thermal protection at 90 degree C  
Recovery at 50 degree C



Change DC040007T0L to DC040004L00  
( Use DC040001V00 symbol )

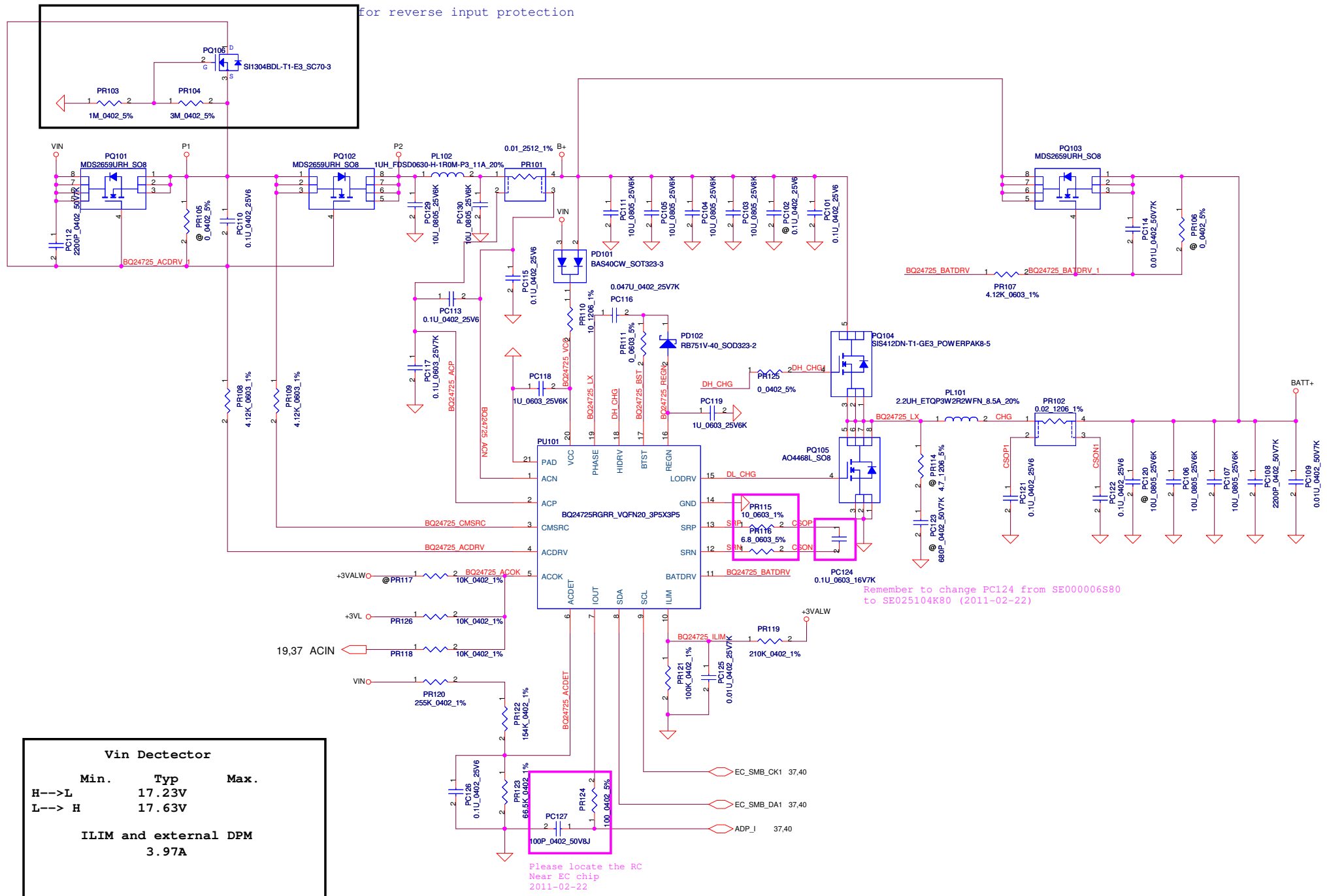


For KB9012 --> Remove all 51\_ON# circuit

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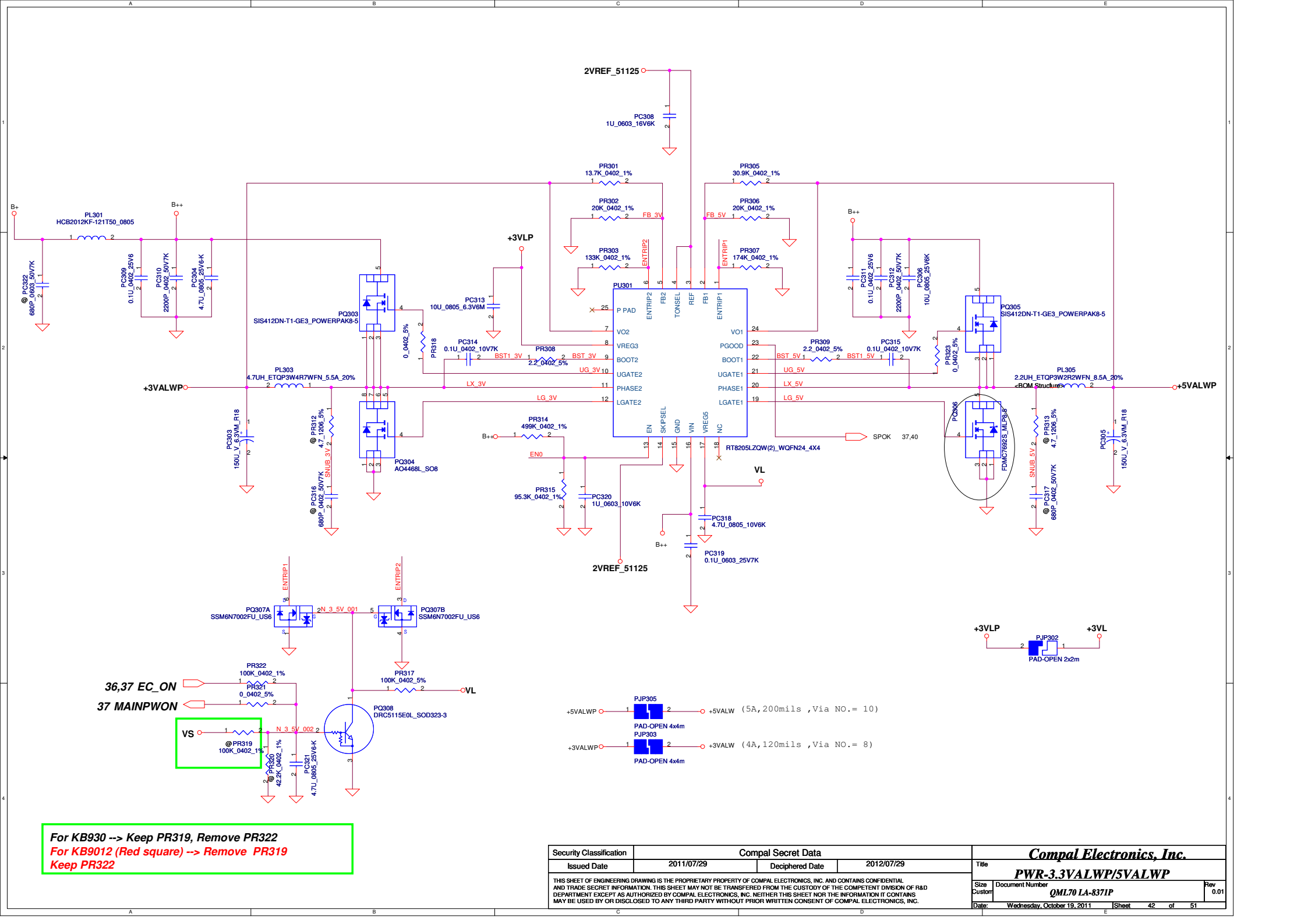
for reverse input protection



Vin Detector			
	Min.	Typ	Max.
H-->L		17.23V	
L-->H		17.63V	
ILIM and external DPM			
3.97A			

Please locate the RC  
Near EC chip  
2011-02-22

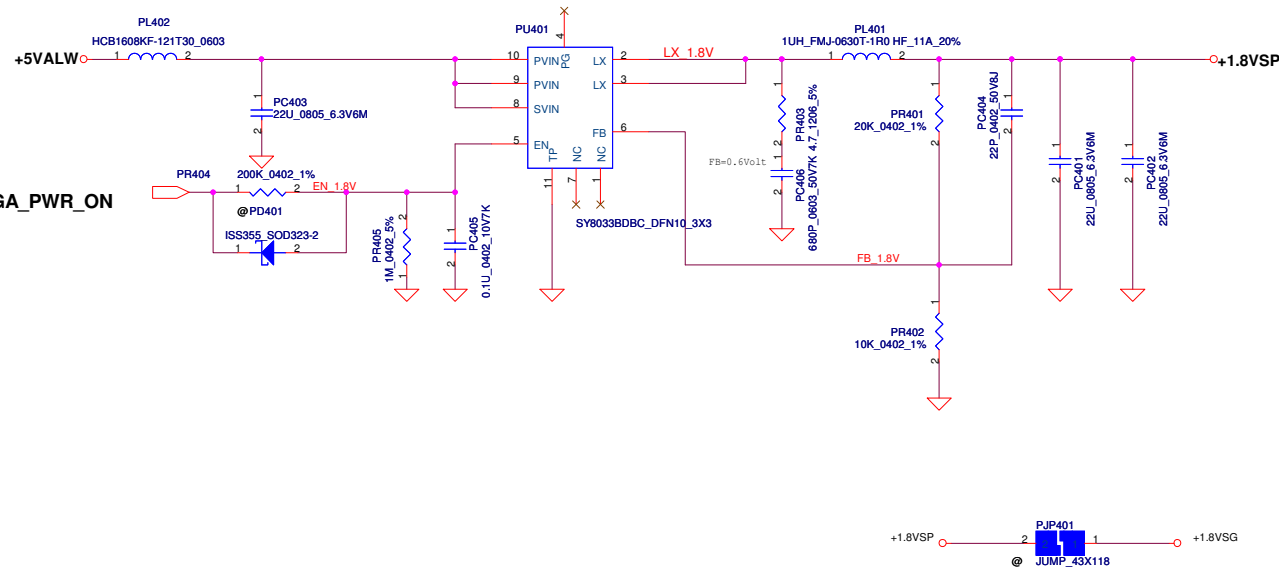
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Issued Date	2011/07/29	Deciphered Date	2012/07/29	Title	
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For KB930 --> Keep PR319, Remove PR322  
 For KB9012 (Red square) --> Remove PR319  
 Keep PR322

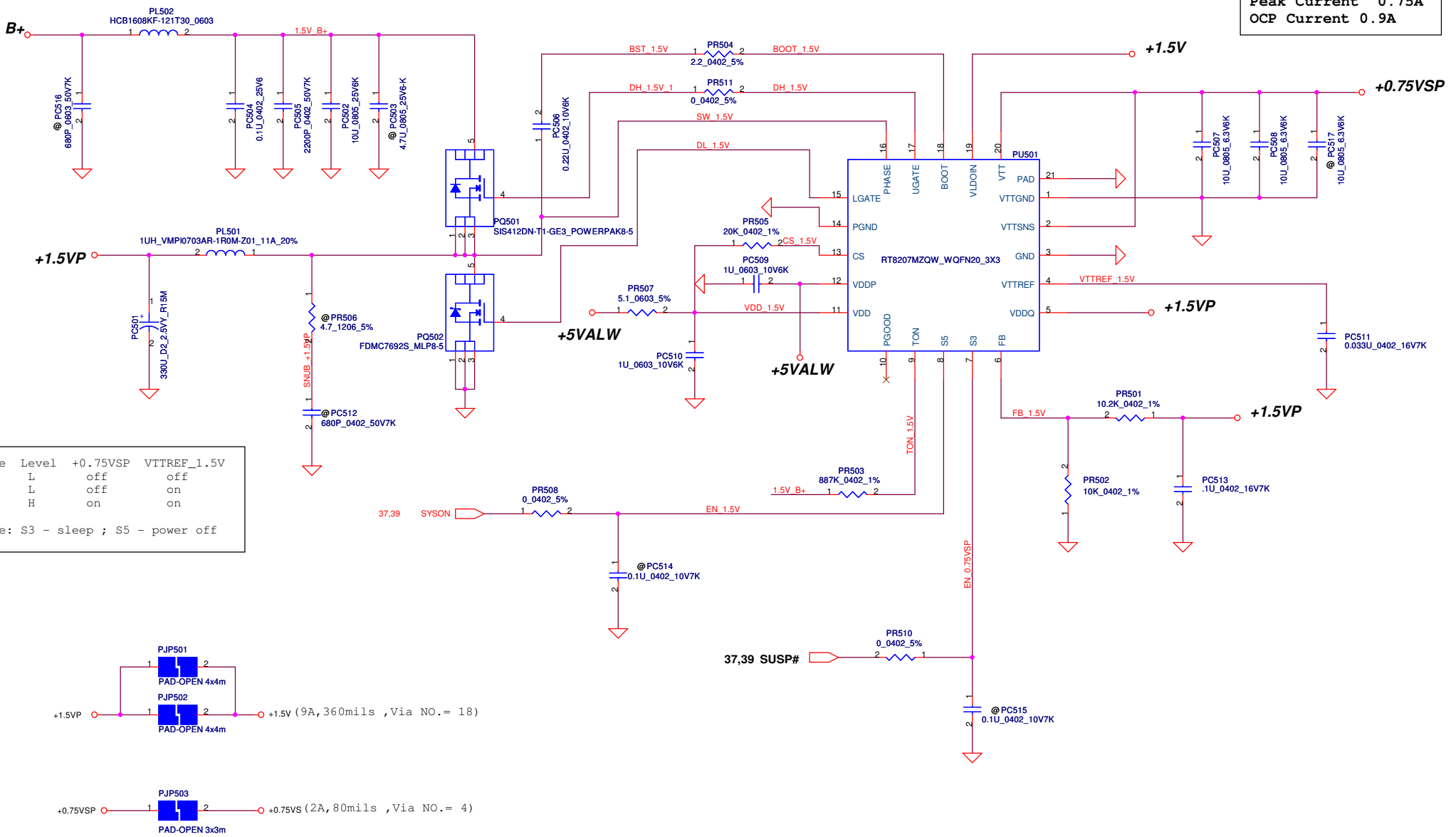
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20,26,49 VGA\_PWR\_ON



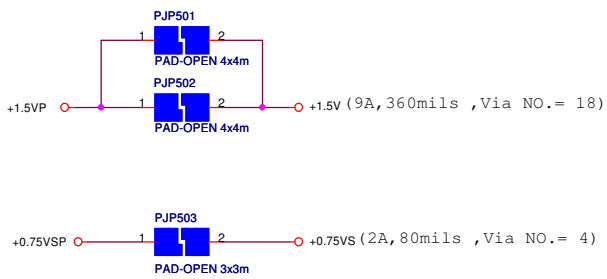
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Issued Date	2011/07/29	Deciphered Date		<b>+1.8VP</b>	
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0.75Volt +/- 5%  
 TDC 0.525A  
 Peak Current 0.75A  
 OCP Current 0.9A

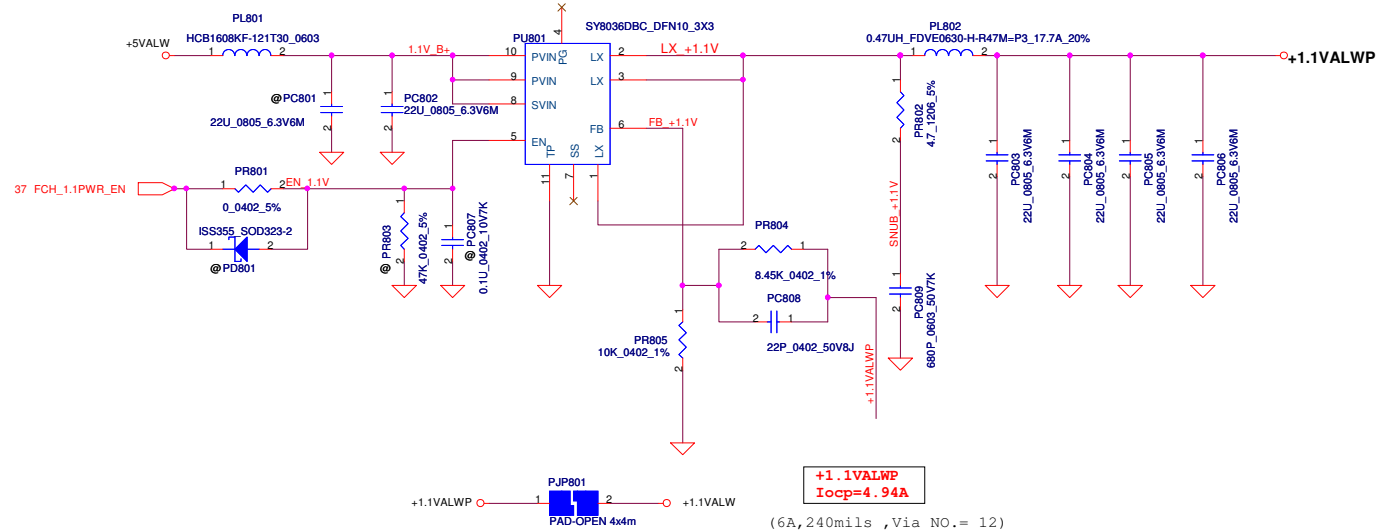


Mode	Level	+0.75VSP	VITREF_1.5V
S5	L	off	off
S3	L	off	on
S0	H	on	on

Note: S3 - sleep ; S5 - power off

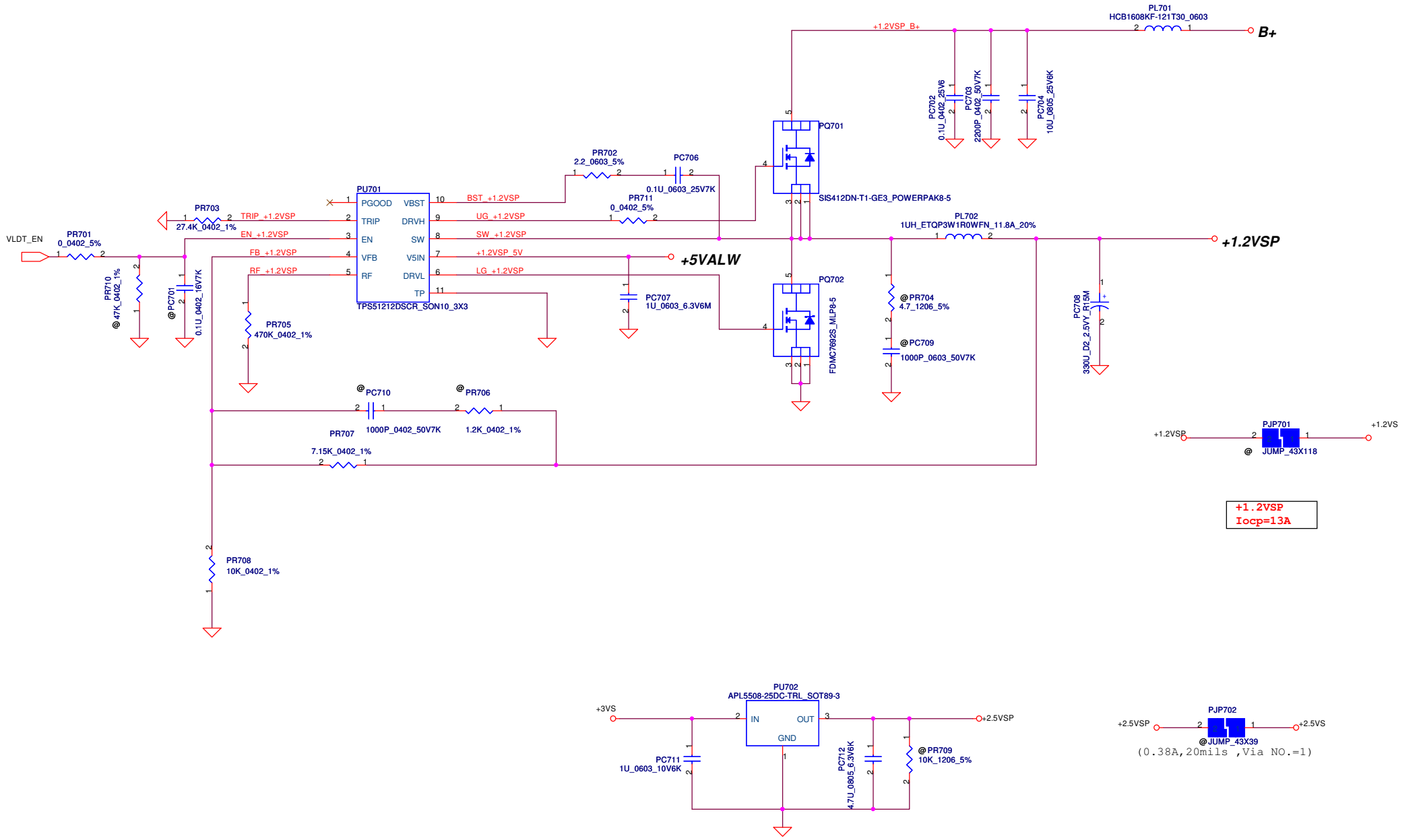


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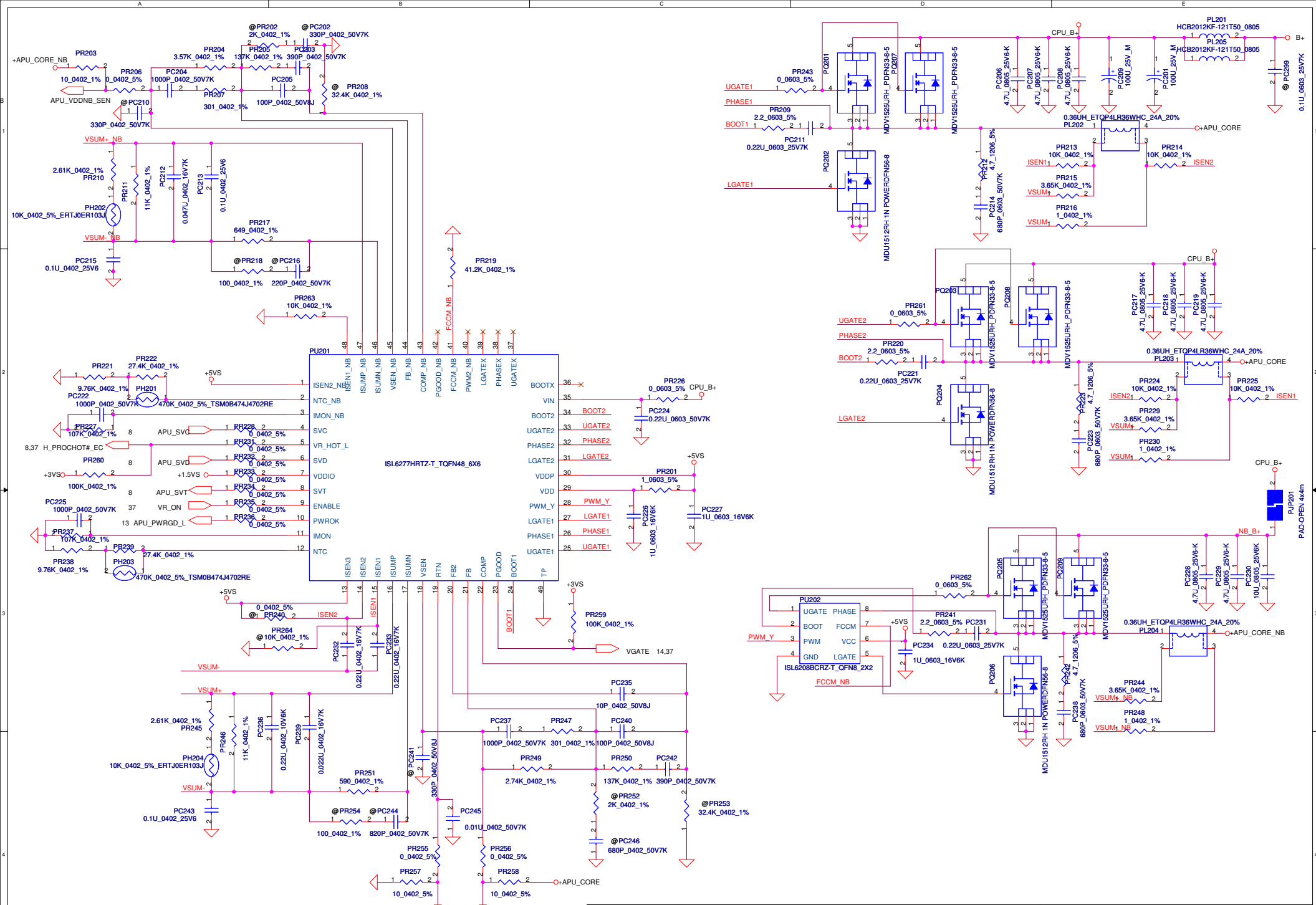


**+1.1VALWP**  
**Iocp=4.94A**  
 (6A, 240mils, Via NO.= 12)

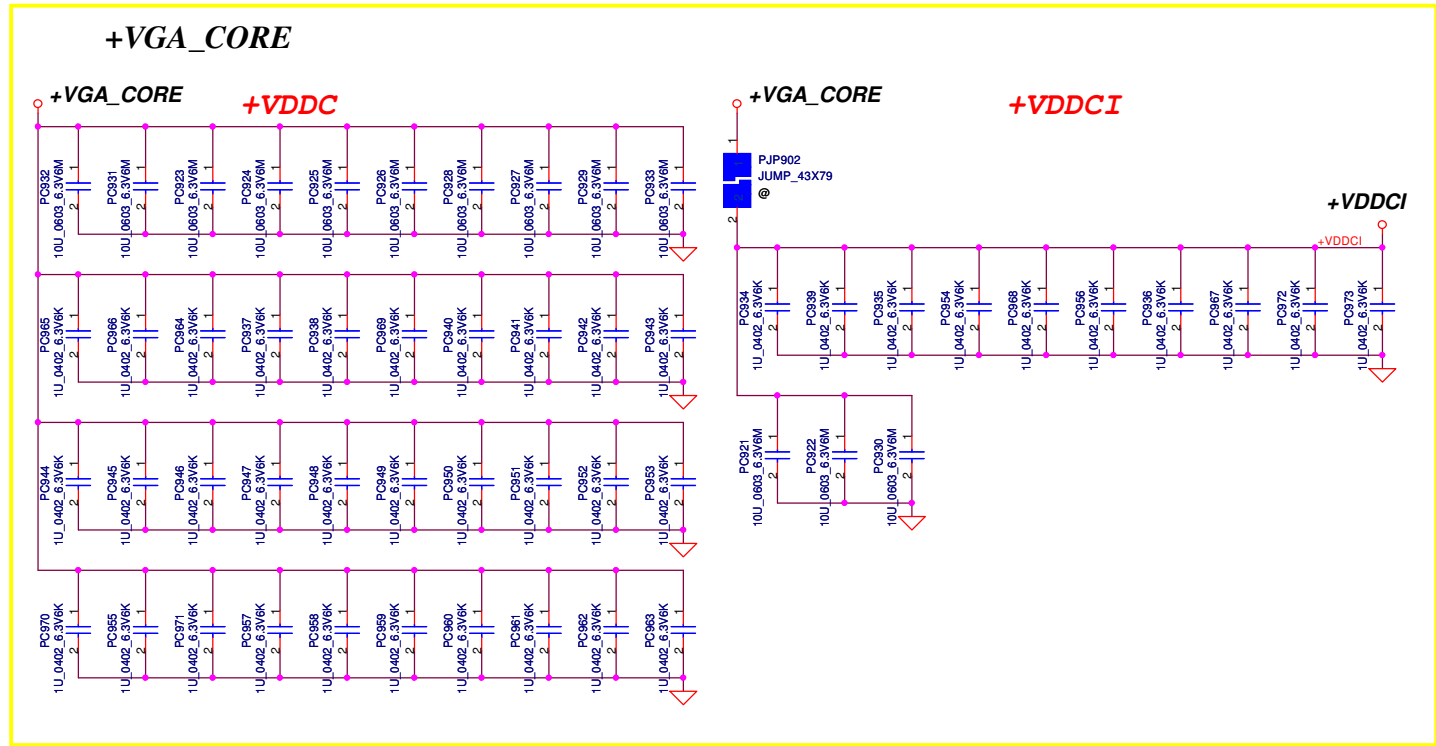
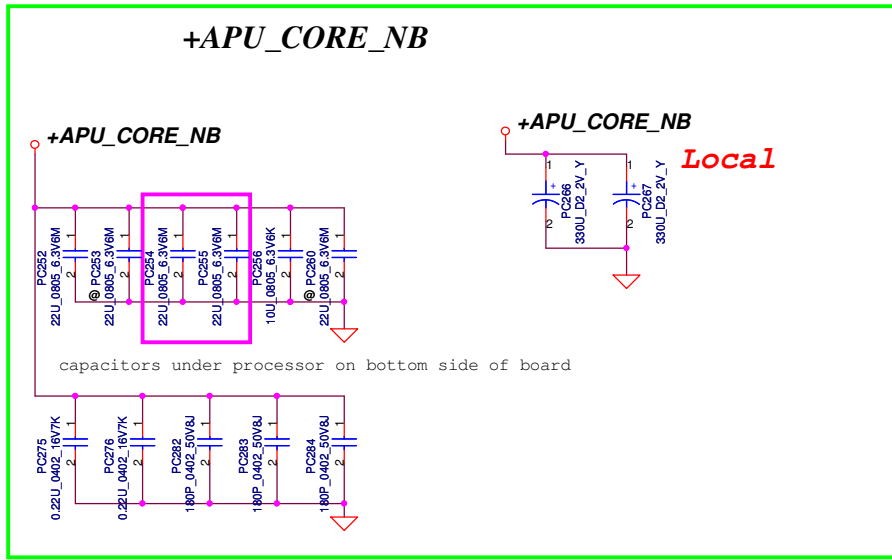
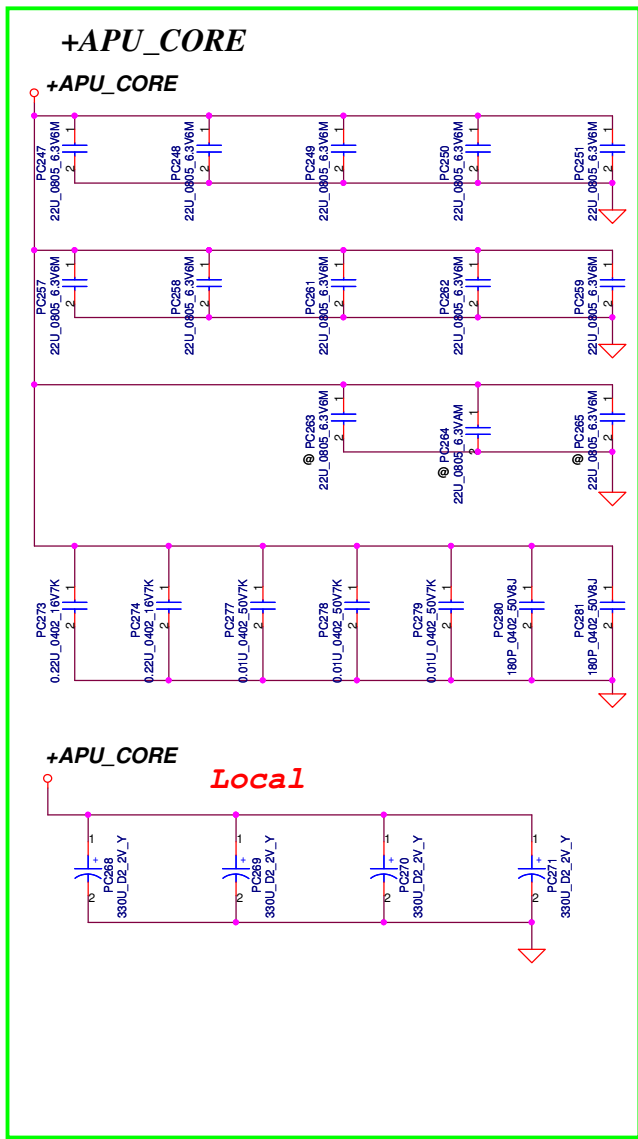
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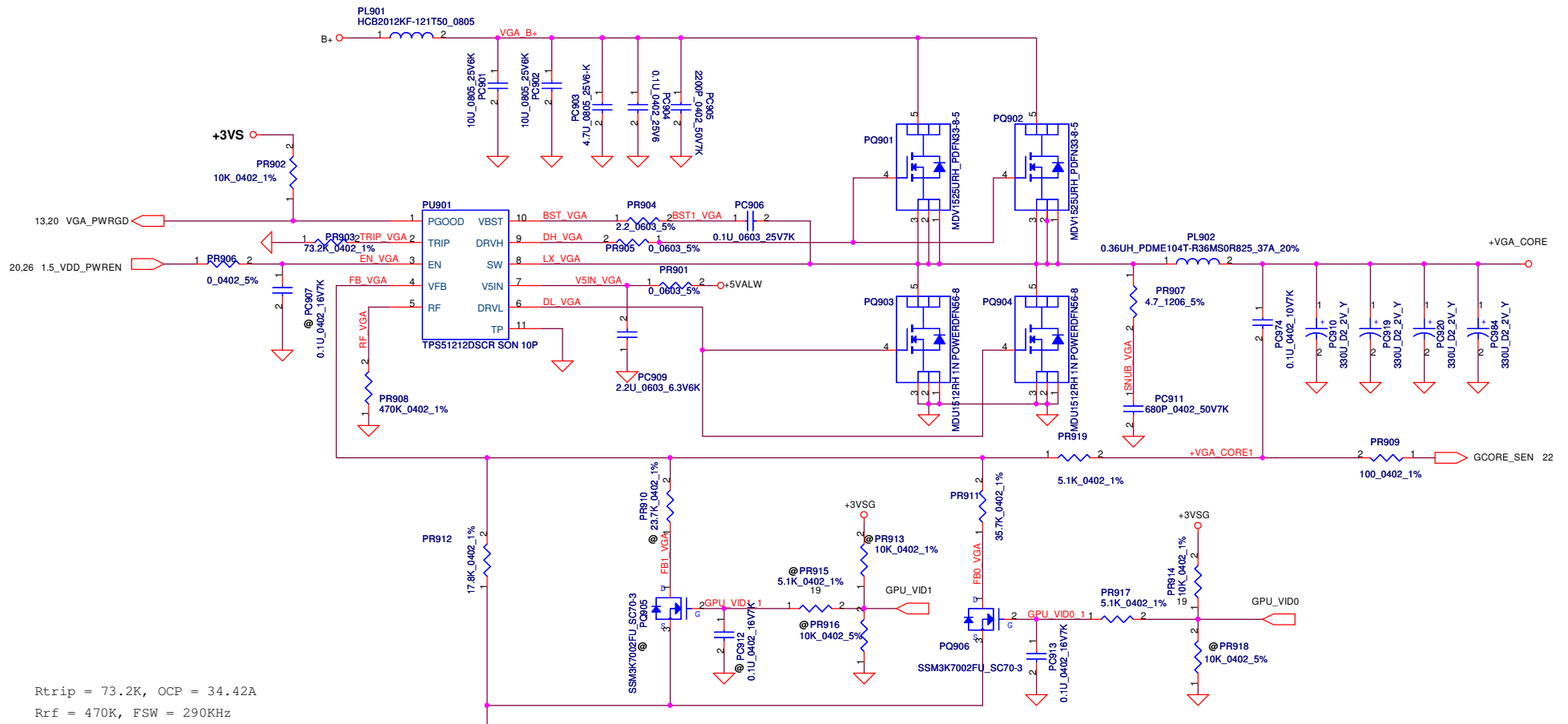


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				<b>+CPU CORE/VDDNB</b>	
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Size	A3	Document Number	QML70 LA-8371P	Rev	0.01
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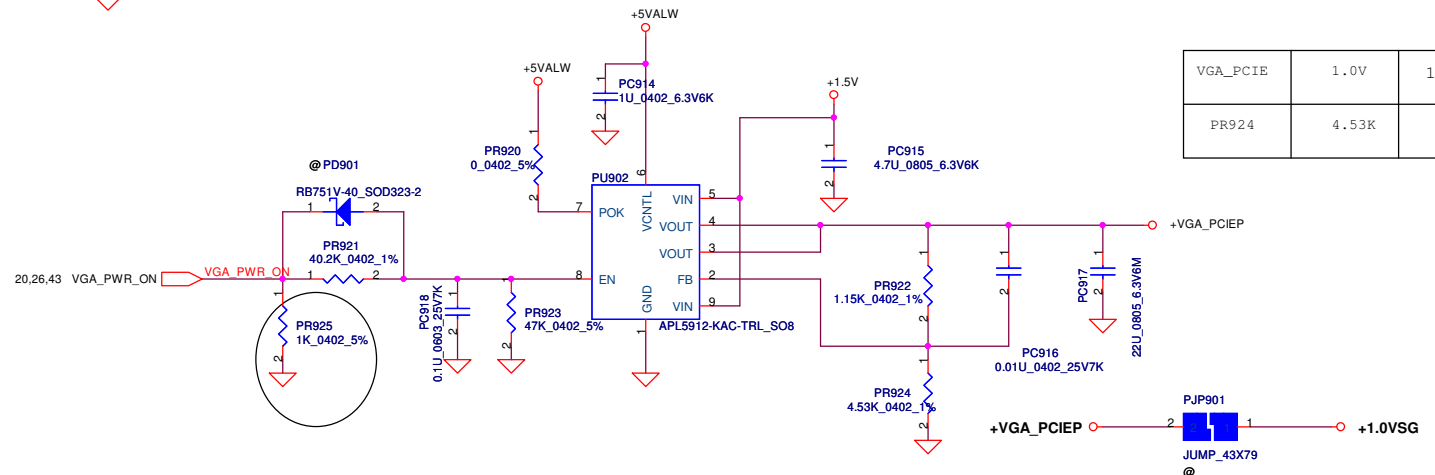


Rtrip = 73.2K, OCP = 34.42A  
 Rrf = 470K, FSW = 290KHz

For Whistler (Thames)  
 $1/2\Delta I = 4.05A$   
 $V_{trip} = 36.5K * 10uA = 0.365V$   
 $I_{ocpmin} = 0.365V / (8 * 1.6m) + 1/2\Delta I = 28.51A + 4.05A = 32.56A$

Thames	
GPU_VID0	Core Voltage Level
1	0.9V
0	1.0V

VGA_PCIE	1.0V	1.1 V
PR924	4.53K	3K



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Compal Electronics, Inc.			
Title <b>VGA CORE</b>			
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*Version Change List ( P. I. R. List ) for Power Circuit*

*Page# Title Date Request Owner Issue Description Solution Description*

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				Custom	QML70 LA-8371P
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Item	Fixed Issue	Reason for change	Rev.	PG#	Modify List	Date	Phase
1		Base on GPU Reference schematic	0.02	22	Reserve pull-up / pull-down resistor 100ohm on GCORE_SEN	08/30	SR
2			0.02	15	Modify Netname of SPI signal of U5	08/30	SR
3			0.02	26	Change Q91.2 from 1.5_VDDC_PWREN# to 1.5VSG_PWREN#	08/30	SR
4		These components are for VGA	0.02	26	Change BOM Structure of R349, R350, R354, R355, Q95, Q96 to PX0	08/30	SR
5		Base on AMD Comal CRB	0.02	8	Change pull-up voltage of APU_RST#, APU_PWRGD, APU_SVT, APU_SVC, APU_SVD, ALERT_L, ALLOW_STOP from +1.5V to +1.5VS	08/30	SR
6		For EMI request	0.02	15	Reserve R559, R561, C624, C625 @ FCH_SDCLK / FCH_SDWP	08/30	SR
7			0.02	36	Remove USB3.0 Host controller circuit	09/01	SR
8			0.02	17	Remove componets of HUDSON_M2	09/01	SR
9		Set PCIE FULL TX OUTPUT SWING to High (Full Swing)	0.02	19	Modify GPU Straps: GPU_GPI00 pull-high	09/01	SR
10			0.02	23	Reserve pull-high and pull-down resistor of MAA14/MBB14	09/01	SR
11		Base on Thames M2 datasheet	0.02	21	Modify U7.U13, U7.14 to NC	09/01	SR
12			0.02	19	Add THM_ALERT# to from U7.AG30 (GPU_THERMAL INT) to U34.6 (ADM1032) Add GPU_CTF from U7.AM17 (GPU_CTF) to U72.97 (EC)	09/02	SR
13			0.02	31	Reserve Analog microphone circuit	09/02	SR
14			0.02	9, 39, 45	Change control signal of 1.1VALWP from SPOK to FCH_1.1PWR_EN Change +1.1V_FCH to +1.1VALW	09/02	SR
15			0.02	15, 37	Connect U72.92 (EC) to U2.V1 (FCH)for SYS ROM Write Protect	09/02	SR
16			0.02	35	Co-lay AI Charger	09/02	SR
17			0.03	31	Modify Analog Microhpone circuit base on Vendor suggestion	09/05	SR
18			0.03	22	Add decoupling cap. base on GPU check list	09/06	SR
19			0.03	17	Change decoupling cap. base on FCH check list	09/06	SR
20			0.03	27	Change LVDS translator to RTD2136	09/06	SR
21			0.03	28	Add pull-up resistor R129, R132 (2.2K) of FCH_CRT_DDC_SDA / SCL	09/06	SR
22			0.03	13	Change R99 to 22ohm (CLK_SD_48M)	09/07	SR
23			0.03	14	Pull-down PEG_CLKREQ#	09/08	SR
24			0.03	37	Change Board ID, R398: 0ohm	09/08	SR
25			0.03	34	Change Power source of ODD from +5VS to +5VALW	09/09	SR
26			0.03	33	Change Power source of WLAN from +3VALW to +3VS	09/09	SR
27			0.03	32	Add power source for none Card Reader IC solution	09/09	SR

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Item	Fixed Issue	Reason for change	Rev.	PG#	Modify List	Date	Phase
1			0.2	15	Change U5 power from +3V_PCH to +3V_FCH	10/11	SR2
2			0.2	15	Change GBE_MDIO pull-up voltage from +3VALW to +3V_FCH	10/11	SR2
3	Blue Screen after install VGA Driver		0.2	25	SWAP QSB7 and QSB#7	10/11	SR2
4			0.2	32	Delete Net SDCD, SDWP# that connect to EC Add MOSFET inverter of SDWP#	10/11	SR2
5			0.2	8	Un-mount pull-high resistor of APU_SVT, APU_SVC, APU_SVD	10/11	SR2
6			0.2	28	Follow QCL70 pin define	10/11	SR2
7			0.2	38	Modify Touch Pad pin define	10/11	SR2
8		For voltage leakage	0.2	8	Change pull-high voltage of APU_PROCHOT#, APU_THERMTRIP#, APU_SVT, APU_SVC, APU_SVD, ALERT_L, ALLOW_STOP, APU_RST#, APU_PWRGD, APU_SIC, APU_SID	10/11	SR2
9		Base on AMD recommend	0.2	24, 25	Change R299, R300, R309, R310, R319, R320, R325, R326 from 56ohm to 40.2ohm	10/11	SR2
10			0.2	37	Change Board ID to "1" for SR2	10/13	SR2
11			0.2	22	Seperate VDDC and VDDCI of VGA	10/14	SR2
12			0.2	23	Reserve R611, R612 for MAA14, MAB14	10/14	SR2
13							
14							
15							
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				Size	Document Number	Rev	
				Custom	QML70 LA-8371P	0.2	
Date: Wednesday, October 19, 2011				Sheet	52 of 53		